

Click [here](#) to ask an associate for production status of specific part numbers.

## MAX77675

## Low I<sub>Q</sub> SIMO PMIC with 0.5V to 5.5V Outputs Delivering Up to 700mA Total Output Current

## General Description

The MAX77675 is a highly efficient, complete power supply for low-power, ultra-compact applications. It provides four programmable buck-boost switching outputs using only one inductor. Operating from a single lithium-ion or Li-ion battery, the MAX77675 delivers a total of 700mA output current ( $3.7V_{IN}$ ,  $1.8V_{OUT}$ ) in less than 40mm<sup>2</sup> solution size.

An integrated sequencer controls full startup while an I<sup>2</sup>C interface allows the MAX77675 to be dynamically configured and monitored.

This device is part of the single-inductor multiple-output (SIMO) product family.

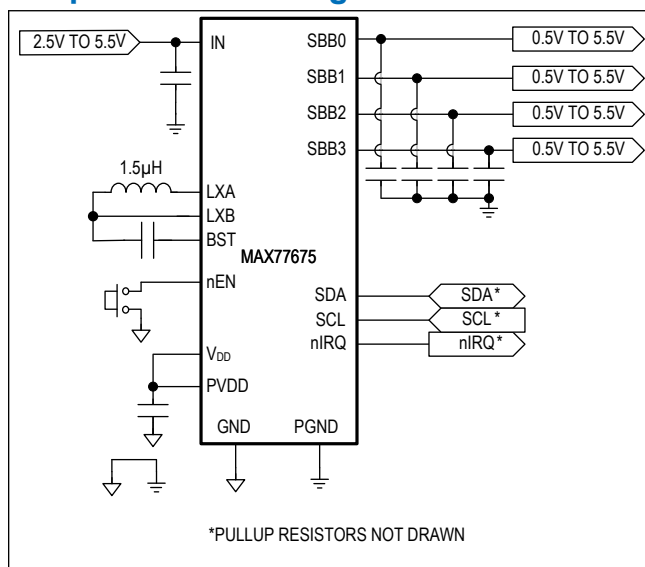
## Applications

- TWS Bluetooth™ Headphones/Hearables
- Fitness, Health, Activity Monitors, and Smart Watches
- Portable Devices
- Sensor Nodes and Consumer Internet of Things or IoT

## Benefits and Features

- 4x Buck/Buck-Boost/Boost Regulators, 1x Inductor
- 2.5V to 5.5V Input Voltage Range
- 0.5V to 5.5V Output Voltage Range
- 700mA Total Output Current ( $3.7V_{IN}$ ,  $1.8V_{OUT}$ )
- SIMO
- Up to 90% Efficiency
  - 6.9 $\mu$ A Typical  $I_Q$  with Two Outputs Enabled in Low-Power Mode
- I<sup>2</sup>C Interface and Dedicated Enable Pin
- Flexible Power Sequencer (FPS)
- 1.99mm x 1.99mm, 16-Bump, 0.5mm Pitch Wafer-Level Package (WLP)
  - < 40mm<sup>2</sup> Solution Size

## Simplified Block Diagram



*Bluetooth is a trademark of Bluetooth SIG, Inc.*

**Ordering Information** appears at end of data sheet.

19-101668: Rev 1: 10/23

© 2023 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners.

One Analog Way, Wilmington, MA 01887 U.S.A. | Tel: 781.329.4700 | © 2023 Analog Devices, Inc. All rights reserved.

**TABLE OF CONTENTS**

|                                                                            |    |
|----------------------------------------------------------------------------|----|
| General Description . . . . .                                              | 1  |
| Applications . . . . .                                                     | 1  |
| Benefits and Features . . . . .                                            | 1  |
| Simplified Block Diagram . . . . .                                         | 1  |
| Absolute Maximum Ratings . . . . .                                         | 7  |
| Recommended Operating Conditions . . . . .                                 | 7  |
| Package Information . . . . .                                              | 7  |
| 16 WLP 0.5mm Pitch . . . . .                                               | 7  |
| Electrical Characteristics . . . . .                                       | 8  |
| Electrical Characteristics—SIMO Buck-Boost . . . . .                       | 10 |
| Electrical Characteristics—I <sup>2</sup> C Serial Interface . . . . .     | 11 |
| Typical Operating Characteristics . . . . .                                | 14 |
| Pin Configuration . . . . .                                                | 21 |
| MAX77675 . . . . .                                                         | 21 |
| Pin Description . . . . .                                                  | 21 |
| Functional Diagrams . . . . .                                              | 22 |
| Top Level Interconnect . . . . .                                           | 22 |
| Detailed Description . . . . .                                             | 23 |
| Part Number Decoding . . . . .                                             | 23 |
| Support Materials . . . . .                                                | 24 |
| Voltage Monitors . . . . .                                                 | 24 |
| IN POR Comparator . . . . .                                                | 24 |
| IN Undervoltage Lockout Comparator . . . . .                               | 24 |
| IN Overvoltage Lockout Comparator . . . . .                                | 25 |
| Thermal Monitors . . . . .                                                 | 25 |
| Thermal Shutdown . . . . .                                                 | 25 |
| Chip Identification . . . . .                                              | 25 |
| nEN Enable Input . . . . .                                                 | 25 |
| nEN Manual Reset . . . . .                                                 | 26 |
| nEN Triple Functionality: Push-Button vs. Slide-Switch vs. Logic . . . . . | 26 |
| Debounced Input . . . . .                                                  | 26 |
| nEN Internal Pullup Resistors to V <sub>IN</sub> . . . . .                 | 27 |
| Interrupts (nIRQ) . . . . .                                                | 27 |
| On/Off Controller . . . . .                                                | 28 |
| Top Level On/Off Controller . . . . .                                      | 29 |
| Internal Wake-Up Flags . . . . .                                           | 30 |
| On/Off Controller Actions . . . . .                                        | 31 |
| Flexible Power Sequencer . . . . .                                         | 31 |
| Startup Timing Diagram Due to nEN . . . . .                                | 32 |

**TABLE OF CONTENTS (CONTINUED)**

|                                                                  |    |
|------------------------------------------------------------------|----|
| Low-Power Mode . . . . .                                         | 33 |
| Detailed Description—SIMO Buck-Boost . . . . .                   | 34 |
| Benefits and Features . . . . .                                  | 34 |
| Inductor Valley Current. . . . .                                 | 34 |
| SIMO Control Scheme . . . . .                                    | 35 |
| Drive Strength . . . . .                                         | 35 |
| SIMO Channel Operating Mode . . . . .                            | 35 |
| Examples . . . . .                                               | 35 |
| Buck Mode . . . . .                                              | 35 |
| Buck-Boost Mode. . . . .                                         | 35 |
| Boost Mode . . . . .                                             | 35 |
| Channel-to-Channel Switching . . . . .                           | 36 |
| SIMO Soft-Start . . . . .                                        | 36 |
| Rising Slew Rate . . . . .                                       | 36 |
| Delay in Changing Output Voltage. . . . .                        | 37 |
| SIMO Registers . . . . .                                         | 37 |
| SIMO Active Discharge Resistance . . . . .                       | 37 |
| Bootstrap Refresh . . . . .                                      | 37 |
| Detailed Description—I <sup>2</sup> C Serial Interface . . . . . | 37 |
| Benefits and Features . . . . .                                  | 37 |
| I <sup>2</sup> C System Configuration. . . . .                   | 38 |
| I <sup>2</sup> C Interface Power . . . . .                       | 38 |
| I <sup>2</sup> C Data Transfer . . . . .                         | 38 |
| I <sup>2</sup> C Start and Stop Conditions . . . . .             | 38 |
| I <sup>2</sup> C Acknowledge Bit . . . . .                       | 38 |
| I <sup>2</sup> C Slave Address . . . . .                         | 39 |
| I <sup>2</sup> C Clock Stretching. . . . .                       | 39 |
| I <sup>2</sup> C General Call Address. . . . .                   | 40 |
| I <sup>2</sup> C Device ID . . . . .                             | 40 |
| I <sup>2</sup> C Communication Speed. . . . .                    | 40 |
| I <sup>2</sup> C Communication Protocols . . . . .               | 40 |
| Writing to a Single Register . . . . .                           | 40 |
| Writing Multiple Bytes to Sequential Registers. . . . .          | 41 |
| Reading from a Single Register . . . . .                         | 42 |
| Reading from Sequential Registers . . . . .                      | 43 |
| Engaging HS Mode for Operation Up to 3.4MHz . . . . .            | 44 |
| Register Map . . . . .                                           | 45 |
| MAX77675 . . . . .                                               | 45 |
| Register Details . . . . .                                       | 45 |

---

**TABLE OF CONTENTS (CONTINUED)**

---

|                                                    |    |
|----------------------------------------------------|----|
| Applications Information . . . . .                 | 56 |
| Configuring Power Modes . . . . .                  | 56 |
| Applications Information—SIMO Buck-Boost . . . . . | 56 |
| SIMO-Supported Output Current . . . . .            | 56 |
| Overload . . . . .                                 | 58 |
| Inductor Selection . . . . .                       | 58 |
| Input Capacitor Selection . . . . .                | 58 |
| Bootstrap Capacitor Selection . . . . .            | 58 |
| Output Capacitor Selection . . . . .               | 59 |
| PVDD and V <sub>DD</sub> Capacitors . . . . .      | 59 |
| Unused Outputs . . . . .                           | 59 |
| Output Voltage Ripple . . . . .                    | 59 |
| PCB Layout Guide . . . . .                         | 60 |
| Capacitors . . . . .                               | 60 |
| Input Capacitor at IN . . . . .                    | 60 |
| Output Capacitors at SBBx . . . . .                | 60 |
| Inductor . . . . .                                 | 60 |
| Ground Connections . . . . .                       | 60 |
| Example PCB Layout . . . . .                       | 60 |
| Typical Application Circuits . . . . .             | 61 |
| Typical Applications Circuit . . . . .             | 61 |
| Ordering Information . . . . .                     | 62 |
| Revision History . . . . .                         | 63 |

---

**LIST OF FIGURES**

---

|                                                                                             |    |
|---------------------------------------------------------------------------------------------|----|
| Figure 1. Part Number Decode . . . . .                                                      | 23 |
| Figure 2. nEN Usage Timing Diagram . . . . .                                                | 26 |
| Figure 3. Debounced Input . . . . .                                                         | 27 |
| Figure 4. nEN Pullup Resistor Configuration . . . . .                                       | 27 |
| Figure 5. On/Off Controller State Diagram . . . . .                                         | 29 |
| Figure 6. On/Off Controller Actions . . . . .                                               | 31 |
| Figure 7. Flexible Power Sequencer Basic Timing Diagram . . . . .                           | 32 |
| Figure 8. Startup Timing Diagram Due to nEN (Logic Mode) . . . . .                          | 32 |
| Figure 9. Startup Timing Diagram Due to nEN (Logic Mode; nEN Connected to Ground) . . . . . | 33 |
| Figure 10. Startup Timing Diagram Due to nEN (Push-Button Mode) . . . . .                   | 33 |
| Figure 11. Valley Current Control with Changing Load Current . . . . .                      | 34 |
| Figure 12. I <sup>2</sup> C System Configuration . . . . .                                  | 38 |
| Figure 13. I <sup>2</sup> C Start and Stop Conditions . . . . .                             | 38 |
| Figure 14. Acknowledge Bit. . . . .                                                         | 39 |
| Figure 15. Slave Address Example . . . . .                                                  | 39 |
| Figure 16. Writing to a Single Register with the Write Byte Protocol . . . . .              | 41 |
| Figure 17. Writing to Sequential Registers X to N. . . . .                                  | 42 |
| Figure 18. Reading from a Single Register with the Read Byte Protocol . . . . .             | 43 |
| Figure 19. Reading Continuously from Sequential Registers X to N. . . . .                   | 44 |
| Figure 20. Engaging HS Mode . . . . .                                                       | 44 |
| Figure 21. PCB Top Layer and Component Placement Example . . . . .                          | 61 |

| LIST OF TABLES                                                           |    |
|--------------------------------------------------------------------------|----|
| Table 1. OTP Options Table . . . . .                                     | 24 |
| Table 2. On/Off Controller Transition/State . . . . .                    | 29 |
| Table 3. SIMO Operating Mode Thresholds . . . . .                        | 35 |
| Table 4. Operating Mode Examples . . . . .                               | 35 |
| Table 5. Output Voltage Rising Slew Rates . . . . .                      | 37 |
| Table 6. I <sup>2</sup> C Slave Address Options . . . . .                | 39 |
| Table 7. Power Mode Configuration . . . . .                              | 56 |
| Table 8. SIMO-Supported Output Current for Common Applications . . . . . | 56 |

## Absolute Maximum Ratings

|                                                |                                 |                                                                                                                |                 |
|------------------------------------------------|---------------------------------|----------------------------------------------------------------------------------------------------------------|-----------------|
| nEN to GND .....                               | -0.3V to V <sub>IN</sub> + 0.3V | BST to LXB .....                                                                                               | -0.3V to +6V    |
| SCL, SDA to GND .....                          | -0.3V to +6V                    | SBB0, SBB1, SBB2, SBB3 Short-Circuit Duration.....                                                             | Continuous      |
| IN, nIRQ to GND.....                           | -0.3V to +6V                    | PGND to GND.....                                                                                               | -0.3V to +0.3V  |
| PVDD, V <sub>DD</sub> to GND.....              | -0.3V to +2.2V                  | Operating Temperature Range .....                                                                              | -40°C to +85°C  |
| SDA Continuous Current.....                    | ±20mA                           | Junction Temperature .....                                                                                     | +150°C          |
| IN Continuous Current.....                     | 1.2A <sub>RMS</sub>             | Storage Temperature Range .....                                                                                | -65°C to +150°C |
| LXA Continuous Current ( <i>Note 1</i> ) ..... | 1.2A <sub>RMS</sub>             | Soldering Temperature (reflow) .....                                                                           | +260°C          |
| LXB Continuous Current ( <i>Note 1</i> ) ..... | 1.2A <sub>RMS</sub>             | Continuous Power Dissipation (Multilayer Board, T <sub>A</sub> = +70°C,<br>derate 20.4mW/°C above +70°C) ..... | 1632mW          |
| SBB0, SBB1, SBB2, SBB3 to PGND .....           | -0.3V to +6V                    |                                                                                                                |                 |
| BST to IN .....                                | -0.3V to +6V                    |                                                                                                                |                 |

**Note 1:** Do not externally bias LXA or LXB. LXA has internal clamping diodes to PGND and IN. LXB has an internal low-side clamping diode to PGND and an internal high-side clamping diode that dynamically connects to a selected SIMO output. It is normal for these diodes to briefly conduct during switching events. When the SIMO regulator is disabled, the LXB to PGND absolute maximum voltage is -0.3V to V<sub>SBBx</sub> + 0.3V.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Recommended Operating Conditions

| PARAMETER                                  | SYMBOL                                                                        | CONDITION                     | TYPICAL RANGE | UNIT |
|--------------------------------------------|-------------------------------------------------------------------------------|-------------------------------|---------------|------|
| IN Voltage                                 | V <sub>IN</sub>                                                               |                               | 2.5–5.5       | V    |
| SBB0/1/2/3 Output Voltage                  | V <sub>SBBx</sub>                                                             | CNFG_SBB_TOP.STEP_SZ_SBBx = 0 | 0.5–5.5       | V    |
|                                            |                                                                               | CNFG_SBB_TOP.STEP_SZ_SBBx = 1 | 0.5000–3.6875 |      |
| SBB0/1/2/3 Maximum Combined Output Current | I <sub>SBB0</sub> + I <sub>SBB1</sub> + I <sub>SBB2</sub> + I <sub>SBB3</sub> | <i>Note 4</i>                 | 700           | mA   |
| V <sub>DD</sub> Voltage                    | V <sub>DD</sub>                                                               |                               | 1.8           | V    |

**Note:** These limits are not guaranteed.

## Package Information

### 16 WLP 0.5mm Pitch

|                                              |                                                |
|----------------------------------------------|------------------------------------------------|
| Package Code                                 | W161N1+1                                       |
| Outline Number                               | <a href="#">21-100374</a>                      |
| Land Pattern Number                          | Refer to <a href="#">Application Note 1891</a> |
| <b>Thermal Resistance, Four-Layer Board:</b> |                                                |
| Junction to Ambient (θ <sub>JA</sub> )       | 49°C/W (2s2p board)                            |
| Junction to Case (θ <sub>JC</sub> )          | N/A                                            |

For the latest package outline information and land patterns (footprints), go to [www.maximintegrated.com/packages](http://www.maximintegrated.com/packages). Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to [www.maximintegrated.com/thermal-tutorial](http://www.maximintegrated.com/thermal-tutorial).

## Electrical Characteristics

(V<sub>IN</sub> = 3.7V, Limits are 100% tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range (T<sub>A</sub> = -40°C to +85°C) and relevant supply voltage range are guaranteed by design and characterization, unless otherwise noted. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER                         | SYMBOL                  | CONDITIONS                                                                    |                                    | MIN                                           | TYP                   | MAX  | UNITS |
|-----------------------------------|-------------------------|-------------------------------------------------------------------------------|------------------------------------|-----------------------------------------------|-----------------------|------|-------|
| INPUT CURRENT                     |                         |                                                                               |                                    |                                               |                       |      |       |
| Shutdown Current                  | I <sub>SHDN</sub>       | All SBBx channels are disabled, V <sub>IN</sub> = 3.7V, V <sub>LXA</sub> = 0V | T <sub>A</sub> = +25°C             | 0.3                                           |                       |      | μA    |
| Quiescent Supply Current          | I <sub>Q</sub>          | T <sub>A</sub> = +25°C                                                        | All channels disabled, bias in LPM | 3.8                                           |                       |      | μA    |
|                                   |                         |                                                                               | All channels disabled, bias in NPM | 10                                            |                       |      |       |
| VOLTAGE MONITORS                  |                         |                                                                               |                                    |                                               |                       |      |       |
| Input Voltage Range               | V <sub>IN</sub>         |                                                                               |                                    | 2.5                                           | 5.5                   |      | V     |
| POWER-ON RESET (POR)              |                         |                                                                               |                                    |                                               |                       |      |       |
| POR Threshold                     | V <sub>POR</sub>        | V <sub>IN</sub> falling                                                       |                                    | 1.8                                           |                       |      | V     |
| UNDERVOLTAGE LOCKOUT (UVLO)       |                         |                                                                               |                                    |                                               |                       |      |       |
| UVLO Threshold                    | V <sub>INUVLO</sub>     | V <sub>IN</sub> falling, UVLO_F[1:0] = 0x4                                    |                                    | 2.3                                           |                       |      | V     |
| UVLO Threshold Hysteresis         | V <sub>INUVLO_HYS</sub> | UVLO_H[1:0] = 0x5 ( <a href="#">Note 2</a> )                                  |                                    | 300                                           |                       |      | mV    |
| OVERVOLTAGE LOCKOUT (OVLO)        |                         |                                                                               |                                    |                                               |                       |      |       |
| OVLO Threshold                    | V <sub>INOVLO</sub>     | V <sub>IN</sub> rising                                                        |                                    | 5.70                                          | 5.85                  | 6.00 | V     |
| THERMAL MONITORS                  |                         |                                                                               |                                    |                                               |                       |      |       |
| Overtemperature Lockout Threshold | T <sub>OTLO</sub>       | T <sub>J</sub> rising                                                         |                                    | 145                                           |                       |      | °C    |
| Thermal Alarm Temperature 1       | T <sub>JAL1</sub>       | T <sub>J</sub> rising                                                         |                                    | 90                                            |                       |      | °C    |
| Thermal Alarm Temperature 2       | T <sub>JAL2</sub>       | T <sub>J</sub> rising                                                         |                                    | 120                                           |                       |      | °C    |
| ENABLE INPUT (nEN)                |                         |                                                                               |                                    |                                               |                       |      |       |
| nEN Input Leakage Current         | I <sub>nEN_LKG</sub>    | V <sub>nEN</sub> = V <sub>IN</sub> = 5.5V<br>CNFG_GLBL_A.P<br>U_DIS = 1       | T <sub>A</sub> = +25°C             | -1                                            | ±0.001                | +1   | μA    |
|                                   |                         |                                                                               | T <sub>A</sub> = +85°C             | ±0.01                                         |                       |      |       |
| nEN Input Falling Threshold       | V <sub>TH_nEN_F</sub>   | nEN falling                                                                   |                                    | V <sub>IN</sub> - 1.6                         | V <sub>IN</sub> - 1.2 |      | V     |
| nEN Input Rising Threshold        | V <sub>TH_nEN_R</sub>   | nEN rising                                                                    |                                    | V <sub>IN</sub> - 1.1   V <sub>IN</sub> - 0.6 |                       |      | V     |
| Debounce Time                     | t <sub>DBNC_nEN</sub>   | CNFG_GLBL_A.DBEN_nEN = 0                                                      |                                    | 100                                           |                       |      | μs    |
|                                   |                         | CNFG_GLBL_A.DBEN_nEN = 1<br>( <a href="#">Note 5</a> )                        |                                    | 30                                            |                       |      | ms    |



**Electrical Characteristics (continued)**

(V<sub>IN</sub> = 3.7V, Limits are 100% tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range (T<sub>A</sub> = -40°C to +85°C) and relevant supply voltage range are guaranteed by design and characterization, unless otherwise noted. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER                          | SYMBOL                | CONDITIONS                                                                         |                                | MIN   | TYP    | MAX   | UNITS |
|------------------------------------|-----------------------|------------------------------------------------------------------------------------|--------------------------------|-------|--------|-------|-------|
| Manual Reset Time                  | t <sub>MRST</sub>     | (Note 3 and Note 5)                                                                | CNFG_GLBL_A.M<br>RT[1:0] = 0x0 | 3.75  | 4.00   | 5.25  | s     |
|                                    |                       |                                                                                    | CNFG_GLBL_A.M<br>RT[1:0] = 0x1 | 7.55  | 8.00   | 9.45  |       |
|                                    |                       |                                                                                    | CNFG_GLBL_A.M<br>RT[1:0] = 0x2 | 11.35 | 12.00  | 13.65 |       |
|                                    |                       |                                                                                    | CNFG_GLBL_A.M<br>RT[1:0] = 0x3 | 15.15 | 16.00  | 17.85 |       |
| nEN Pullup                         | R <sub>nEN_PU</sub>   | Pullup to V <sub>IN</sub>                                                          | CNFG_GLBL_A.P<br>U_DIS = 0     |       | 200    |       | kΩ    |
| OPEN-DRAIN INTERRUPT OUTPUT (nIRQ) |                       |                                                                                    |                                |       |        |       |       |
| Output Low Voltage                 |                       | Sinking 2mA                                                                        |                                |       |        | 0.4   | V     |
| Output Falling Edge Time           | t <sub>f_nIRQ</sub>   | C <sub>IRQ</sub> = 25pF (Note 5)                                                   |                                |       | 1.5    |       | ns    |
| Leakage Current                    | I <sub>nIRQ_LKG</sub> | V <sub>IN</sub> = 5.5V, nIRQ set to high impedance, V <sub>nIRQ</sub> = 0V or 5.5V | T <sub>A</sub> = +25°C         | -1    | ±0.001 | +1    | μA    |
|                                    |                       |                                                                                    | T <sub>A</sub> = +85°C         |       | ±0.01  |       |       |
| FLEXIBLE POWER SEQUENCER           |                       |                                                                                    |                                |       |        |       |       |
| Power-Up Event Periods             | t <sub>EN</sub>       | See Figure 7. (Note 5)                                                             |                                |       | 1.28   |       | ms    |
| Power-Down Event Periods           | t <sub>DIS</sub>      | See Figure 7. (Note 5)                                                             |                                |       | 2.56   |       | ms    |
| BIAS                               |                       |                                                                                    |                                |       |        |       |       |
| Enable Delay                       | t <sub>BIAS_EN</sub>  |                                                                                    |                                |       | 1      |       | ms    |
| PVDD Output Voltage                | V <sub>PVDD</sub>     |                                                                                    |                                |       | 1.8    |       | V     |
| V <sub>DD</sub> Input Voltage      | V <sub>DD</sub>       |                                                                                    |                                |       | 1.8    |       | V     |

**Note 2:** Programmed at Analog Devices factory.

**Note 3:** The error in manual reset period is the same percentage-wise for all options.

**Electrical Characteristics—SIMO Buck-Boost**

(V<sub>IN</sub> = 3.7V, C<sub>SBBx</sub> = 22μF, L = 1.5μH, Limits are 100% tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range (T<sub>A</sub> = -40°C to +85°C) and relevant supply voltage range are guaranteed by design and characterization, unless otherwise noted. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER                         | SYMBOL               | CONDITIONS                                                                                                                             |                                                    | MIN    | TYP  | MAX | UNITS |
|-----------------------------------|----------------------|----------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------|--------|------|-----|-------|
| GENERAL CHARACTERISTICS           |                      |                                                                                                                                        |                                                    |        |      |     |       |
| SIMO Quiescent Supply Current     | I <sub>Q_SIMO</sub>  | T <sub>A</sub> = +25°C, bias in LPM<br><a href="#">(Note 5)</a>                                                                        | Total current for the first channel at 1.8V output | 4.0    |      | μA  |       |
|                                   |                      |                                                                                                                                        | Current for each additional channel at 1.8V output | 0.2    |      |     |       |
|                                   |                      | T <sub>A</sub> = +25°C, bias in NPM<br><a href="#">(Note 5)</a>                                                                        | Current for the first channel at 1.8V output       | 230    |      |     |       |
|                                   |                      |                                                                                                                                        | Current for each additional channel at 1.8V output | 61     |      |     |       |
| OUTPUT VOLTAGE RANGE (SBB0/1/2/3) |                      |                                                                                                                                        |                                                    |        |      |     |       |
| Programmable Output Voltage Range |                      | CNFG_SBB_TOP_A.STEP_SZ_SBBx = 0                                                                                                        | 0.5                                                | 5.5    |      | V   |       |
|                                   |                      | CNFG_SBB_TOP_A.STEP_SZ_SBBx = 1                                                                                                        | 0.5                                                | 3.6875 |      |     |       |
| Output DAC Bits                   |                      |                                                                                                                                        | 8                                                  |        | bits |     |       |
| Output DAC LSB Size               |                      | CNFG_SBB_TOP_A.STEP_SZ_SBBx = 0                                                                                                        | 25                                                 |        | mV   |     |       |
|                                   |                      | CNFG_SBB_TOP_A.STEP_SZ_SBBx = 1                                                                                                        | 12.5                                               |        |      |     |       |
| OUTPUT VOLTAGE ACCURACY           |                      |                                                                                                                                        |                                                    |        |      |     |       |
| Output Voltage Accuracy           |                      | I <sub>SBBx</sub> = 1mA, typical is based on an average over 100ms, V <sub>DD</sub> = 1.8V, V <sub>SBBx</sub> = 1.8V                   | T <sub>A</sub> = +25°C                             | -3.0   | +3.0 |     | %     |
|                                   |                      |                                                                                                                                        | T <sub>A</sub> = -40°C to +85°C                    | -4.0   | +4.0 |     |       |
|                                   |                      | I <sub>SBBx</sub> = 300mA, typical is based on an average over 100ms, V <sub>DD</sub> = 1.8V, V <sub>SBBx</sub> = 1.8V                 | T <sub>A</sub> = +25°C                             | -2.0   | +2.0 |     |       |
|                                   |                      |                                                                                                                                        | T <sub>A</sub> = -40°C to +85°C                    | -4.0   | +4.0 |     |       |
| TIMING CHARACTERISTICS            |                      |                                                                                                                                        |                                                    |        |      |     |       |
| Enable Delay                      | t <sub>SIMO_EN</sub> | Delay time from the SIMO receiving its first enable signal to when it begins to switch in order to service that output.                | 450                                                |        | μs   |     |       |
|                                   |                      | After the first SIMO channel has been enabled, subsequent enable signals cause their outputs to begin switching after this delay time. | 150                                                |        |      |     |       |

**Electrical Characteristics—SIMO Buck-Boost (continued)**

(V<sub>IN</sub> = 3.7V, C<sub>SBBx</sub> = 22μF, L = 1.5μH, Limits are 100% tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range (T<sub>A</sub> = -40°C to +85°C) and relevant supply voltage range are guaranteed by design and characterization, unless otherwise noted. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER                       | SYMBOL               | CONDITIONS                                                                                                                                                          |                              | MIN  | TYP   | MAX | UNITS |
|---------------------------------|----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------|------|-------|-----|-------|
| Soft-Start Slew Rate            | dV/dt <sub>SS</sub>  | CNFG_SBB_TOP_ B.SR_SBBx = 0                                                                                                                                         |                              | 1.0  | 2.0   | 3.0 | mV/μs |
|                                 |                      | CNFG_SBB_TOP_ B.SR_SBBx = 1                                                                                                                                         | CNFG_SBB_TOP_ B.DVS_SLEW = 0 | 5.0  |       |     |       |
|                                 |                      | ( <a href="#">Note 5</a> )                                                                                                                                          | CNFG_SBB_TOP_ B.DVS_SLEW = 1 | 10   |       |     |       |
| POWER STAGE CHARACTERISTICS     |                      |                                                                                                                                                                     |                              |      |       |     |       |
| LXA Leakage Current             |                      | All SBB channels are disabled, V <sub>IN</sub> = 5.5V, V <sub>LXA</sub> = 0V, or 5.5V                                                                               | T <sub>A</sub> = +25°C       | -1   | ±0.01 | +1  | μA    |
|                                 |                      |                                                                                                                                                                     | T <sub>A</sub> = +85°C       | ±0.1 |       |     |       |
| LXB Leakage Current             |                      | All SBB channels are disabled, V <sub>IN</sub> = 5.5V, V <sub>LXA</sub> = 0V or 5.5V, all V <sub>SBBx</sub> = 4.0V                                                  | T <sub>A</sub> = +25°C       | -1   | ±0.01 | +1  | μA    |
|                                 |                      |                                                                                                                                                                     | T <sub>A</sub> = +85°C       | ±0.1 |       |     |       |
| Disabled Output Leakage Current |                      | All SBB channels are disabled, active discharge disabled (ADE_SBBx = 0), V <sub>SBBx</sub> = 4.0V, V <sub>LXB</sub> = 0V, V <sub>IN</sub> = V <sub>BST</sub> = 5.5V | T <sub>A</sub> = +25°C       | 0.05 |       |     | μA    |
|                                 |                      | All SBB channels are disabled, active discharge disabled (ADE_SBBx = 0), V <sub>SBBx</sub> = 4.0V, V <sub>LXB</sub> = 0V, V <sub>IN</sub> = V <sub>BST</sub> = 5.5V | T <sub>A</sub> = +85°C       | 0.1  |       |     |       |
| Active-Discharge Impedance      | R <sub>AD_SBBx</sub> | All SBB channels are disabled, active discharge enabled (ADE_SBBx = 1)                                                                                              |                              | 80   | 140   | 260 | Ω     |

**Note 4:** See the [SIMO Supported Output Current](#) section for more information.

**Electrical Characteristics—I<sup>2</sup>C Serial Interface**

(V<sub>IN</sub> = 3.7V, Limits are 100% tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range (T<sub>A</sub> = -40°C to +85°C) and relevant supply voltage range are guaranteed by design and characterization, unless otherwise noted. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER                    | SYMBOL          | CONDITIONS                                     | MIN                   | TYP | MAX                   | UNITS |
|------------------------------|-----------------|------------------------------------------------|-----------------------|-----|-----------------------|-------|
| <b>SDA AND SCL I/O STAGE</b> |                 |                                                |                       |     |                       |       |
| SCL, SDA Input High Voltage  | V <sub>IH</sub> | V <sub>IN</sub> = 3.7V, T <sub>A</sub> = +25°C | 0.7 x V <sub>DD</sub> |     |                       | V     |
| SCL, SDA Input Low Voltage   | V <sub>IL</sub> | T <sub>A</sub> = +25°C                         |                       |     | 0.3 x V <sub>DD</sub> | V     |

**Electrical Characteristics—I<sup>2</sup>C Serial Interface (continued)**

(V<sub>IN</sub> = 3.7V, Limits are 100% tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range (T<sub>A</sub> = -40°C to +85°C) and relevant supply voltage range are guaranteed by design and characterization, unless otherwise noted. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER                                                                                                       | SYMBOL              | CONDITIONS                                                                | MIN  | TYP                    | MAX  | UNITS |
|-----------------------------------------------------------------------------------------------------------------|---------------------|---------------------------------------------------------------------------|------|------------------------|------|-------|
| SCL, SDA Input Hysteresis                                                                                       | V <sub>HYS</sub>    | T <sub>A</sub> = +25°C                                                    |      | 0.05 x V <sub>DD</sub> |      | V     |
| SCL, SDA Input Leakage Current                                                                                  | I <sub>I</sub>      | V <sub>SCL</sub> = V <sub>SDA</sub> = V <sub>DD</sub>                     | -1   |                        | +1   | μA    |
| SDA Output Low Voltage                                                                                          | V <sub>OL</sub>     | Sinking 20mA                                                              |      |                        | 0.4  | V     |
| SCL, SDA Pin Capacitance                                                                                        | C <sub>I</sub>      | ( <a href="#">Note 5</a> )                                                |      | 10                     |      | pF    |
| Output Fall Time from V <sub>IH</sub> to V <sub>IL</sub>                                                        | t <sub>OF</sub>     | ( <a href="#">Note 5</a> )                                                |      |                        | 120  | ns    |
| <b>I<sup>2</sup>C-COMPATIBLE INTERFACE TIMING (STANDARD, FAST, AND FAST-MODE PLUS) (<a href="#">Note 5</a>)</b> |                     |                                                                           |      |                        |      |       |
| Clock Frequency                                                                                                 | f <sub>SCL</sub>    |                                                                           | 0    |                        | 1000 | kHz   |
| Hold Time (REPEATED) START Condition                                                                            | t <sub>HD_STA</sub> |                                                                           | 0.26 |                        |      | μs    |
| SCL Low Period                                                                                                  | t <sub>LOW</sub>    |                                                                           | 0.5  |                        |      | μs    |
| SCL High Period                                                                                                 | t <sub>HIGH</sub>   |                                                                           | 0.26 |                        |      | μs    |
| Setup Time REPEATED START Condition                                                                             | t <sub>SU_STA</sub> |                                                                           | 0.26 |                        |      | μs    |
| Data Hold Time                                                                                                  | t <sub>HD_DAT</sub> |                                                                           | 0    |                        |      | μs    |
| Data Setup Time                                                                                                 | t <sub>SU_DAT</sub> |                                                                           | 50   |                        |      | ns    |
| Setup Time for STOP Condition                                                                                   | t <sub>SU_STO</sub> |                                                                           | 0.26 |                        |      | μs    |
| Bus Free Time between STOP and START Condition                                                                  | t <sub>BUF</sub>    |                                                                           | 0.5  |                        |      | μs    |
| Pulse Width of Suppressed Spikes                                                                                | t <sub>SP</sub>     | Maximum pulse width of spikes that must be suppressed by the input filter |      |                        | 50   | ns    |
| <b>I<sup>2</sup>C-COMPATIBLE INTERFACE TIMING (HIGH-SPEED MODE, CB = 100pF) (<a href="#">Note 5</a>)</b>        |                     |                                                                           |      |                        |      |       |
| Clock Frequency                                                                                                 | f <sub>SCL</sub>    |                                                                           |      |                        | 3.4  | MHz   |
| Setup Time REPEATED START Condition                                                                             | t <sub>SU_STA</sub> |                                                                           | 160  |                        |      | ns    |
| Hold Time (REPEATED) START Condition                                                                            | t <sub>HD_STA</sub> |                                                                           | 160  |                        |      | ns    |
| SCL Low Period                                                                                                  | t <sub>LOW</sub>    |                                                                           | 160  |                        |      | ns    |
| SCL High Period                                                                                                 | t <sub>HIGH</sub>   |                                                                           | 60   |                        |      | ns    |
| Data Setup Time                                                                                                 | t <sub>SU_DAT</sub> |                                                                           | 10   |                        |      | ns    |
| Data Hold Time                                                                                                  | t <sub>HD_DAT</sub> |                                                                           | 0    |                        | 70   | ns    |
| SCL Rise Time                                                                                                   | t <sub>rCL</sub>    | T <sub>A</sub> = +25°C                                                    | 10   |                        | 40   | ns    |
| Rise Time of SCL Signal After REPEATED START Condition and After Acknowledge Bit                                | t <sub>rCL1</sub>   | T <sub>A</sub> = +25°C                                                    | 10   |                        | 80   | ns    |

**Electrical Characteristics—I<sup>2</sup>C Serial Interface (continued)**

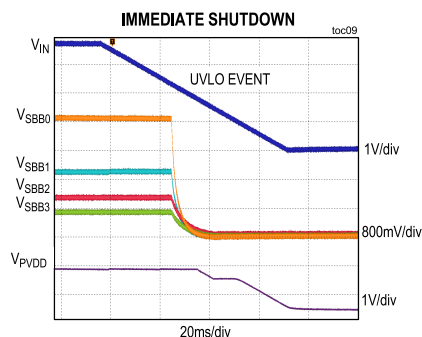
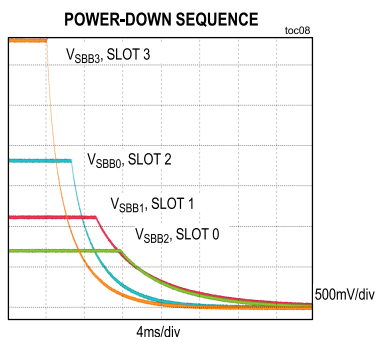
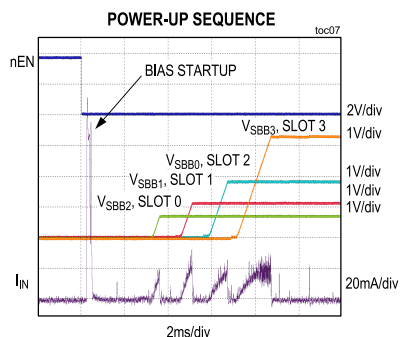
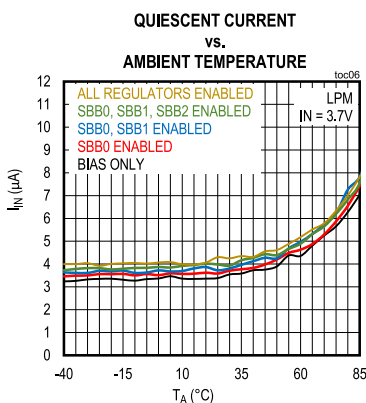
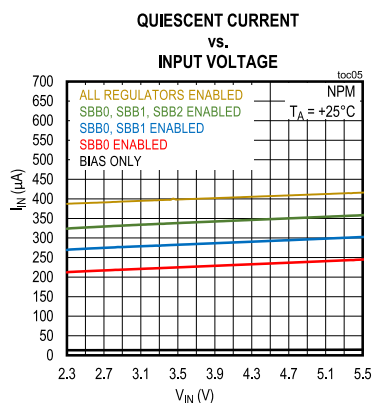
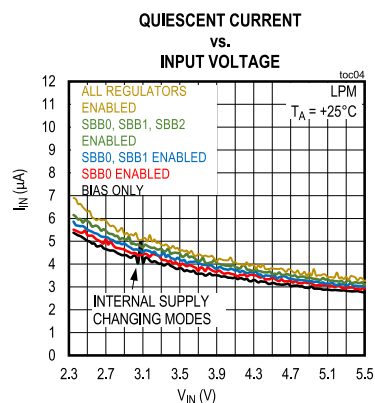
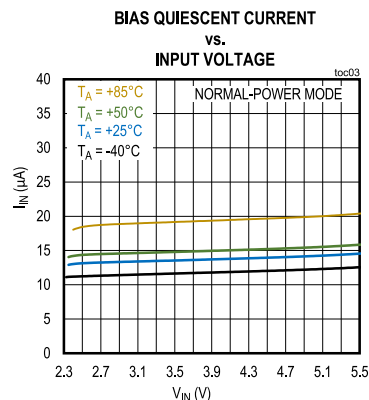
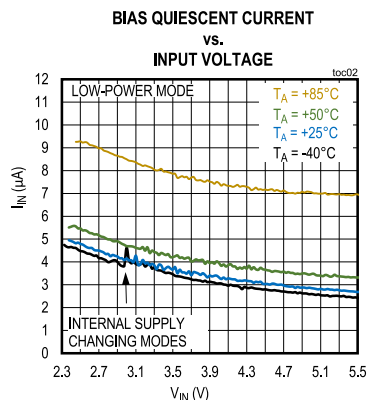
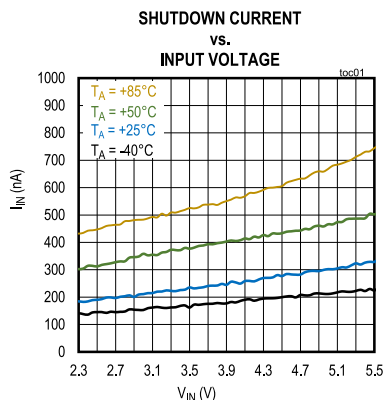
(V<sub>IN</sub> = 3.7V, Limits are 100% tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range (T<sub>A</sub> = -40°C to +85°C) and relevant supply voltage range are guaranteed by design and characterization, unless otherwise noted. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER                                                                                | SYMBOL              | CONDITIONS                                                                | MIN | TYP | MAX | UNITS |
|------------------------------------------------------------------------------------------|---------------------|---------------------------------------------------------------------------|-----|-----|-----|-------|
| SCL Fall Time                                                                            | t <sub>FCL</sub>    | T <sub>A</sub> = +25°C                                                    | 10  |     | 40  | ns    |
| SDA Rise Time                                                                            | t <sub>rDA</sub>    | T <sub>A</sub> = +25°C                                                    | 10  |     | 80  | ns    |
| SDA Fall Time                                                                            | t <sub>fDA</sub>    | T <sub>A</sub> = +25°C                                                    | 10  |     | 80  | ns    |
| Setup Time for STOP Condition                                                            | t <sub>SU_STO</sub> |                                                                           | 160 |     |     | ns    |
| Bus Capacitance                                                                          | C <sub>B</sub>      |                                                                           |     |     | 100 | pF    |
| Pulse Width of Suppressed Spikes                                                         | t <sub>SP</sub>     | Maximum pulse width of spikes that must be suppressed by the input filter |     |     | 10  | ns    |
| <b>I<sup>2</sup>C-COMPATIBLE INTERFACE TIMING (HIGH-SPEED MODE, CB = 400pF) (Note 5)</b> |                     |                                                                           |     |     |     |       |
| Clock Frequency                                                                          | f <sub>SCL</sub>    |                                                                           |     |     | 1.7 | MHz   |
| Setup Time REPEATED START Condition                                                      | t <sub>SU_STA</sub> |                                                                           | 160 |     |     | ns    |
| Hold Time (REPEATED) START Condition                                                     | t <sub>HD_STA</sub> |                                                                           | 160 |     |     | ns    |
| SCL Low Period                                                                           | t <sub>LOW</sub>    |                                                                           | 320 |     |     | ns    |
| SCL High Period                                                                          | t <sub>HIGH</sub>   |                                                                           | 120 |     |     | ns    |
| Data Setup Time                                                                          | t <sub>SU_DAT</sub> |                                                                           | 10  |     |     | ns    |
| Data Hold Time                                                                           | t <sub>HD_DAT</sub> |                                                                           | 0   |     | 150 | ns    |
| SCL Rise Time                                                                            | t <sub>RCL</sub>    | T <sub>A</sub> = +25°C                                                    | 20  |     | 80  | ns    |
| Rise Time of SCL Signal After REPEATED START Condition and After Acknowledge Bit         | t <sub>RCL1</sub>   | T <sub>A</sub> = +25°C                                                    | 20  |     | 160 | ns    |
| SCL Fall Time                                                                            | t <sub>FCL</sub>    | T <sub>A</sub> = +25°C                                                    | 20  |     | 80  | ns    |
| SDA Rise Time                                                                            | t <sub>rDA</sub>    | T <sub>A</sub> = +25°C                                                    | 20  |     | 160 | ns    |
| SDA Fall Time                                                                            | t <sub>fDA</sub>    | T <sub>A</sub> = +25°C                                                    | 20  |     | 160 | ns    |
| Setup Time for STOP Condition                                                            | t <sub>SU_STO</sub> |                                                                           | 160 |     |     | ns    |
| Bus Capacitance                                                                          | C <sub>B</sub>      |                                                                           |     |     | 400 | pF    |
| Pulse Width of Suppressed Spikes                                                         | t <sub>SP</sub>     | Maximum pulse width of spikes that must be suppressed by the input filter |     | 10  |     | ns    |

**Note 5:** Design guidance only. Not production tested.

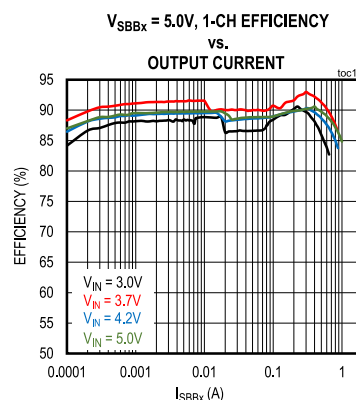
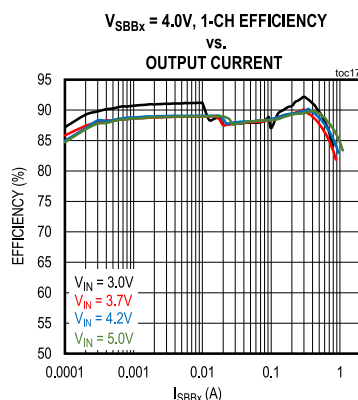
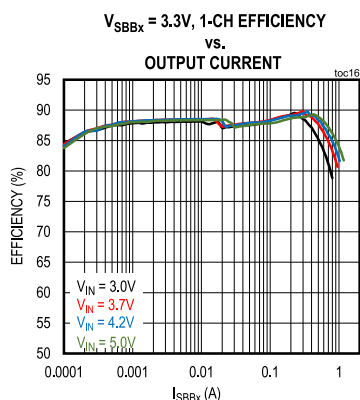
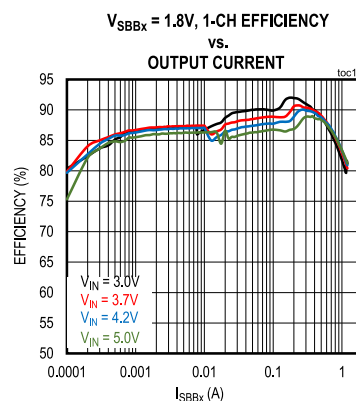
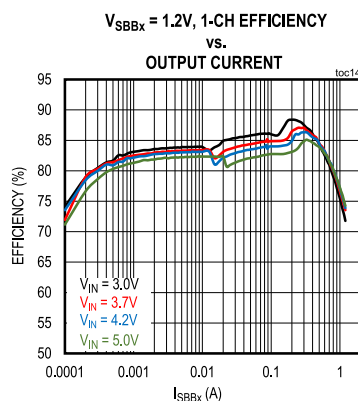
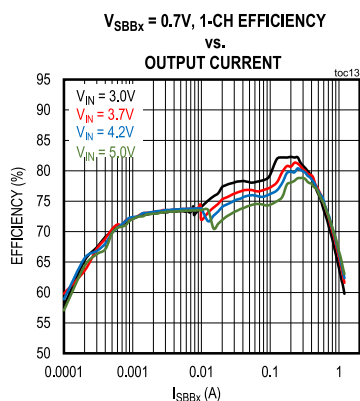
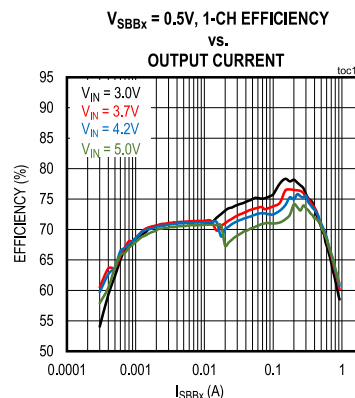
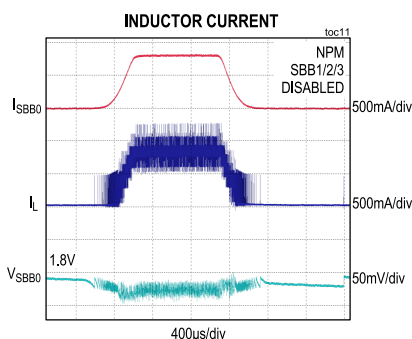
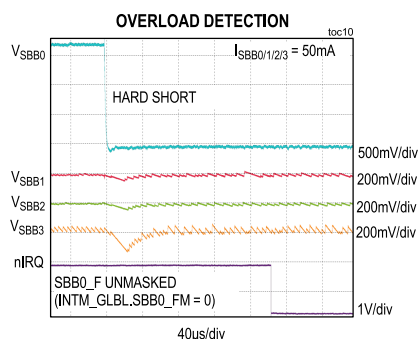
## Typical Operating Characteristics

(Typical Applications Circuit.  $V_{IN} = 3.7V$ ,  $C_{SBBx} = 22\mu F$ ,  $L = 1.5\mu H$ ,  $T_A = +25^\circ C$ ,  $V_{SBB0} = 1.8V$ ,  $V_{SBB1} = 1.1V$ ,  $V_{SBB2} = 0.7V$ ,  $V_{SBB3} = 3.3V$ , unless otherwise noted.)



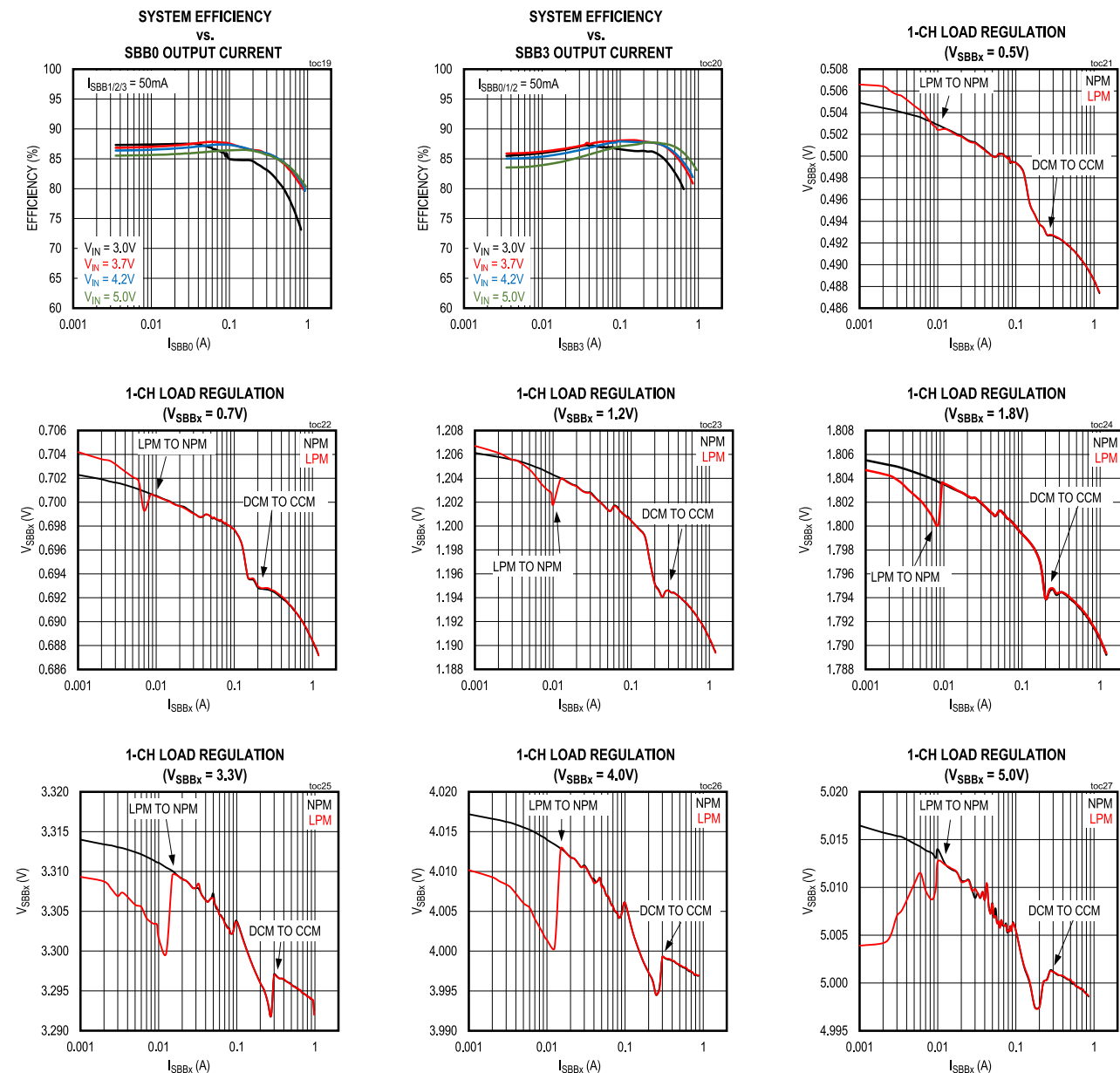
## Typical Operating Characteristics (continued)

(Typical Applications Circuit.  $V_{IN} = 3.7V$ ,  $C_{SBBx} = 22\mu F$ ,  $L = 1.5\mu H$ ,  $T_A = +25^\circ C$ ,  $V_{SBB0} = 1.8V$ ,  $V_{SBB1} = 1.1V$ ,  $V_{SBB2} = 0.7V$ ,  $V_{SBB3} = 3.3V$ , unless otherwise noted.)



## Typical Operating Characteristics (continued)

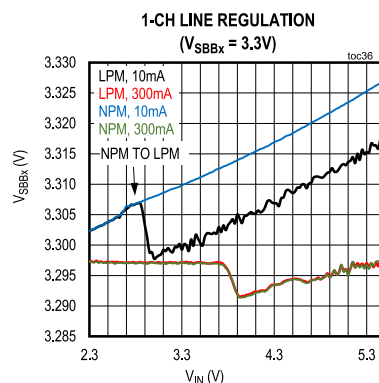
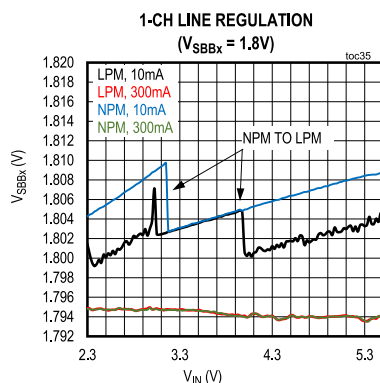
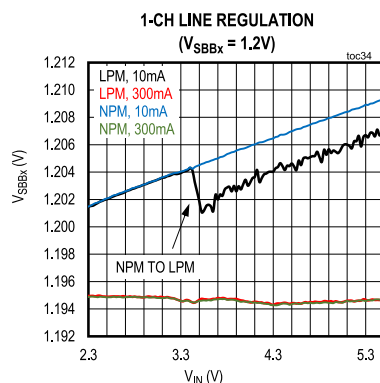
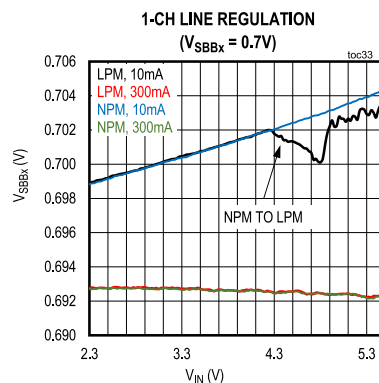
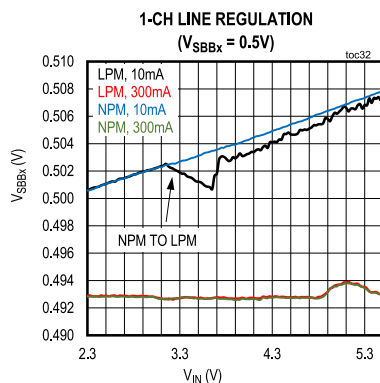
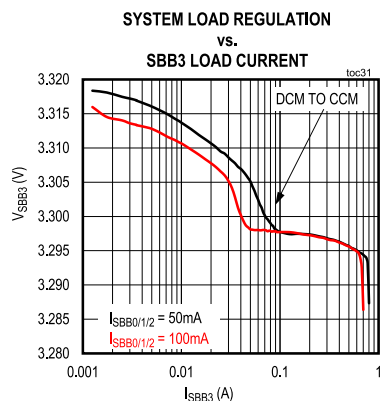
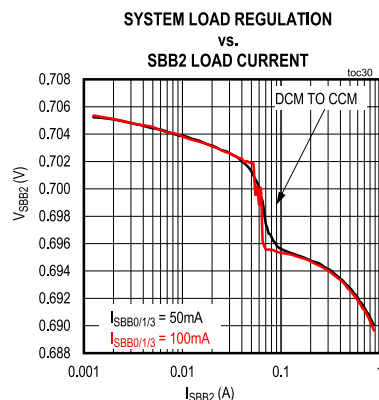
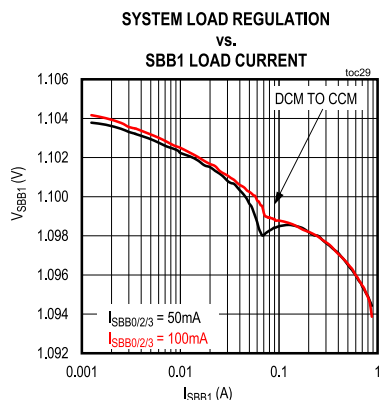
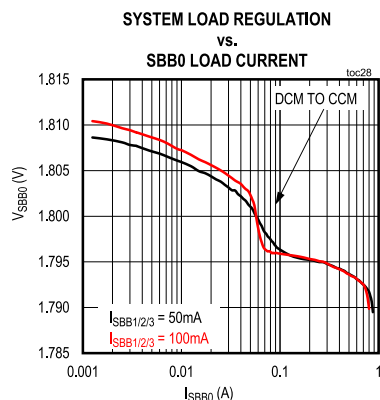
(Typical Applications Circuit.  $V_{IN} = 3.7V$ ,  $C_{SBBx} = 22\mu F$ ,  $L = 1.5\mu H$ ,  $T_A = +25^\circ C$ ,  $V_{SBB0} = 1.8V$ ,  $V_{SBB1} = 1.1V$ ,  $V_{SBB2} = 0.7V$ ,  $V_{SBB3} = 3.3V$ , unless otherwise noted.)





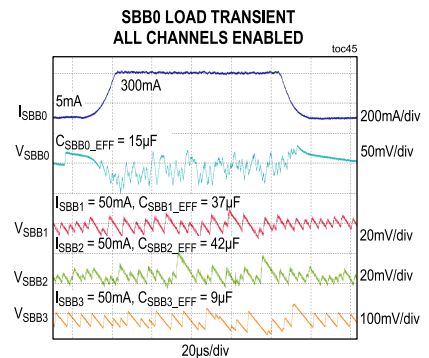
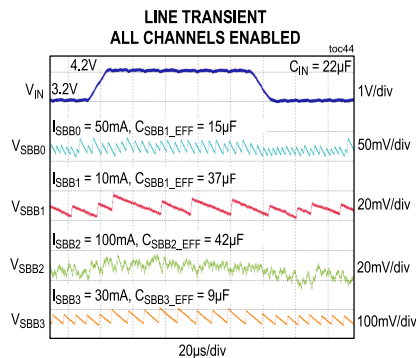
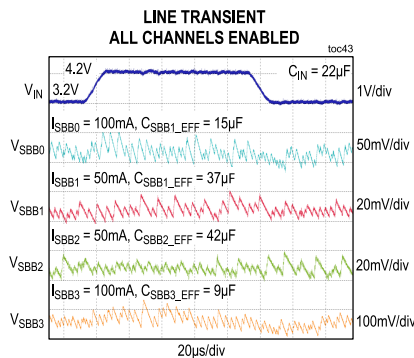
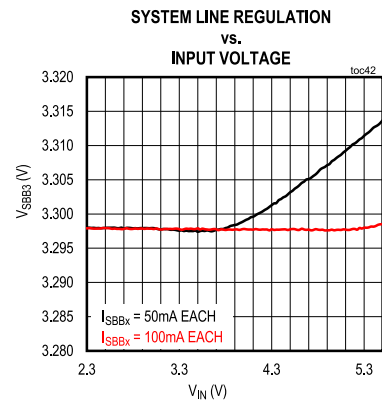
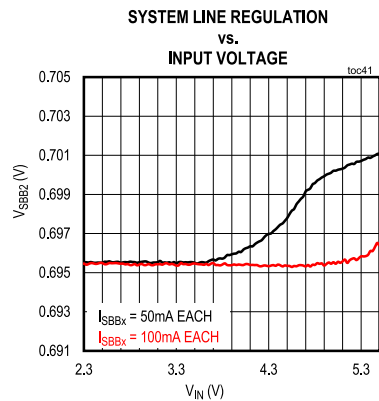
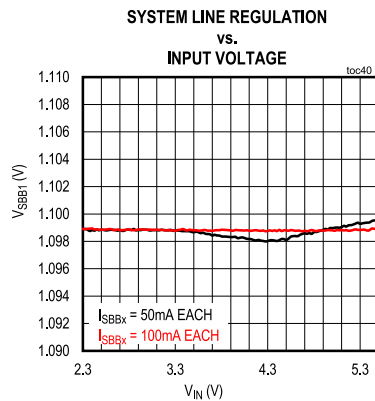
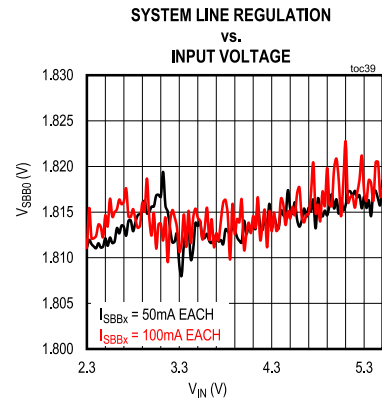
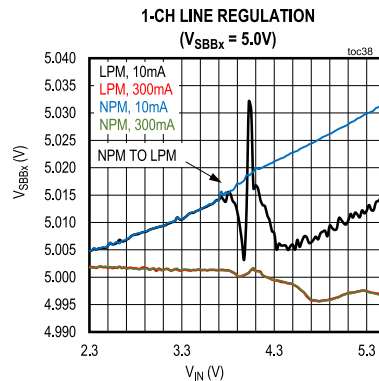
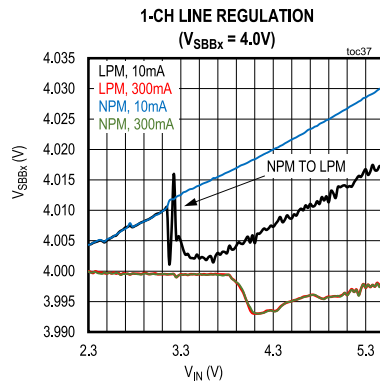
## Typical Operating Characteristics (continued)

(Typical Applications Circuit.  $V_{IN} = 3.7V$ ,  $C_{SBBx} = 22\mu F$ ,  $L = 1.5\mu H$ ,  $T_A = +25^\circ C$ ,  $V_{SBB0} = 1.8V$ ,  $V_{SBB1} = 1.1V$ ,  $V_{SBB2} = 0.7V$ ,  $V_{SBB3} = 3.3V$ , unless otherwise noted.)



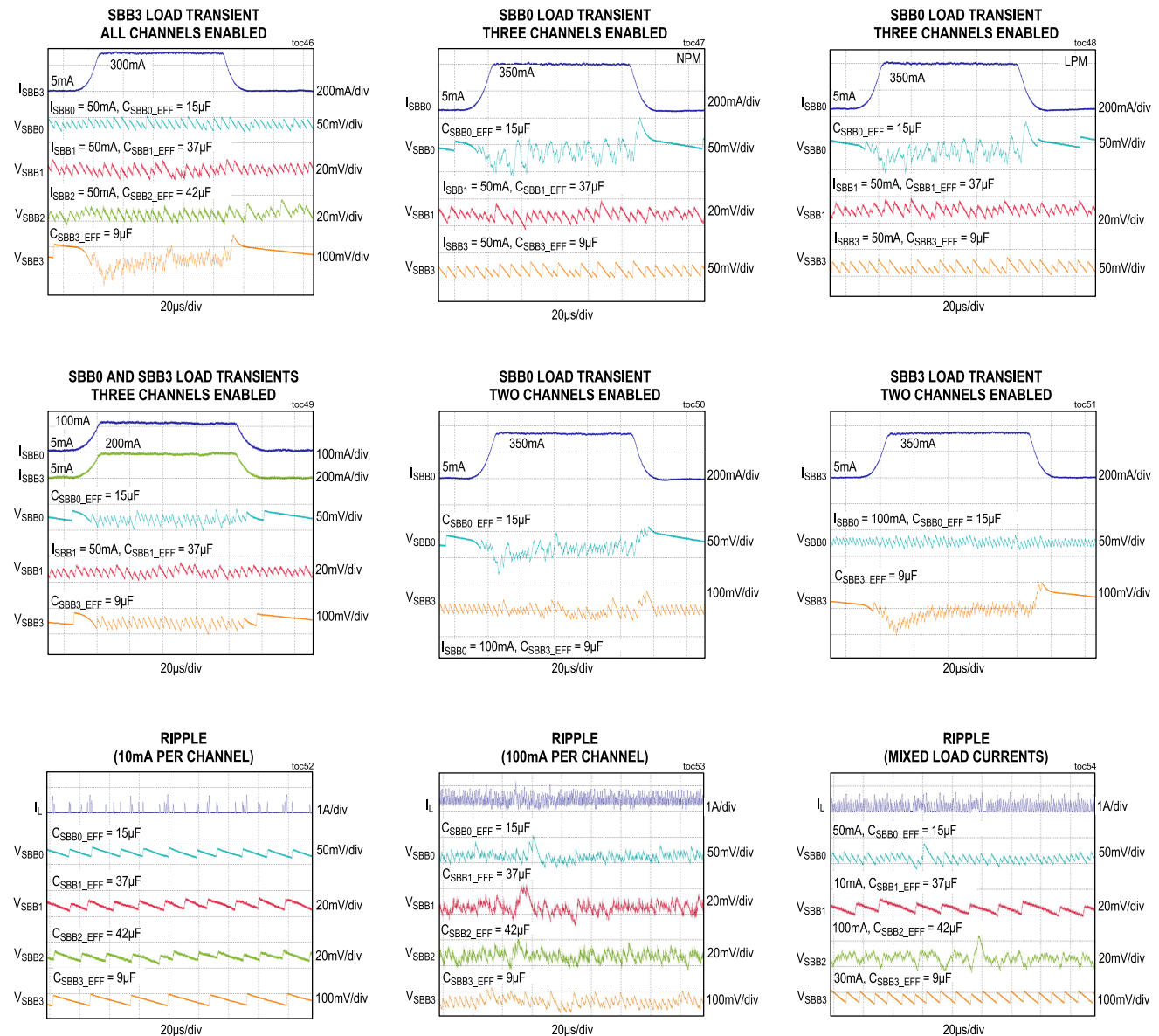
## Typical Operating Characteristics (continued)

(Typical Applications Circuit.  $V_{IN} = 3.7V$ ,  $C_{SBBx} = 22\mu F$ ,  $L = 1.5\mu H$ ,  $T_A = +25^\circ C$ ,  $V_{SBB0} = 1.8V$ ,  $V_{SBB1} = 1.1V$ ,  $V_{SBB2} = 0.7V$ ,  $V_{SBB3} = 3.3V$ , unless otherwise noted.)



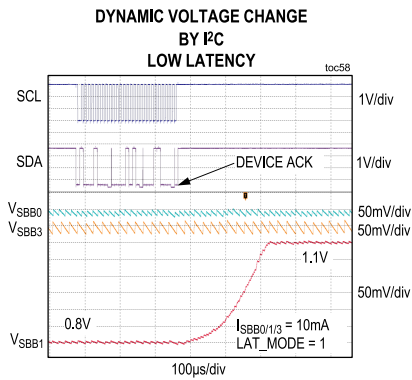
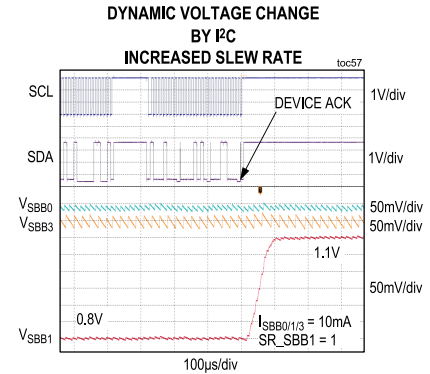
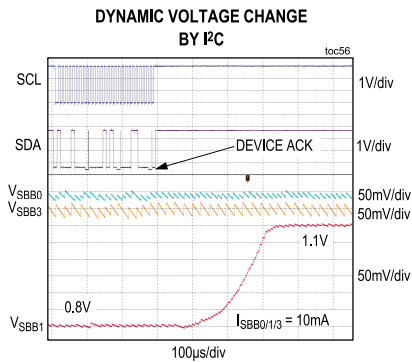
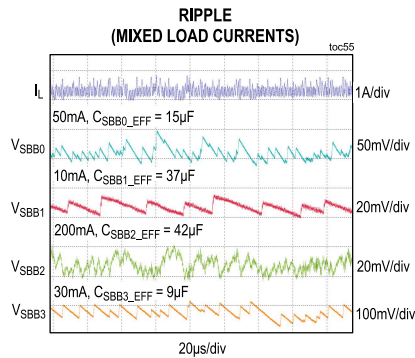
## Typical Operating Characteristics (continued)

(Typical Applications Circuit.  $V_{IN} = 3.7V$ ,  $C_{SBBx} = 22\mu F$ ,  $L = 1.5\mu H$ ,  $T_A = +25^\circ C$ ,  $V_{SBB0} = 1.8V$ ,  $V_{SBB1} = 1.1V$ ,  $V_{SBB2} = 0.7V$ ,  $V_{SBB3} = 3.3V$ , unless otherwise noted.)



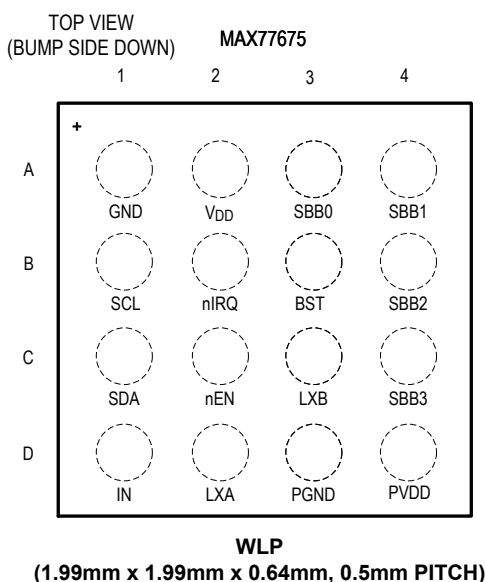
**Typical Operating Characteristics (continued)**

(Typical Applications Circuit.  $V_{IN} = 3.7V$ ,  $C_{SBBx} = 22\mu F$ ,  $L = 1.5\mu H$ ,  $T_A = +25^\circ C$ ,  $V_{SBB0} = 1.8V$ ,  $V_{SBB1} = 1.1V$ ,  $V_{SBB2} = 0.7V$ ,  $V_{SBB3} = 3.3V$ , unless otherwise noted.)



## Pin Configuration

### MAX77675



## Pin Description

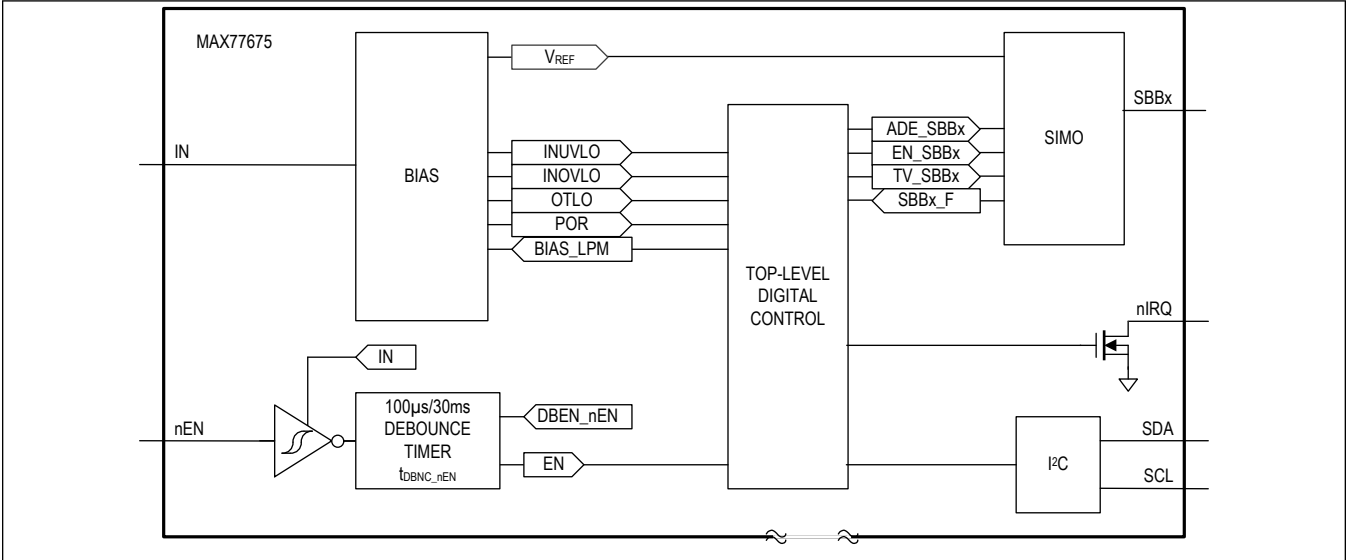
| PIN                    | NAME            | FUNCTION                                                                                                                                                                                                                                                                                                                                                             | TYPE           |
|------------------------|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|
| <b>TOP LEVEL</b>       |                 |                                                                                                                                                                                                                                                                                                                                                                      |                |
| C2                     | nEN             | Active-Low Enable Input. $\overline{\text{EN}}$ supports push-button, slide-switch, or logic configurations. If not used, connect nEN to IN.                                                                                                                                                                                                                         | Digital Input  |
| B2                     | nIRQ            | Active-Low, Open-Drain Interrupt Pin. Connect a 100k $\Omega$ pull-up resistor to nIRQ.                                                                                                                                                                                                                                                                              | Digital Output |
| B1                     | SCL             | I <sup>2</sup> C Clock                                                                                                                                                                                                                                                                                                                                               | Digital Input  |
| C1                     | SDA             | I <sup>2</sup> C Data                                                                                                                                                                                                                                                                                                                                                | Digital I/O    |
| D1                     | IN              | Input Voltage Connection                                                                                                                                                                                                                                                                                                                                             | Power Input    |
| A1                     | GND             | Quiet Ground. Connect GND to PGND and the low-impedance ground plane of the PCB.                                                                                                                                                                                                                                                                                     | Ground         |
| A2                     | V <sub>DD</sub> | Device Power Input. Connect to PVDD. Bypass to GND with a 10 $\mu$ F capacitor.                                                                                                                                                                                                                                                                                      | Power Input    |
| D4                     | PVDD            | 1.8V Internal Supply. Bypass this pin with a 10 $\mu$ F capacitor and connect to V <sub>DD</sub> . Do not connect anything else to this pin. If pullup resistors must be connected to PVDD, ensure on the layout the connection points are as close as possible to the capacitor and not the pin. See the <a href="#">PCB Layout Guide</a> section for more details. | Power Output   |
| <b>SIMO BUCK-BOOST</b> |                 |                                                                                                                                                                                                                                                                                                                                                                      |                |
| A3                     | SBB0            | SIMO Buck-Boost Output 0. SBB0 is the power output for Channel 0 of the SIMO buck-boost. If not used, see the <a href="#">Unused Outputs</a> section.                                                                                                                                                                                                                | Power Output   |
| A4                     | SBB1            | SIMO Buck-Boost Output 1. SBB1 is the power output for Channel 1 of the SIMO buck-boost. If not used, see the <a href="#">Unused Outputs</a> section.                                                                                                                                                                                                                | Power Output   |
| B4                     | SBB2            | SIMO Buck-Boost Output 2. SBB2 is the power output for Channel 2 of the SIMO buck-boost. If not used, see the <a href="#">Unused Outputs</a> section.                                                                                                                                                                                                                | Power Output   |

Pin Description (continued)

| PIN | NAME | FUNCTION                                                                                                                                              | TYPE         |
|-----|------|-------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|
| C4  | SBB3 | SIMO Buck-Boost Output 3. SBB3 is the power output for Channel 3 of the SIMO buck-boost. If not used, see the <a href="#">Unused Outputs</a> section. | Power Output |
| B3  | BST  | SIMO Power Input for the High-Side Output NMOS Drivers. Connect a 10nF ceramic capacitor between BST and LXB.                                         | Power Input  |
| C3  | LXB  | Switching Node B. LXB is driven between PGND and SBBx when SBBx is enabled. LXB is driven to PGND when all SIMO channels are disabled.                | Power I/O    |
| D2  | LXA  | Switching Node A. LXA is driven between PGND and IN when any SIMO channel is enabled. LXA is driven to PGND when all SIMO channels are disabled.      | Power I/O    |
| D3  | PGND | Power Ground for the SIMO Low-Side FETs. Connect PGND to GND and the low-impedance ground plane of the PCB.                                           | Ground       |

Functional Diagrams

Top Level Interconnect



Detailed Description

The MAX77675 provides a power management solution for low-power applications. A SIMO buck-boost regulator efficiently provides four independently programmable power rails. A bidirectional I<sup>2</sup>C serial interface allows for configuring and checking the status of the device. An internal on/off controller provides power sequencing and supervisory functionality for the device.

Part Number Decoding

The MAX77675 has different one-time programmable (OTP) options and variants to support a variety of applications. The OTP options set default settings such as output voltage. See [Figure 1](#) for how to identify these. [Table 1](#) lists all available OTP options. Refer to [Product Naming Convention](#) for more details.

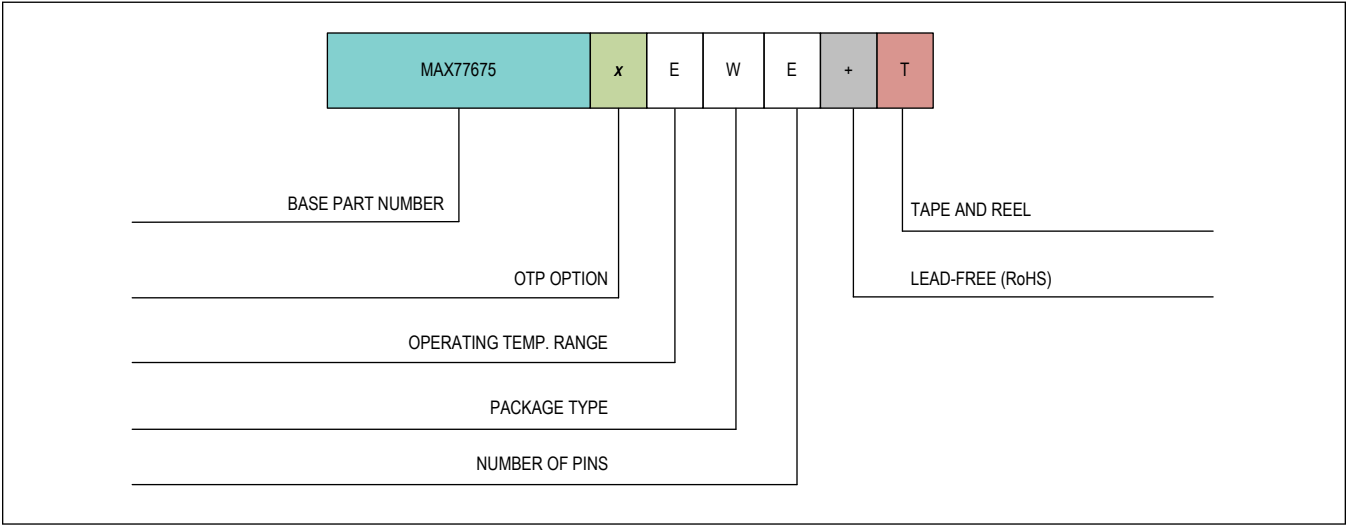


Figure 1. Part Number Decode

Table 1. OTP Options Table

|        |                |                                  | OTP LETTER AND SETTINGS |                 |
|--------|----------------|----------------------------------|-------------------------|-----------------|
| BLOCK  | BIT FIELD NAME | SETTING NAME                     | A                       | C               |
| Global | CID[7:0]       | OTP Identifier                   | 0x3                     | 0xC             |
|        | PU_DIS         | Pullup Disable                   | Disabled                | Enabled (200kΩ) |
|        | BIAS_LPM       | Bias Power Mode                  | LPM                     | LPM             |
|        | MRT            | Manual Reset Time                | 8s                      | 8s              |
|        | nEN_MODE       | nEN Mode                         | Logic                   | Logic           |
|        | DBEN_nEN       | nEN Debounce Time                | 100μs                   | 100μs           |
|        | ADDR           | I <sup>2</sup> C Address (7-bit) | 0x44                    | 0x40            |
|        | OVLO_R         | OVLO Rising Threshold            | 5.85V                   | 5.65V           |
|        | UVLO_F         | UVLO Falling Threshold           | 2.30V                   | 2.30V           |
|        | UVLO_H         | UVLO Threshold Hysteresis        | 0.30V                   | 0.30V           |
| SIMO   | TV_SBB0[7:0]   | SBB0 V <sub>OUT</sub>            | 1.800V                  | 3.300V          |
|        | ADE_SBB0       | Active-Discharge Resistor Enable | Enabled                 | Enabled         |
|        | EN_SBB0[2:0]   | SBB0 Enable Control              | FPS Slot 2              | FPS Slot 1      |
|        | TV_SBB1[7:0]   | SBB1 V <sub>OUT</sub>            | 1.100V                  | 4.000V          |
|        | ADE_SBB1       | Active-Discharge Resistor Enable | Enabled                 | Enabled         |
|        | EN_SBB1[2:0]   | SBB1 Enable Control              | FPS Slot 1              | FPS Slot 0      |
|        | TV_SBB2[7:0]   | SBB2 V <sub>OUT</sub>            | 0.700V                  | 1.500V          |
|        | ADE_SBB2       | Active-Discharge Resistor Enable | Enabled                 | Enabled         |
|        | EN_SBB2[2:0]   | SBB2 Enable Control              | FPS Slot 0              | FPS Slot 3      |
|        | TV_SBB3[7:0]   | SBB3 V <sub>OUT</sub>            | 3.300V                  | 1.800V          |
|        | ADE_SBB3       | Active-Discharge Resistor Enable | Enabled                 | Enabled         |
|        | EN_SBB3[2:0]   | SBB3 Enable Control              | FPS Slot 3              | FPS Slot 2      |

## Support Materials

The following support materials are available for this device:

- MAX77675 [Register Map](#): Full table of registers that can be read from or written to by I<sup>2</sup>C.
- MAX77675 [Programmer's Guide](#): Basic software implementation guide. (**Note:** The guide applies to both the MAX77655 and MAX77675.)
- MAX77675 [SIMO Calculator](#): Tool to determine if a given set of voltages and currents are supported. The tool can be found under **Design Resources** in the product web page.

## Voltage Monitors

The device monitors the input voltage (V<sub>IN</sub>) to ensure proper operation using three comparators (POR, UVLO, and OVLO). These comparators include hysteresis to prevent their outputs from toggling between states during noisy system transitions.

### IN POR Comparator

The IN POR comparator monitors V<sub>IN</sub> and generates a power-on reset signal (POR). When V<sub>IN</sub> is below V<sub>POR</sub>, the device is held in reset (RST = 1, POR = 1). When V<sub>IN</sub> rises above V<sub>POR</sub>, the device enters shutdown state (RST = 1, POR = 0). See [Figure 5](#) and [Table 2](#) for more details.

### IN Undervoltage Lockout Comparator

The IN UVLO comparator monitors V<sub>IN</sub> and generates an INUVLO signal when the V<sub>IN</sub> falls below the UVLO threshold.



The INUVLO signal is provided to the top-level digital controller. See [Figure 5](#) and [Table 2](#) for additional information regarding the UVLO comparator:

- When the device is in the Shutdown state, the UVLO comparator is disabled.
- When transitioning out of the Shutdown state, the UVLO comparator is enabled allowing the device to check for sufficient input voltage. If  $V_{IN}$  is above the UVLO rising threshold and a wake-up signal is received, the device can transition to the Resource On state; otherwise, the device transitions back to the Shutdown state.

### IN Overvoltage Lockout Comparator

The device is rated for 5.5V maximum operating voltage ( $V_{IN}$ ) with an absolute maximum input voltage of 6.0V. An OVLO monitor increases the robustness of the device by inhibiting operation when the supply voltage is greater than  $V_{INOVLO}$ . See [Figure 5](#) and [Table 2](#) for additional information regarding the OVLO comparator:

- When the device is in the Shutdown state, the OVLO comparator is disabled.

### Thermal Monitors

The MAX77675 has three global on-chip thermal sensors:

- Junction Temperature Alarm 1 → 90°C
- Junction Temperature Alarm 2 → 120°C
- Junction Temperature Shutdown → 145°C

The junction temperature alarms have maskable rising interrupts as well as status bits (see the [Register Map](#) section for more information). Unmasking these thermal alarms is recommended for all systems. If the first alarm is triggered, the system software should attempt to lower system power dissipation. If the second alarm is triggered, then attempts to lower the power dissipation were unsuccessful and the system software should turn the device off. Finally, if the junction temperature rises to junction temperature shutdown, then the MAX77675 sets the ERCFLAG.TOVLD bit and automatically turns itself off.

After a junction temperature shutdown event, the system can be enabled again. The system software can read the ERCFLAG register during initialization to see ERCFLAG.TOVLD = 1 and log that an extreme thermal event has occurred.

### Thermal Shutdown

The MAX77675 has on-chip thermal sensors to monitor thermal overloads. The thermal overload alarm generates a TOVLD signal when the junction temperature exceeds +145°C ( $T_{JOVLD}$ ). The on/off controller provides TOVLD. When TOVLD is asserted, the on/off controller forces system reset which disables all functions of the MAX77675. Once all functions are disabled, a wake-up event is required to turn the MAX77675 on again. In the case that a wake-up event turns the MAX77675 on when the junction temperature is still above +145°C, the MAX77675's on/off controller promptly forces system reset which disables all functions again. The thermal monitoring function is sampled in low-power mode to save quiescent current. The host can check if a temperature overload occurred by reading the ERCFLAG.TOVLD flag.

### Chip Identification

Different OTP variants of the MAX77675 offer different settings such as settings for default output voltages or power sequencing. These OTP variants are identified by the Chip Identification number, which can be read in the CID register.

### nEN Enable Input

The nEN is an active-low, internally debounced digital input that typically comes from the system's on-key. The debounce time is programmable with CNFG\_GLBL\_A.DBEN\_nEN. The primary purpose of this input is to generate a wake-up signal for the PMIC, turning on the regulators. Maskable rising/falling interrupts are available for nEN (INTM\_GLBL.nEN\_R and INTM\_GLBL.nEN\_F) for alternate functionality.

The nEN input can be configured to work with a push-button (CNFG\_GLBL\_A.nEN\_MODE[1:0] = 0x0), a slide-switch (CNFG\_GLBL\_A.nEN\_MODE[1:0] = 0x1), or a logic output of an external device (CNFG\_GLBL\_A.nEN\_MODE[1:0] = 0x2). See [Figure 2](#) for more information. In both push-button and slide-switch modes, the on/off controller looks for a falling edge on the nEN input to initiate a power-up sequence. In logic mode, the on/off controller initiates a power-up or power-down sequence depending on the nEN value. There is no debouncing for logic mode.

### nEN Manual Reset

The nEN pin works as a manual reset input when the on/off controller is in the Resource On state. The manual reset function is useful for forcing a power-down in case communication with the processor fails. When nEN is configured for push-button mode and the input is asserted (nEN = LOW) for an extended period ( $t_{MRST}$ ), the on/off controller initiates a power-down sequence and goes to shutdown mode. When nEN is configured for slide-switch mode and the input is deasserted (nEN = HIGH) for an extended period ( $t_{MRST}$ ), the on/off controller initiates a power-down sequence and goes to shutdown mode. Logic mode does not depend on a manual reset time ( $t_{MRST}$ ), so when nEN is pulled high, the on/off controller initiates a power-down sequence and goes to shutdown mode. In all modes, the ERCFLAG.MRST flag sets to indicate a reset occurred.

### nEN Triple Functionality: Push-Button vs. Slide-Switch vs. Logic

The nEN digital input can be configured to work with a push-button switch, a slide-switch, or a logic output. [Figure 2](#) shows nEN's triple functionality for power-on sequencing and manual reset.

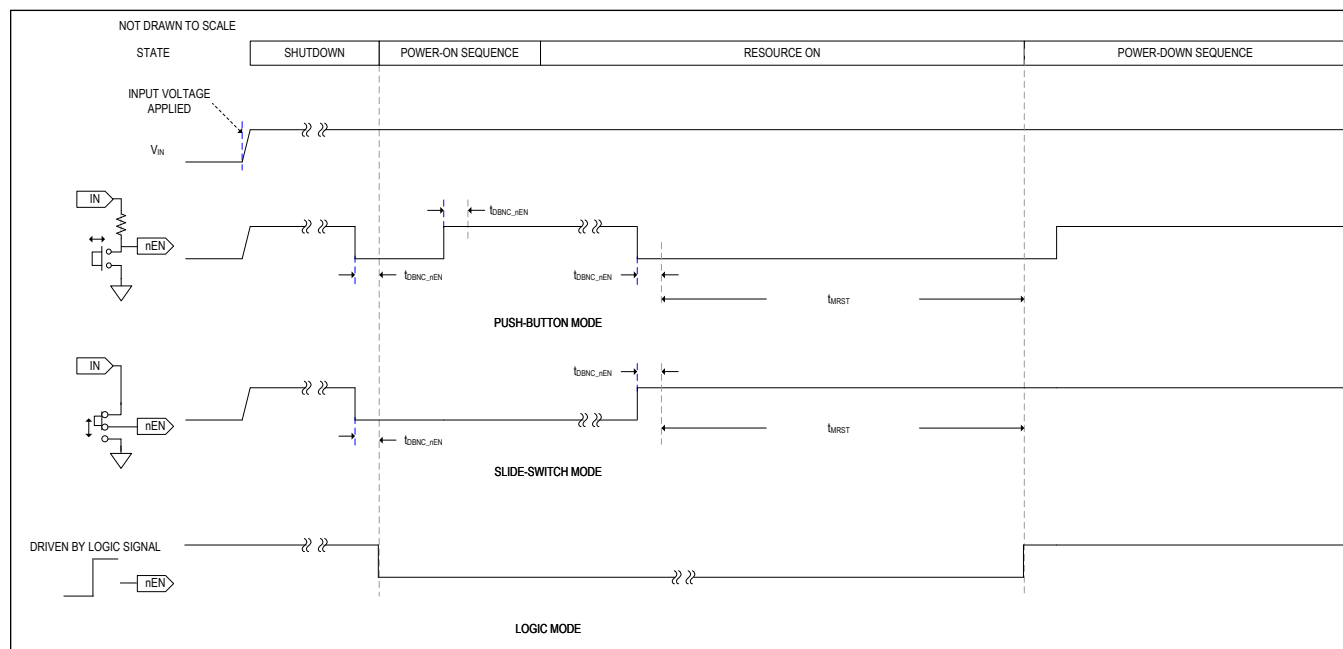


Figure 2. nEN Usage Timing Diagram

### Debounced Input

The nEN is debounced on both rising and falling edges to reject undesired transitions. The input must be at a stable logic level for the entire debounce period for the output to change its logic state. [Figure 3](#) shows an example timing diagram for the nEN debounce.

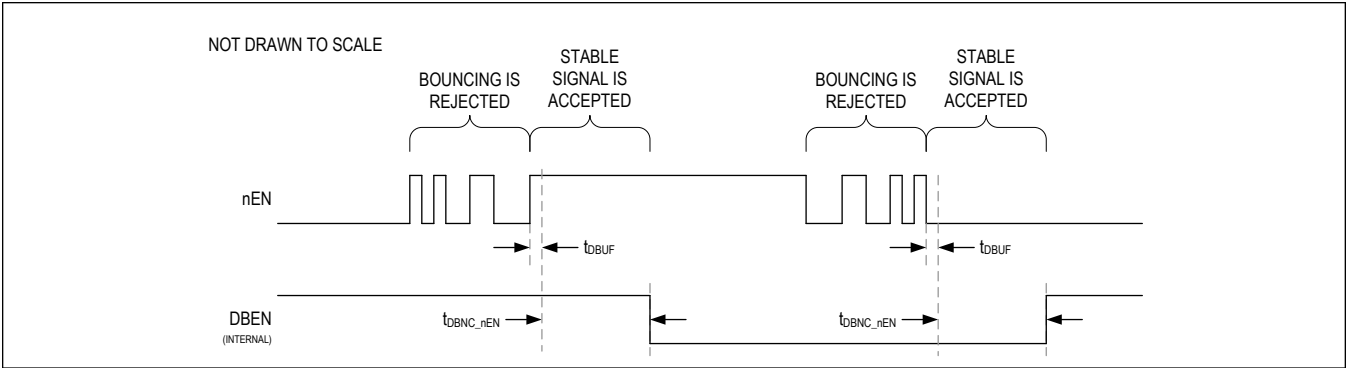


Figure 3. Debounced Input

**nEN Internal Pullup Resistors to V<sub>IN</sub>**

The nEN logic thresholds are referenced to V<sub>IN</sub>. There is an internal pullup resistor between nEN and V<sub>IN</sub> (R<sub>nEN\_PU</sub>), which can be enabled by setting CNFG\_GLBL\_A.PU\_DIS = 0. See [Figure 4](#). While enabled, the pullup value is approximately 200kΩ. While PU\_DIS = 1, the nEN node has high impedance.

Applications using a slide-switch on-key or push-pull digital output connected to nEN can reduce quiescent current consumption by disabling the pullup resistor. Applications using normally-open, momentary, and push-button on-keys (as shown in [Figure 4](#)) can use the internal resistor to avoid external components.

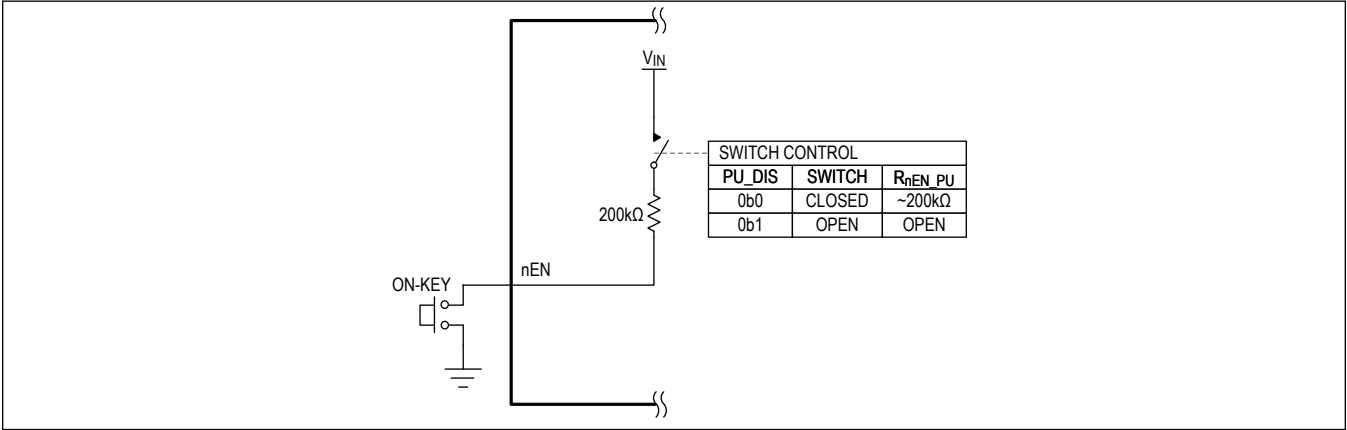


Figure 4. nEN Pullup Resistor Configuration

**Interrupts (nIRQ)**

Several status, interrupt, and interrupt mask registers monitor key information and update when an interrupt event has occurred. See the [Register Map](#) section for a comprehensive list of all interrupt bits and status registers.

Depending on OTP, some or all interrupts are masked by default. Initialization software should unmask interrupts of interest.

The nIRQ is an active-low, open-drain output typically routed to a processor's interrupt input for triggering off interrupt events. When any unmasked interrupt occurs, this pin is asserted (LOW). A pullup resistor is required for this signal, and is typically found inside the host processor. If one is unavailable, a board-mounted pullup resistor is required.

### On/Off Controller

The on/off controller monitors multiple power-up (wake-up) and power-down (shutdown) conditions to enable or disable resources that are necessary for the system and its processor to move between its operating modes.

Many systems have one power management controller and one processor and rely on the on/off controller to be the master controller. In this case, the on/off controller receives the wake-up events and enables some or all of the regulators in order to power up a processor. This processor then manages the system. To conceptualize this operation, see [Figure 5](#) and [Table 2](#). A typical path through the on/off controller during power-up is as follows:

1. Apply power to IN and start in the Shutdown state.
2. Press the system's on-key (nEN = LOW) and follow transitions 2, 3A, and 4 to the Resource On state.
3. The device performs its desired functions in the Resource On state. When a manual reset occurs, the device follows transitions 5A, 6, and 10 to the Shutdown state.

Some systems have several power management blocks, a main processor, and subprocessors. These systems can use this device as a subpower management block for a peripheral portion of circuitry as long as there is an I<sup>2</sup>C port available from a higher level processor. To conceptualize this slave operation, see [Figure 5](#) and [Table 2](#). Optionally, to avoid delay from debouncing the nEN pin, systems should use the MAX77675 with nEN configured to be in logic mode (CNFG\_GLBL\_A.nEN\_MODE[1:0] = 0b10) by OTP. A typical path through the on/off controller used in this way is as follows:

1. Apply power to IN and start in the Shutdown state.
2. When the higher level processor wants to turn on this device's resources, it pulls nEN LOW to follow transitions 2, 3A, and 4 to the Resource On state.
3. The higher level processor can control this device's resources with I<sup>2</sup>C commands (e.g., turn on/off regulators).
4. When the higher level processor is ready to turn this device off, it turns off everything through the I<sup>2</sup>C either with a software command (CNFG\_GLBL\_B.SFT\_CTRL[1:0]) or pulling nEN high to transition along paths 5A, 6, and 10 to the Shutdown state.
5. If the higher level processor wants to power down outputs on the FPS but keep the bias enabled (for I<sup>2</sup>C communication), it sends a SFT\_STBY command (CNFG\_GLBL\_B.SFT\_CTRL[1:0] = 0x3) to transition along paths 5B and 6 to the Standby state.
6. Afterward, to exit standby state, the processor sends a SFT\_EXIT\_STBY command (CNFG\_GLBL\_B.SFT\_CTRL[1:0] = 0x4) to transition along path 7 back to the wake-up action, eventually going back to the Resource On state.

## Top Level On/Off Controller

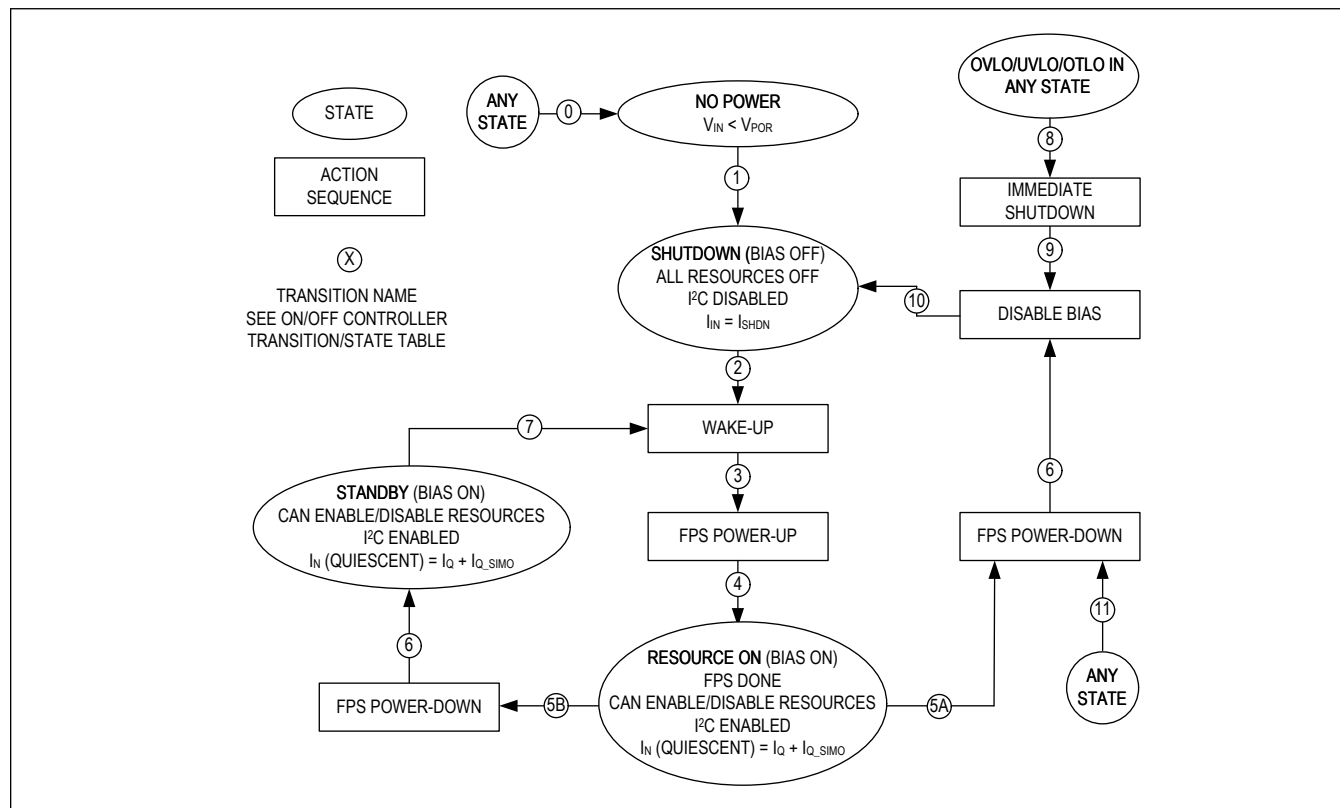


Figure 5. On/Off Controller State Diagram

Table 2. On/Off Controller Transition/State

| TRANSITION/STATE | CONDITION                                                                                                                                                                                                                                                                                                                                             |
|------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>0</b>         | IN voltage is below the POR threshold ( $V_{IN} < V_{POR}$ ).                                                                                                                                                                                                                                                                                         |
| <b>1</b>         | IN voltage is above the POR threshold ( $V_{IN} > V_{POR}$ ).                                                                                                                                                                                                                                                                                         |
| <b>SHUTDOWN</b>  | <ul style="list-style-type: none"> <li>The device is waiting for a wake-up signal to enable the main bias circuits.</li> <li>This is the lowest current state of the device (<math>I_Q \sim 0.3\mu A</math>)</li> <li>Main bias circuits and I<sup>2</sup>C are off. POR comparator is on</li> <li>The ERCFLAG register value is preserved</li> </ul> |
| <b>2</b>         | <ul style="list-style-type: none"> <li>A wake-up signal is received.</li> <li>A debounced on-key (nEN) falling edge is detected (push-button or slide-switch mode) <b>OR</b></li> <li>nEN is LOW (logic mode) <b>OR</b></li> <li>Internal wake-up flag is set due to cold reset command</li> </ul>                                                    |
| <b>3</b>         | No faults detected. In the ERCFLAG register: UVLO = 0, OVLO = 0, TOVLD = 0.                                                                                                                                                                                                                                                                           |
| <b>4</b>         | Power-up sequence is complete.                                                                                                                                                                                                                                                                                                                        |

**Table 2. On/Off Controller Transition/State (continued)**

| TRANSITION/STATE   | CONDITION                                                                                                                                                                                                                                                                                                                                                                                              |
|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>RESOURCE ON</b> | Flexible power sequencer went through power-up and I <sup>2</sup> C is on. The main bias circuits are enabled.                                                                                                                                                                                                                                                                                         |
| <b>5A</b>          | Request to power-down is received.<br><ul style="list-style-type: none"> <li>• Software cold reset (CNFG_GLBL_B.SFT_CTRL[1:0] = 0b01) occurred <b>OR</b></li> <li>• Software power off (CNFG_GLBL_B.SFT_CTRL[1:0] = 0b10) occurred <b>OR</b></li> <li>• Manual reset occurred</li> </ul>                                                                                                               |
| <b>5B</b>          | I <sup>2</sup> C command SFT_STBY received to enter standby mode                                                                                                                                                                                                                                                                                                                                       |
| <b>STANDBY</b>     | The device is waiting for a wake-up signal to restart.<br><ul style="list-style-type: none"> <li>• SIMO channels on the FPS are off.</li> <li>• SIMO channels that were forced on (CNFG_SBBx_B.EN_SBBx[2:0] = 0x6 or 0x7) stay on</li> <li>• The main bias circuits are enabled, and I<sup>2</sup>C is on.</li> <li>• Main bias circuits are in low-power mode if CNFG_GLBL_A.BIAS_LPM = 1.</li> </ul> |
| <b>6</b>           | Power-down sequence is finished.                                                                                                                                                                                                                                                                                                                                                                       |
| <b>7</b>           | Wake-up signal received.<br><ul style="list-style-type: none"> <li>• A debounced on-key (nEN) falling edge is detected (push-button mode) <b>OR</b></li> <li>• I<sup>2</sup>C wake-up command SFT_EXIT_STBY received <b>OR</b></li> <li>• Manual reset occurred</li> </ul>                                                                                                                             |
| <b>8</b>           | <ul style="list-style-type: none"> <li>• System overtemperature lockout (<math>T_J &gt; T_{OTLO}</math>) <b>OR</b></li> <li>• System undervoltage lockout (<math>V_{IN} &lt; V_{INUVLO}</math>) <b>OR</b></li> <li>• System overvoltage lockout (<math>V_{IN} &gt; V_{INOVLO}</math>)</li> </ul>                                                                                                       |
| <b>9</b>           | Immediate shutdown is finished.                                                                                                                                                                                                                                                                                                                                                                        |
| <b>10</b>          | Bias is disabled.                                                                                                                                                                                                                                                                                                                                                                                      |
| <b>11</b>          | nEN is HIGH (logic mode).                                                                                                                                                                                                                                                                                                                                                                              |

**Internal Wake-Up Flags**

After transitioning to the Shutdown state because of a reset, to allow the device to power-up again, internal wake-up flags are set to remember the wake-up request. In [Figure 5](#) and [Table 2](#), these internal wake-up flags trigger transition 2. The internal wake-up flags are set when any of the following happens:

- While in push-button or slide-switch mode, nEN is debounced (see the [nEN Enable Input](#) section)
  - For example, after a push button is pressed or a slide-switch is switched to HIGH
- While in logic mode, nEN is LOW (see the [nEN Enable Input](#) section)
- Software Cold Reset command sent (CNFG\_GLBL.SFT\_CTRL[1:0] = 0b01)

## On/Off Controller Actions

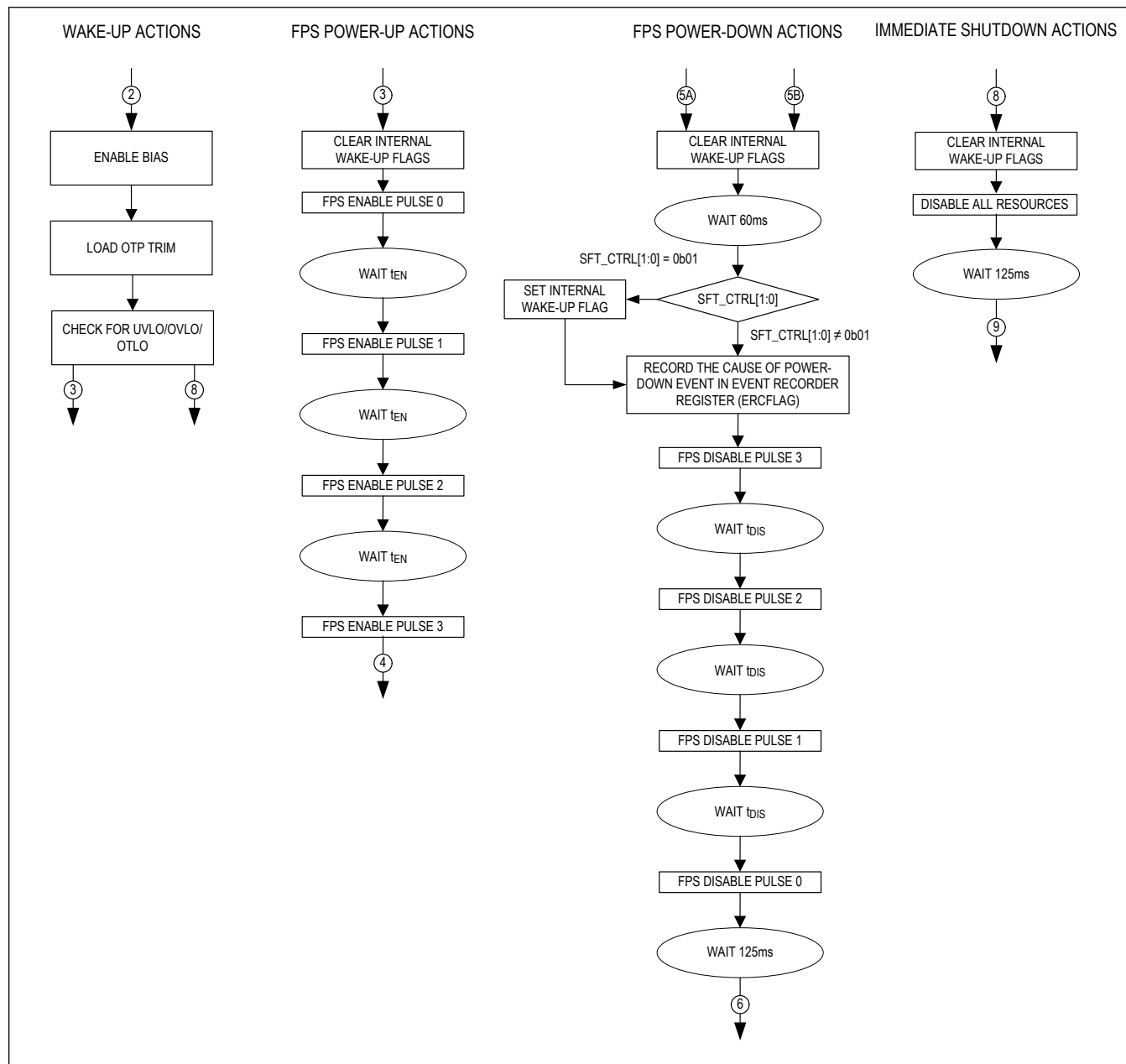


Figure 6. On/Off Controller Actions

## Flexible Power Sequencer

The FPS allows resources to power up under hardware or software control. Additionally, each resource can power up independently or among a group of other regulators with adjustable power-up and power-down slots (sequencing). [Figure 7](#) shows four resources powering up under the control of the FPS.

The flexible sequencing structure consists of one master sequencing timer and four slave resources (SBB0, SBB1, SBB2, and SBB3). When the FPS is enabled, a master timer generates four sequencing events for device power-up and power-

MAX77675

Low I<sub>Q</sub> SIMO PMIC with 0.5V to 5.5V Outputs  
Delivering Up to 700mA Total Output Current

down.

Therefore, the power-down sequence has a total delay up to 195.24ms (60ms + 4 x 2.56ms power-down slot delays + 125ms output discharge delay). If issuing the Software Cold Reset (CNFG\_GLBL\_A.SFT\_CTRL[1:0]), then wait more than 200ms before issuing additional commands through the I<sup>2</sup>C.

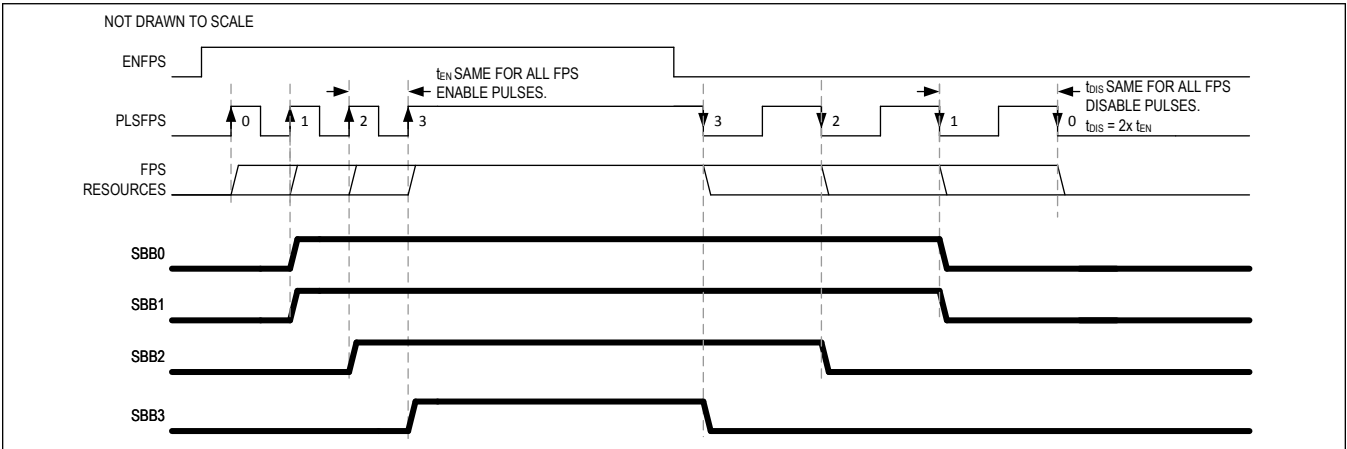


Figure 7. Flexible Power Sequencer Basic Timing Diagram

Startup Timing Diagram Due to nEN

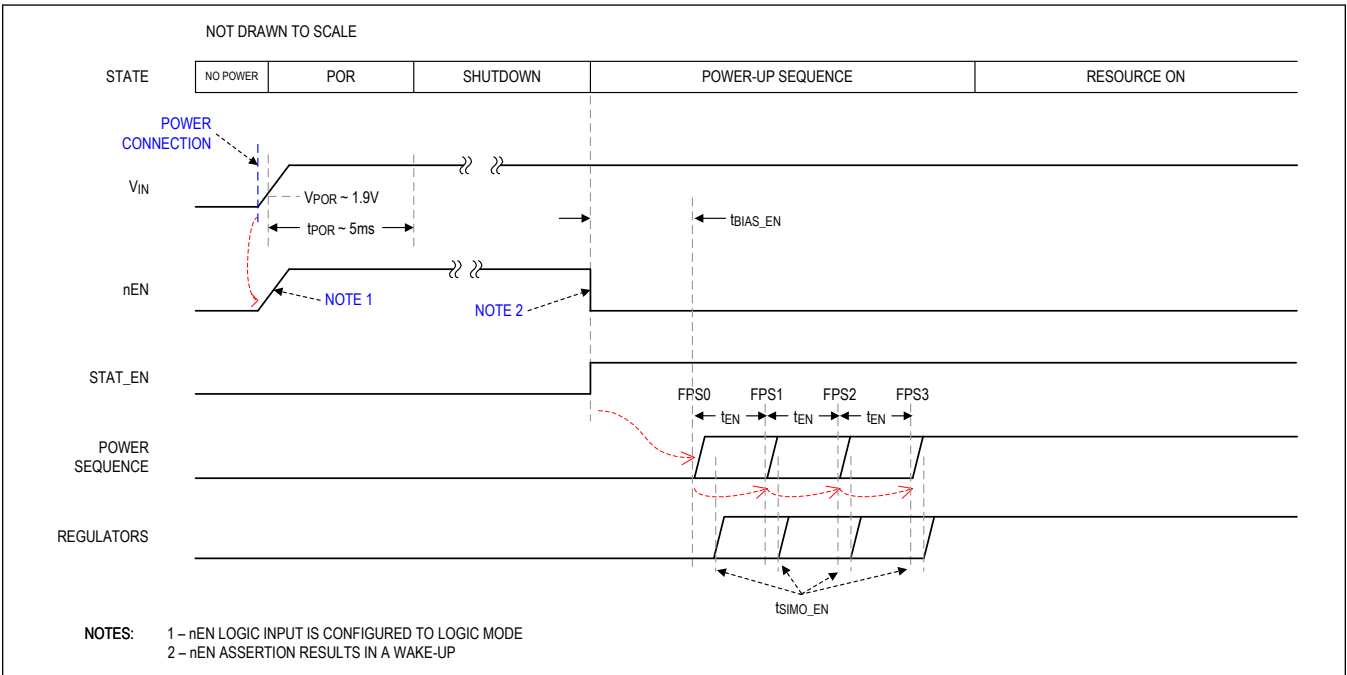


Figure 8. Startup Timing Diagram Due to nEN (Logic Mode)



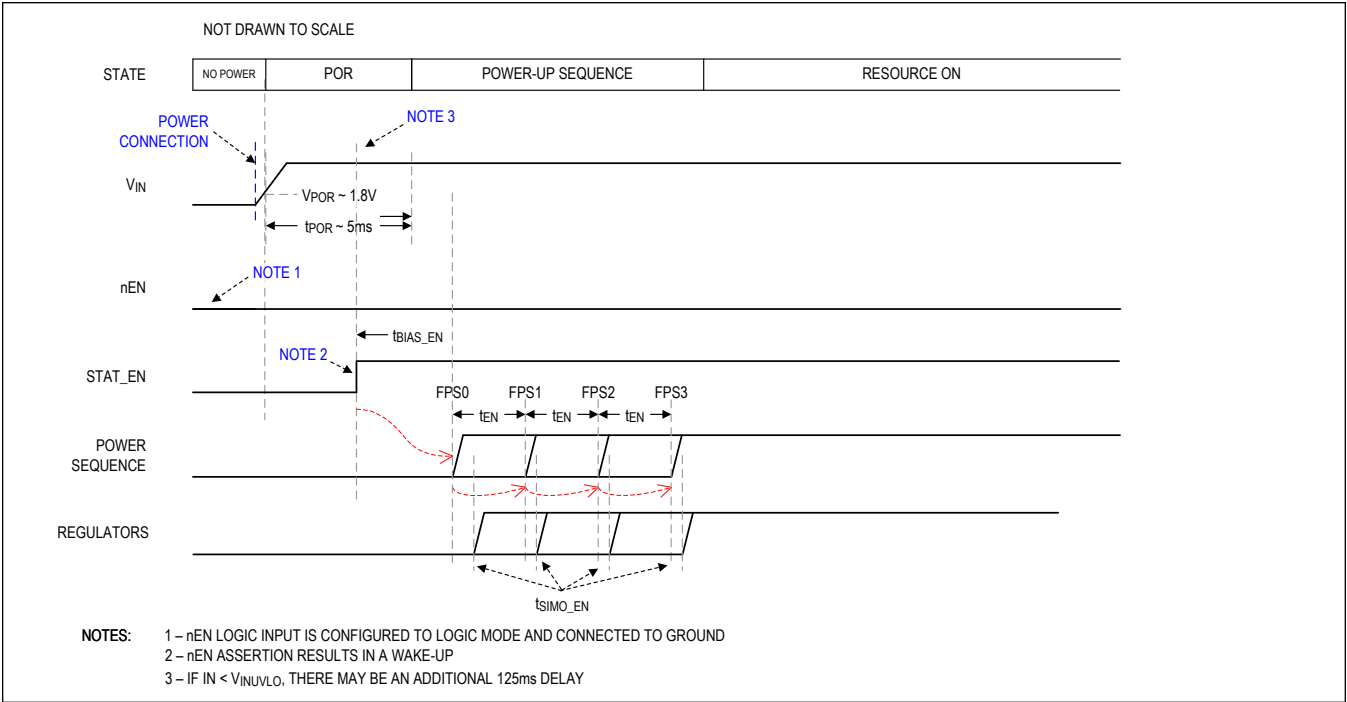


Figure 9. Startup Timing Diagram Due to nEN (Logic Mode; nEN Connected to Ground)

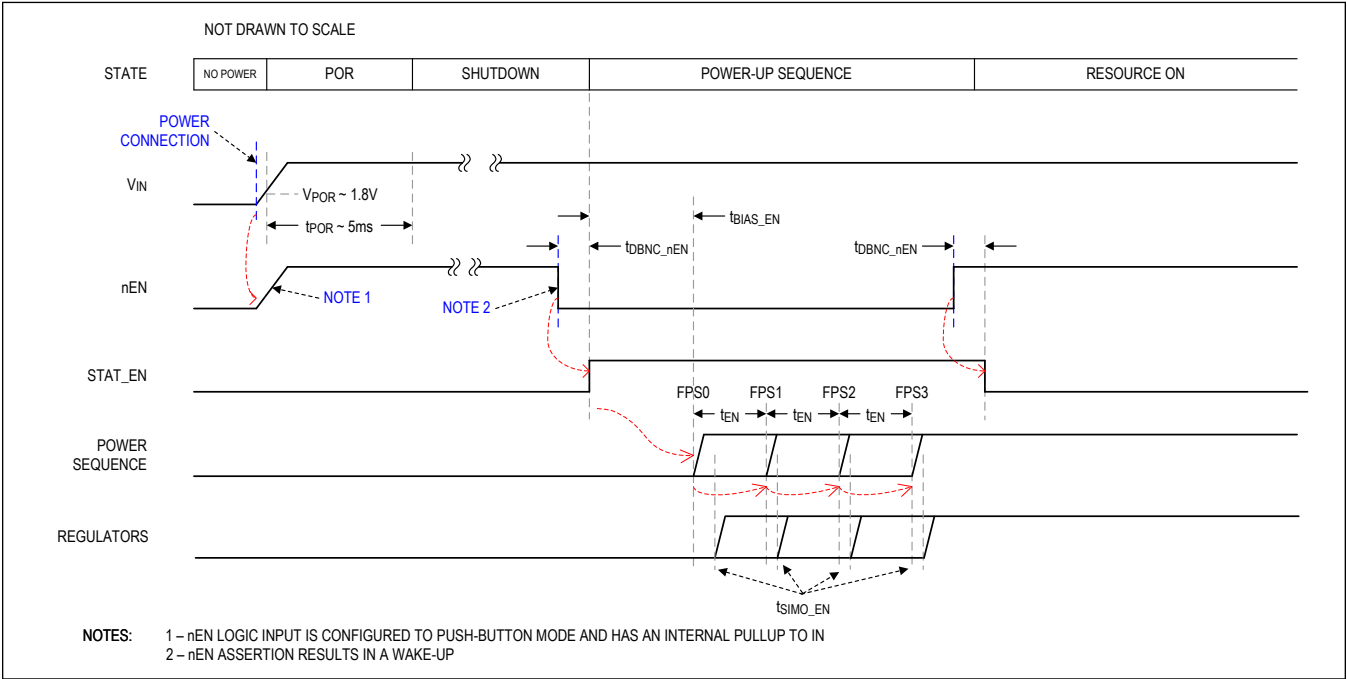


Figure 10. Startup Timing Diagram Due to nEN (Push-Button Mode)

Low-Power Mode

To request the device to enter low-power mode, set CNFG\_GLBL\_A.BIAS\_LPM = 1. This sets both the bias and the SIMO regulator to a lower-power state, reducing quiescent current through signal sampling techniques. The sampling

technique reduces quiescent current but increases output voltage ripple and slows down transient response.

### Detailed Description—SIMO Buck-Boost

The SIMO buck-boost DC-to-DC converter is designed for applications emphasizing low quiescent current and small solution size. A single inductor is used to regulate four separate outputs, saving board space while delivering total system efficiency better than equivalent power solutions using one buck and linear regulators.

For battery applications, the SIMO configuration utilizes the entire battery voltage range due to its ability to create output voltages that are above, below, or equal to the input voltage.

### Benefits and Features

- Four Output Channels
- Ideal for Low-Power Designs
  - Delivers > 700mA at 1.8V Output from a 3.7V Input
  - $\pm 2\%$  Accurate Output Voltage
- Small Solution Size
  - Multiple Outputs from a Single Inductor
- Flexible and Easy to Use
  - Automatic Transitions Between Buck, Buck-Boost, and Boost Operating Modes
  - Programmable, On-Chip Active Discharge
- Long Battery Life
  - High Efficiency, 90% Efficiency at 1.8V Output
  - Better Total System Efficiency than a Discrete Buck + LDOs Solution
  - Low Quiescent Current: 0.2 $\mu$ A Typical for Each Additional Output in Low-Power Mode
  - Low Input Operating Voltage: 2.5V Minimum

### Inductor Valley Current

The MAX77675 regulates inductor valley current or the lowest point in an inductor current cycle. Under light loads, in which inductor valley current is 0A, the SIMO regulator operates in discontinuous conduction mode (DCM). If DCM delivers insufficient energy to maintain any output voltage, the regulator switches to continuous conduction mode, raising valley current above 0A. As load current increases, the valley current also increases in discrete steps. [Figure 11](#) demonstrates how it increases or decreases with changing load current.

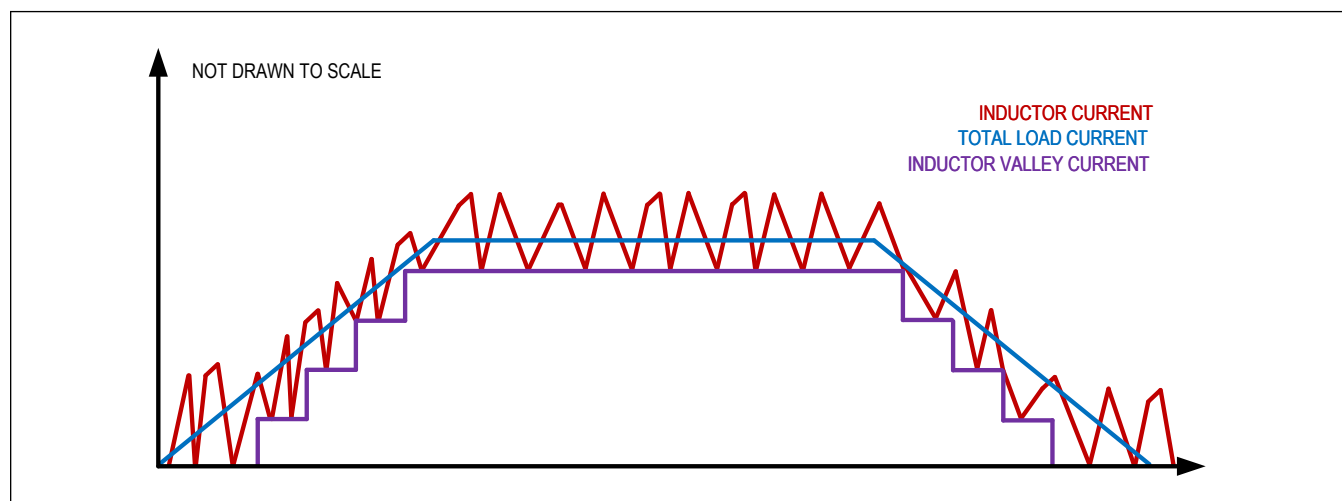


Figure 11. Valley Current Control with Changing Load Current

See the [Typical Operating Characteristics](#) section for examples.

### SIMO Control Scheme

The SIMO buck-boost is designed to service multiple outputs simultaneously. A proprietary controller ensures that all outputs are serviced in a timely manner, even while multiple outputs are contending for the energy stored in the inductor. When no regulator needs service and low-power mode is enabled, the state machine rests in a low-power rest state.

### Drive Strength

The SIMO regulator's drive strength for its internal power MOSFETs is adjustable using the CNFG\_SBB\_TOP.DRV\_SBB[1:0] bit field. Faster drive strength results in higher efficiency but requires stricter layout rules or shielding to avoid additional EMI. Slower settings limit EMI in non-ideal settings (e.g., contained layout, antennae adjacent to the device) but lower efficiency. Change the drive strength only once during system initialization.

### SIMO Channel Operating Mode

Each SIMO channel can individually operate in one of the three modes (buck, buck-boost, or boost) depending on the output voltage to input voltage ratio. The operating mode is automatically chosen based on the  $V_{SBBx}/V_{IN}$  ratio as shown in [Table 3](#).

**Table 3. SIMO Operating Mode Thresholds**

| OPERATING MODE  | OUTPUT VOLTAGE TO INPUT VOLTAGE RATIO RANGE |
|-----------------|---------------------------------------------|
| Buck Mode       | $V_{SBBx}/V_{IN} < 0.6$                     |
| Buck-Boost Mode | $0.6 < V_{SBBx}/V_{IN} < 1.25$              |
| Boost Mode      | $1.25 < V_{SBBx}/V_{IN}$                    |

### Examples

Given  $I_N = 3.1V$ ,  $SBB0 = 1.8V$ ,  $SBB1 = 5.0V$ ,  $SBB2 = 0.7V$ , and  $SBB3 = 3.3V$ , the operating mode for each channel is shown in [Table 4](#).

**Table 4. Operating Mode Examples**

|      | VOLTAGE (V) | SBBx/IN RATIO | OPERATING MODE |
|------|-------------|---------------|----------------|
| SBB0 | 1.8         | 0.581         | Buck           |
| SBB1 | 5.0         | 1.351         | Boost          |
| SBB2 | 0.7         | 0.226         | Buck           |
| SBB3 | 3.3         | 1.064         | Buck-Boost     |

### Buck Mode

When an output needs service, switch M3\_x remains closed and M4 remains open (see [\[\[SIMO Simple Block Diagram\]\]](#)). M1 and M2 are toggled as in a traditional buck converter. That is, M1 is closed and M2 is open to both deliver energy to the output and charge the inductor. Then, M1 is open and M2 is closed to deliver energy stored in the inductor to the output.

### Buck-Boost Mode

Unlike traditional buck-boost regulators, the SIMO regulator uses a three-state buck-boost control scheme. First, M1 and M4 are closed to charge the inductor. Then, M4 is open and M3\_x is closed. This is similar to a buck regulator state, delivering energy to the output while continuing to charge the inductor. Finally, M1 is open and M2 is closed delivering energy stored in the inductor to the output.

The second state improves efficiency in buck-boost mode compared to traditional control schemes.

### Boost Mode

When an output needs service, switch M1 remains closed and M2 remains open. M3\_x and M4 are toggled as in a traditional boost converter. That is, M3\_x is open and M4 is closed to charge the inductor. Then, M3\_x is closed and M4

is open to deliver energy to the output from both the input and the charged inductor.

### Channel-to-Channel Switching

To lower output voltage ripple, the regulator might switch directly from one channel to another using a proprietary algorithm. During the transition from one channel to another, the LXB node is temporarily connected to ground.

### SIMO Soft-Start

The soft-start feature of the SIMO limits inrush current during startup, achieved by limiting the slew rate of the output voltage during startup ( $dV/dt_{SS}$ ).

More output capacitance results in higher input current surges during startup. The following example and set of equations describe this phenomenon during startup.

The current into the output capacitor ( $I_{CSBB}$ ) during soft-start is as follows:

$$I_{CSBB} = C_{SBB} \frac{dV}{dt_{SS}} \quad (\text{Equation 1})$$

where:

- $C_{SBB}$  is the capacitance on the output of the regulator
- $dV/dt_{SS}$  is the voltage change rate of the output

The input current ( $I_{IN}$ ) during soft-start is as follows:

$$I_{IN} = \frac{(I_{CSBB} + I_{LOAD}) \frac{V_{SBBx}}{V_{IN}}}{\xi} \quad (\text{Equation 2})$$

where:

- $I_{CSBB}$  is from Equation 1
- $I_{LOAD}$  is the current consumed from the external load
- $V_{SBBx}$  is the output voltage
- $V_{IN}$  is the input voltage
- $\xi$  is the efficiency of the regulator

For example, given the following conditions, the peak input current ( $I_{IN}$ ) during soft-start is ~71mA.

Given:

- $V_{IN} = 3.5V$
- $V_{SBB2} = 3.3V$
- $C_{SBB2} = 22\mu F$
- $dV/dt_{SS} = 2mV/\mu s$
- $R_{LOAD2} = 330\Omega$  ( $I_{LOAD2} = 3.3V/330\Omega = 10mA$ )
- $\xi = 86\%$

Calculation:

- $I_{CSBB} = 22\mu F \times 2mV/\mu s$  (from Equation 1)
- $I_{CSBB} = 44mA$
- $I_{IN} = \frac{(44mA + 10mA) \frac{3.3V}{3.5V}}{0.86}$  (from Equation 1)
- $I_{IN} \sim 59.2mA$

### Rising Slew Rate

The rising slew rate while output voltage is increasing to a higher target output voltage is controlled by the CNFG\_SBB\_TOP\_B.SR\_SBBx and CNFG\_SBB\_TOP\_B.DVS\_SLEW bits. [Table 5](#) shows which slew rate options are available.

- This only applies to rising slew rates. Falling slew rates are mainly determined by load current.
- Actual rising slew rate may be lower depending on output capacitance and load current.

**Table 5. Output Voltage Rising Slew Rates**

| SR_SBBx | DVS_SLEW   | SLEW RATE |
|---------|------------|-----------|
| 0       | Don't Care | 2mV/μs    |
| 1       | 0          | 5mV/μs    |
| 1       | 1          | 10mV/μs   |

**Delay in Changing Output Voltage**

When an I<sup>2</sup>C command is sent to increase output voltage, there is a delay between the command and the output voltage changing. This delay is around 100μs but can be reduced by setting CNFG\_SBB\_TOP\_B.LAT\_MODE = 1, which reduces the delay to around 10μs. While LAT\_MODE = 1, the bias is in normal power mode.

When LAT\_MODE = 1, also set CNFG\_SBB\_TOP\_B.SR\_SBBx = 1. If SR\_SBBx = 0, LAT\_MODE is ignored.

**SIMO Registers**

The CNFG\_SBB\_TOP registers control all SIMO channels, modifying parameters such as drive strength and output voltage step size. Each SIMO buck-boost channel has a dedicated register to program its target output voltage (CNFG\_SBBx\_A.TV\_SBBx[7:0]). Additional controls are available in the CNFG\_SBBx\_B register for enabling/disabling the active discharge resistors (ADE\_SBBx) and enabling/disabling the SIMO buck-boost channels (EN\_SBBx[2:0]). To monitor each channel in real time for overload, read the STAT\_GLBL.SBBx\_S bits. To check if a channel was overloaded in the past, read the INT\_GLBL.SBBx\_F flags. Note that the interrupt flags are cleared upon reading.

For a full description of bits, registers, default values, and reset conditions, see the [Register Map](#) section.

**SIMO Active Discharge Resistance**

Each SIMO buck-boost channel has an active-discharge resistor (R<sub>AD\_SBBx</sub>) that is automatically enabled/disabled based on a CNFG\_SBBx\_B.ADE\_SBBx and the status of the SIMO regulator. The active discharge feature may be enabled (CNFG\_SBBx\_B.ADE\_SBBx = 1) or disabled (CNFG\_SBBx\_B.ADE\_SBBx = 0) independently for each SIMO channel. Enabling the active discharge feature helps ensure a complete and timely power down of all system peripherals. If the active-discharge resistor is enabled, then it is enabled whenever the respective channel is disabled.

**Bootstrap Refresh**

The bootstrap capacitor (connected between the BST and LXB pins) is refreshed when one of the following conditions is true:

- The capacitor has not been refreshed for a predetermined amount of time.
- While switching among three channels to service each one, none of those switching states connected LXB to ground.

**Detailed Description—I<sup>2</sup>C Serial Interface**

This device features a revision 3.0 I<sup>2</sup>C-compatible, two-wire serial interface consisting of a bidirectional serial data line (SDA) and a serial clock line (SCL). This device acts as a slave-only device and depends on the master to generate the clock signal. The SCL clock rates from 0Hz to 3.4MHz are supported. The I<sup>2</sup>C serial communication is an open-drain bus and therefore, SDA and SCL require pullups. Optional resistors (24Ω) in series with SDA and SCL protect the device inputs from high-voltage spikes on the bus lines. Series resistors also minimize crosstalk and undershoot on bus signals. [\[\[I<sup>2</sup>C Simplified Block Diagram\]\]](#) shows the functional diagram for the I<sup>2</sup>C-based communications controller. For additional information on I<sup>2</sup>C, refer to the I<sup>2</sup>C bus specification and user manual, which is available for free through the internet.

**Benefits and Features**

- I<sup>2</sup>C Revision 3.0 Compatible Serial Communications Channel
- 0Hz to 100kHz (Standard Mode)
- 0Hz to 400kHz (Fast Mode)
- 0Hz to 1MHz (Fast-Mode Plus)
- 0Hz to 3.4MHz (High-Speed Mode)

## I<sup>2</sup>C System Configuration

The I<sup>2</sup>C bus is a multimaster bus. The maximum number of devices that can attach to the bus is only limited by bus capacitance.

A device on the I<sup>2</sup>C bus that sends data to the bus is called a transmitter. A device that receives data from the bus is called a receiver. The device that initiates a data transfer and generates the SCL clock signals to control the data transfer is a master. Any device that is being addressed by the master is considered a slave. The I<sup>2</sup>C-compatible interface operates as a slave on the I<sup>2</sup>C bus with transmit and receive capabilities.

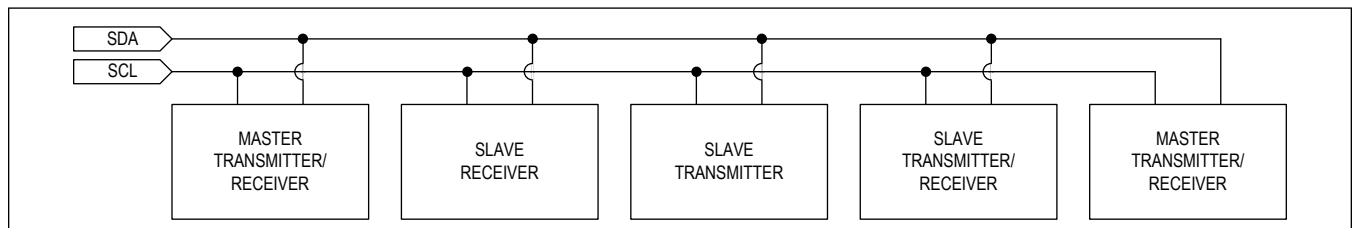


Figure 12. I<sup>2</sup>C System Configuration

## I<sup>2</sup>C Interface Power

The I<sup>2</sup>C interface derives its power from V<sub>DD</sub>. Bypass the V<sub>DD</sub> pin with a local 1μF ceramic capacitor to ground.

## I<sup>2</sup>C Data Transfer

One data bit is transferred during each SCL clock cycle. The data on SDA must remain stable during the high period of the SCL clock pulse. Changes in SDA while SCL is high are control signals. See the [I<sup>2</sup>C Start and Stop Conditions](#) section. Each transmit sequence is framed by a START (S) condition and a STOP (P) condition. Each data packet is nine bits long: eight bits of data followed by the acknowledge bit. Data is transferred with the MSB first.

## I<sup>2</sup>C Start and Stop Conditions

When the serial interface is inactive, SDA and SCL idle high. A master device initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA, while SCL is high. See [Figure 13](#).

A START condition from the master signals the beginning of a transmission to a slave. The master terminates transmission by issuing a not acknowledge followed by a STOP condition (see the [I<sup>2</sup>C Acknowledge Bit](#) section for information on not acknowledge). The STOP condition frees the bus. To issue a series of commands to the slave, the master can issue repeated start (Sr) commands instead of a STOP command to maintain control of the bus. In general, a repeated start command is functionally equivalent to a regular start command.

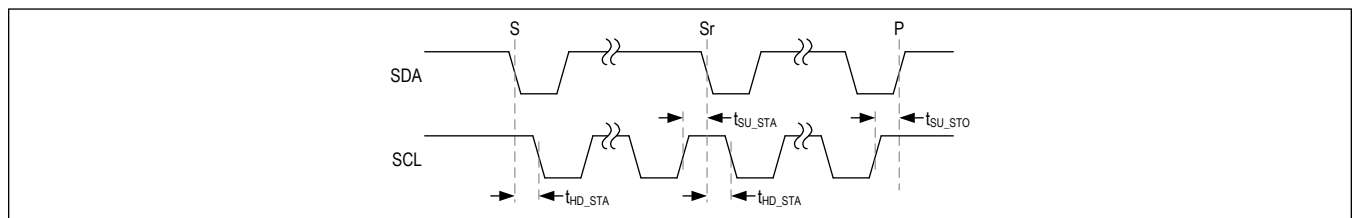


Figure 13. I<sup>2</sup>C Start and Stop Conditions

## I<sup>2</sup>C Acknowledge Bit

Both the I<sup>2</sup>C bus master and this device generate acknowledge bits when receiving data. The acknowledge bit is the last bit of each nine-bit data packet. To generate an acknowledge (A), the receiving device must pull SDA low before the rising edge of the acknowledge-related clock pulse (ninth pulse) and keep it low during the high period of the clock pulse. See [Figure 14](#). To generate a not acknowledge (nA), the receiving device allows SDA to be pulled high before the rising edge of the acknowledge-related clock pulse and leaves it high during the high period of the clock pulse.

MAX77675

Low I<sub>Q</sub> SIMO PMIC with 0.5V to 5.5V Outputs

Delivering Up to 700mA Total Output Current

Monitoring the acknowledge bits allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master should reattempt communication at a later time.

This device issues an ACK for all register addresses in the possible address space even if the particular register does not exist.

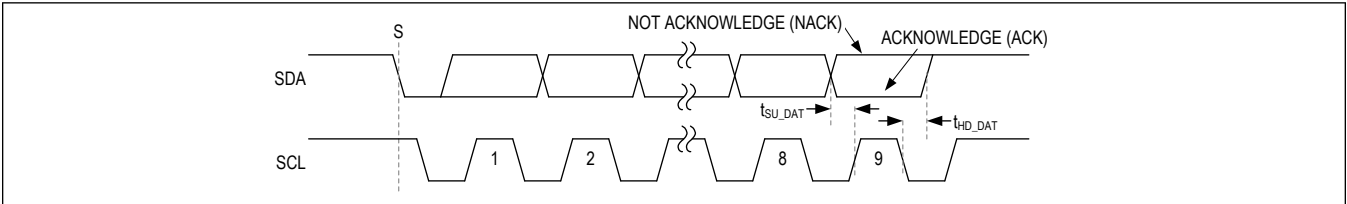


Figure 14. Acknowledge Bit

I<sup>2</sup>C Slave Address

The I<sup>2</sup>C controller implements seven-bit slave addressing. An I<sup>2</sup>C bus master initiates communication with the slave by issuing a START condition followed by the slave address. See [Figure 15](#). The address is factory-programmable. See [Table 6](#). All slave addresses not mentioned in [Table 6](#) are not acknowledged.

Table 6. I<sup>2</sup>C Slave Address Options

| ADDRESS                         | 7-BIT SLAVE ADDRESS | 8-BIT WRITE ADDRESS | 8-BIT READ ADDRESS |
|---------------------------------|---------------------|---------------------|--------------------|
| Main Address (ADDR[1:0] = 0x0)* | 0x40, 0b 100 0000   | 0x80, 0b 1000 0000  | 0x81, 0b 1000 0001 |
| Main Address (ADDR[1:0] = 0x1)* | 0x44, 0b 100 0100   | 0x88, 0b 1000 1000  | 0x89, 0b 1000 1001 |
| Main Address (ADDR[1:0] = 0x2)* | 0x48, 0b 100 1000   | 0x90, 0b 1001 0000  | 0x91, 0b 1001 0001 |
| Main Address (ADDR[1:0] = 0x3)* | 0x52, 0b 101 0010   | 0xA4, 0b 1010 0100  | 0xA5, 0b 1010 0101 |
| Test Mode**                     | 0x49, 0b 100 1001   | 0x92, 0b 1001 0010  | 0x93, 0b 1001 0011 |

\*Perform all reads and writes on the Main Address. The ADDR is a factory OTP option, allowing for address changes in the event of a bus conflict. [Contact support](#) for more information.

\*\*When test mode is unlocked, the additional address is acknowledged. Test mode details are confidential. If possible, leave the test mode address unallocated to allow for the rare event that debugging needs to be performed in cooperation with Analog Devices.

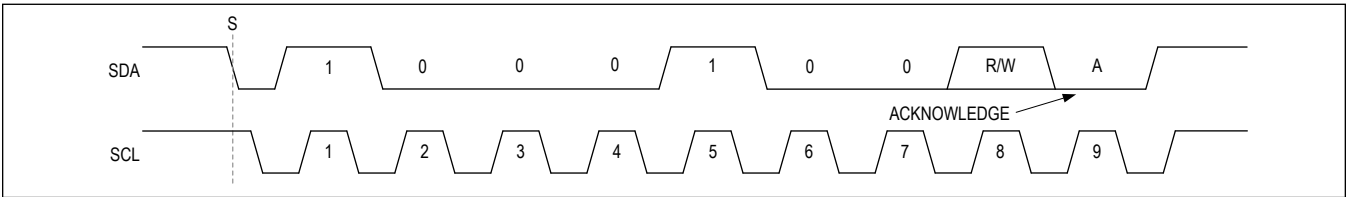


Figure 15. Slave Address Example

I<sup>2</sup>C Clock Stretching

In general, the clock signal generation for the I<sup>2</sup>C bus is the responsibility of the master device. The I<sup>2</sup>C specification allows slow slave devices to alter the clock signal by holding down the clock line. The process in which a slave device holds down the clock line is typically called clock stretching. This device does not use any form of clock stretching to hold down the clock line.

### I<sup>2</sup>C General Call Address

This device does not implement the I<sup>2</sup>C specifications general call address and does not issue an acknowledge for a general call address (0b0000 0000).

### I<sup>2</sup>C Device ID

This device does not support the I<sup>2</sup>C Device ID feature.

### I<sup>2</sup>C Communication Speed

This device is compatible with all four communication speed ranges as defined by the I<sup>2</sup>C Revision 3.0 specification:

- 0Hz to 100kHz (Standard Mode)
- 0Hz to 400kHz (Fast Mode)
- 0Hz to 1MHz (Fast-Mode Plus)
- 0Hz to 3.4MHz (High-Speed Mode)

Operating in standard mode, fast mode, and fast-mode plus does not require any special protocols. The main consideration when changing the bus speed through this range is the combination of bus capacitance and pullup resistors. Larger values of bus capacitance and pullup resistance increase the time constant ( $C \times R$ ), slowing bus operation. Therefore, when increasing bus speeds, the pullup resistance must be decreased to maintain a reasonable time constant. Refer to the *Pullup Resistor Sizing* section of the I<sup>2</sup>C bus specification and user manual for detailed guidance on the pullup resistor selection. In general for bus capacitances of 200pF, a 100kHz bus needs 5.6k $\Omega$  pullup resistors, a 400kHz bus needs about 1.5k $\Omega$  pullup resistors, and a 1MHz bus needs 680 $\Omega$  pullup resistors. Note that when the open-drain bus is low, the pullup resistor is dissipating power, lower value pullup resistors dissipate more power ( $V^2/R$ ).

Operating in high-speed mode requires some special considerations. For a full list of considerations, refer to the publicly available I<sup>2</sup>C bus specification and user manual. Major considerations with respect to this device are as follows:

- The I<sup>2</sup>C bus master uses current source pullups to shorten the signal rise.
- The I<sup>2</sup>C slave must use a different set of input filters on its SDA and SCL lines to accommodate for the higher bus.
- The communication protocols need to utilize the high-speed master code.

At power-up and after each stop condition, the I<sup>2</sup>C input filters are set for standard mode, fast mode, and fast-mode plus (i.e., 0Hz to 1MHz). To switch the input filters for high-speed mode, use the high-speed master code protocols that are described in the [I<sup>2</sup>C Communication Protocols](#) section.

### I<sup>2</sup>C Communication Protocols

This device supports both writing and reading from its registers.

#### Writing to a Single Register

[Figure 16](#) shows the protocol for the I<sup>2</sup>C master device to write one byte of data. This protocol is the same as the SMBus specification's write byte protocol.

The write byte protocol is as follows:

1. The master sends a start command (S).
2. The master sends the 7-bit slave address followed by a write bit ( $R/\overline{W} = 0$ ).
3. The addressed slave asserts an acknowledge (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave acknowledges the register pointer.
6. The master sends a data byte.
7. The slave updates with the new data.
8. The slave asserts an acknowledge or a not acknowledge for the data byte. The next rising edge on SDA loads the data byte into its target register and the data becomes active.
9. The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.



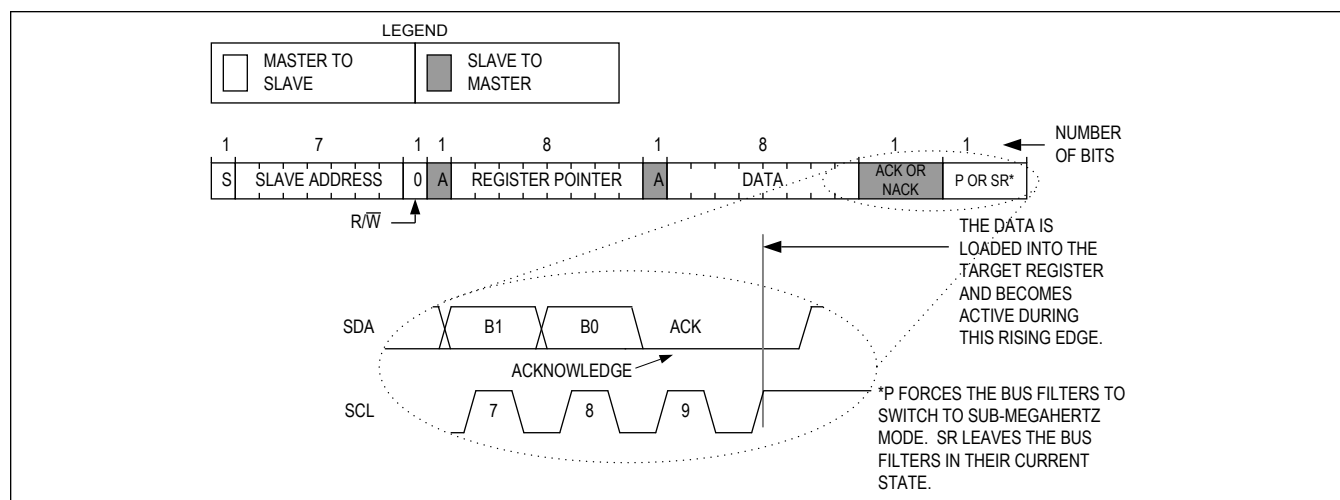


Figure 16. Writing to a Single Register with the Write Byte Protocol

## Writing Multiple Bytes to Sequential Registers

Figure 17 shows the protocol for writing to sequential registers. This protocol is similar to the write byte protocol described in the [Writing to a Single Register](#) section except that the master continues to write after it receives the first byte of data. When the master is done writing, it issues a stop or repeated start.

The protocol for writing to sequential registers is as follows:

1. The master sends a start command (S).
2. The master sends the 7-bit slave address followed by a write bit ( $R/\overline{W} = 0$ ).
3. The addressed slave asserts an acknowledge (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave issues an acknowledge for the register pointer.
6. The master sends a data byte.
7. The slave issues an acknowledge for the data byte. The next rising edge on SDA loads the data byte into its target register and the data becomes active.
8. Steps 6 to 7 are repeated as many times as the master requires.
9. During the last issued acknowledge-related clock pulse, the master can issue an acknowledge or a not acknowledge.
10. The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

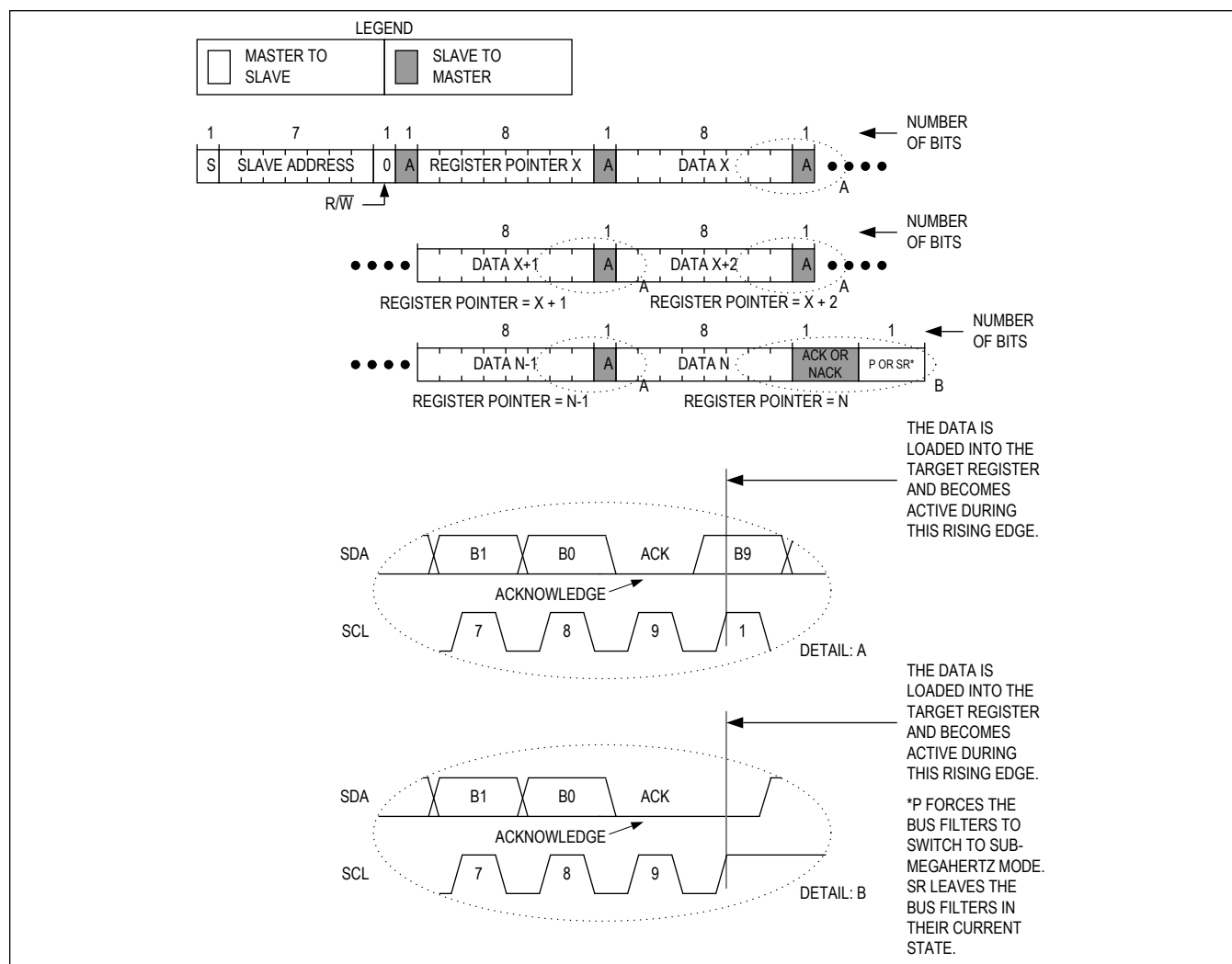


Figure 17. Writing to Sequential Registers X to N

### Reading from a Single Register

Figure 18 shows the protocol for the I<sup>2</sup>C master device to read one byte of data. This protocol is the same as the SMBus specification's read byte protocol.

The read byte protocol is as follows:

1. The master sends a start command (S).
2. The master sends the 7-bit slave address followed by a write bit ( $R/\overline{W} = 0$ ).
3. The addressed slave asserts an acknowledge (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave issues an acknowledge for the register pointer.
6. The master sends a repeated start command (Sr).
7. The master sends the 7-bit slave address followed by a read bit ( $R/\overline{W} = 1$ ).
8. The addressed slave asserts an acknowledge by pulling SDA low.
9. The addressed slave places 8 bits of data on the bus from the location specified by the register pointer.
10. The master issues a not acknowledge (nA).
11. The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters

are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

Note that when this device receives a stop, the register pointer is not modified. Therefore, if the master wants to reread the same register, it can start at Step 7 in the read byte protocol.

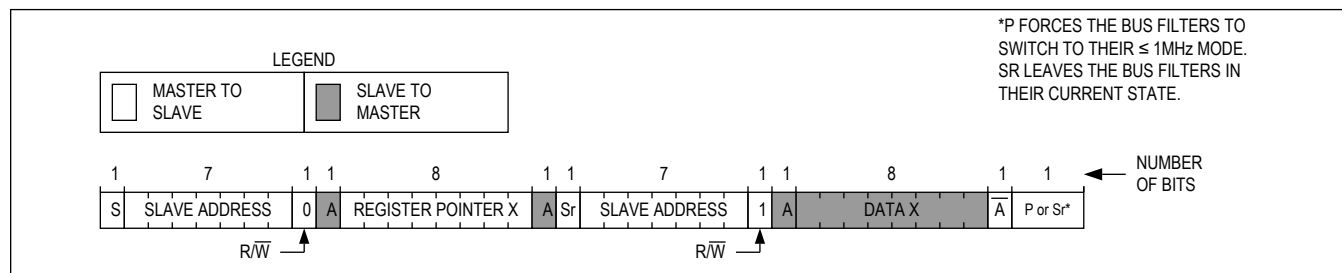


Figure 18. Reading from a Single Register with the Read Byte Protocol

### Reading from Sequential Registers

Figure 19 shows the protocol for reading from sequential registers. This protocol is similar to the read byte protocol except that the master issues an acknowledge to signal the slave that it wants more data: when the master has all the data it requires it issues a not acknowledge (nA) and a stop (P) to end the transmission.

The protocol for continuous read from sequential registers is as follows:

1. The master sends a start command (S).
2. The master sends the 7-bit slave address followed by a write bit ( $R/\overline{W} = 0$ ).
3. The addressed slave asserts an acknowledge (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave issues an acknowledge for the register pointer.
6. The master sends a repeated start command (Sr).
7. The master sends the 7-bit slave address followed by a read bit ( $R/\overline{W} = 1$ ).
8. The addressed slave asserts an acknowledge by pulling SDA low.
9. The addressed slave places 8 bits of data on the bus from the location specified by the register pointer.
10. The master issues an acknowledge (A) signaling the slave that it wishes to receive more data.
11. Steps 9 and 10 are repeated as many times as the master requires. Following the last byte of data, the master must issue a not acknowledge (nA) to signal that it wishes to stop receiving data.
12. The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a stop (P) ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

Note that when this device receives a stop, the register pointer is not modified. Therefore, if the master wants to re-read the same register, it can start at Step 7 in the read byte protocol.

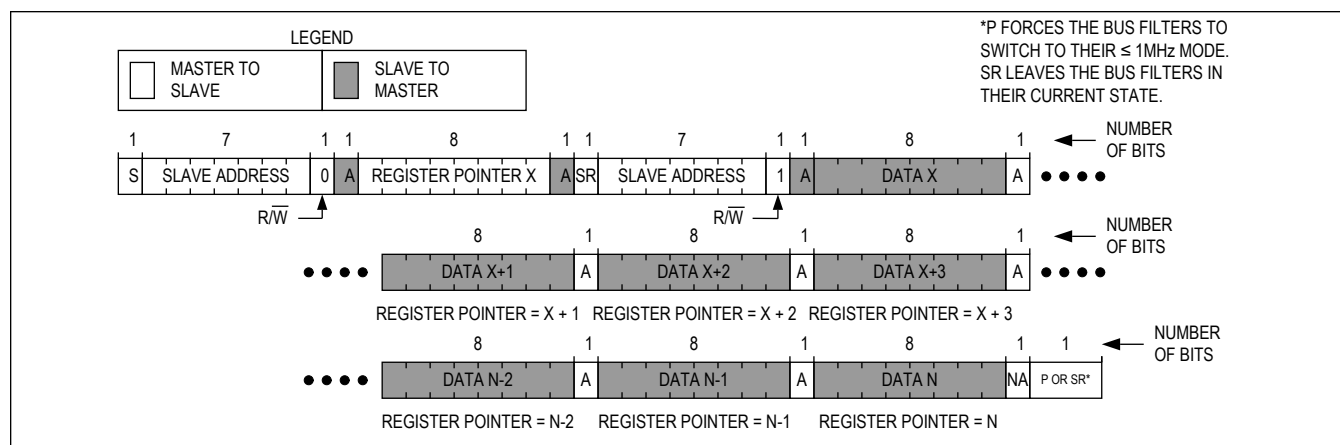


Figure 19. Reading Continuously from Sequential Registers X to N

### Engaging HS Mode for Operation Up to 3.4MHz

Figure 20 shows the protocol for engaging HS mode operation. The HS mode operation allows for a bus operating speed up to 3.4MHz.

The engaging HS mode protocol is as follows:

1. Begin the protocol while operating at a bus speed of 1MHz or lower.
2. The master sends a start command (S).
3. The master sends the 8-bit master code of 0b0000 1XXX where 0bXXX are don't care bits.
4. The addressed slave issues a not acknowledge (nA).
5. The master may increase its bus speed up to 3.4MHz and issue any read/write operation.

The master may continue to issue high-speed read/write operations until a stop (P) is issued. To continue operations in high-speed mode, use repeated start (Sr).

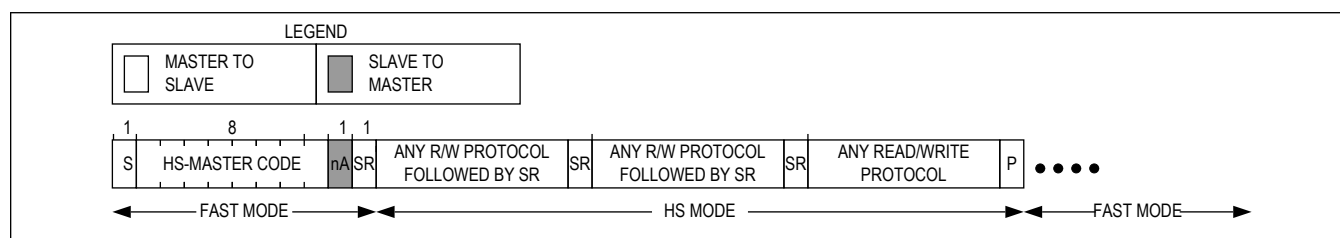


Figure 20. Engaging HS Mode

## Register Map

## MAX77675

| ADDRESS       | NAME                                | MSB          |             |                  |                  |                         |                  |              | LSB          |
|---------------|-------------------------------------|--------------|-------------|------------------|------------------|-------------------------|------------------|--------------|--------------|
| Configuration |                                     |              |             |                  |                  |                         |                  |              |              |
| 0x00          | <a href="#">CNFG_GLBL_A[7:0]</a>    | MRT[1:0]     |             | PU_DIS           | BIAS_LP<br>M     | SIMO_IN<br>T_CH_DI<br>S | nEN_MODE[1:0]    |              | DBEN_n<br>EN |
| 0x01          | <a href="#">CNFG_GLBL_B[7:0]</a>    | –            | –           | –                | –                | –                       | SFT_CTRL[2:0]    |              |              |
| 0x02          | <a href="#">INT_GLBL[7:0]</a>       | SBB3_F       | SBB2_F      | SBB1_F           | SBB0_F           | TJAL2_R                 | TJAL1_R          | nEN_R        | nEN_F        |
| 0x03          | <a href="#">INTM_GLBL[7:0]</a>      | SBB3_F<br>M  | SBB2_F<br>M | SBB1_F<br>M      | SBB0_F<br>M      | TJAL2_R<br>M            | TJAL1_R<br>M     | nEN_RM       | nEN_FM       |
| 0x04          | <a href="#">STAT_GLBL[7:0]</a>      | SBB3_S       | SBB2_S      | SBB1_S           | SBB0_S           | –                       | TJAL2_S          | TJAL1_S      | STAT_E<br>N  |
| 0x05          | <a href="#">ERCFLAG[7:0]</a>        | –            | –           | SFT_CR<br>ST_F   | SFT_OF<br>F_F    | MRST                    | UVLO             | OVLO         | TOVLD        |
| 0x06          | <a href="#">CID[7:0]</a>            | –            | –           | –                | CID[4:0]         |                         |                  |              |              |
| 0x07          | <a href="#">CNFG_SBB_TOP_A[7:0]</a> | –            | –           | STEP_S<br>Z_SBB3 | STEP_S<br>Z_SBB2 | STEP_S<br>Z_SBB1        | STEP_S<br>Z_SBB0 | DRV_SBB[1:0] |              |
| 0x08          | <a href="#">CNFG_SBB0_A[7:0]</a>    | TV_SBB0[7:0] |             |                  |                  |                         |                  |              |              |
| 0x09          | <a href="#">CNFG_SBB0_B[7:0]</a>    | –            | –           | –                | –                | ADE_SB<br>B0            | EN_SBB0[2:0]     |              |              |
| 0x0A          | <a href="#">CNFG_SBB1_A[7:0]</a>    | TV_SBB1[7:0] |             |                  |                  |                         |                  |              |              |
| 0x0B          | <a href="#">CNFG_SBB1_B[7:0]</a>    | –            | –           | –                | –                | ADE_SB<br>B1            | EN_SBB1[2:0]     |              |              |
| 0x0C          | <a href="#">CNFG_SBB2_A[7:0]</a>    | TV_SBB2[7:0] |             |                  |                  |                         |                  |              |              |
| 0x0D          | <a href="#">CNFG_SBB2_B[7:0]</a>    | –            | –           | –                | –                | ADE_SB<br>B2            | EN_SBB2[2:0]     |              |              |
| 0x0E          | <a href="#">CNFG_SBB3_A[7:0]</a>    | TV_SBB3[7:0] |             |                  |                  |                         |                  |              |              |
| 0x0F          | <a href="#">CNFG_SBB3_B[7:0]</a>    | –            | –           | –                | –                | ADE_SB<br>B3            | EN_SBB3[2:0]     |              |              |
| 0x10          | <a href="#">CNFG_SBB_TOP_B[7:0]</a> | –            | –           | DVS_SL<br>EW     | LAT_MO<br>DE     | SR_SBB<br>3             | SR_SBB<br>2      | SR_SBB<br>1  | SR_SBB<br>0  |

## Register Details

[CNFG\\_GLBL\\_A \(0x00\)](#)

| BIT                | 7           | 6 | 5           | 4           | 3               | 2             | 1 | 0           |
|--------------------|-------------|---|-------------|-------------|-----------------|---------------|---|-------------|
| <b>Field</b>       | MRT[1:0]    |   | PU_DIS      | BIAS_LPM    | SIMO_INT_CH_DIS | nEN_MODE[1:0] |   | DBEN_nEN    |
| <b>Reset</b>       | 0x0         |   | 0x0         | 0x0         | 0x0             | 0x0           |   | 0x0         |
| <b>Access Type</b> | Write, Read |   | Write, Read | Write, Read | Write, Read     | Write, Read   |   | Write, Read |

| BITFIELD            | BITS | DESCRIPTION                                                                                   | DECODE                                                                                                                                                                                                                                             |
|---------------------|------|-----------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MRT                 | 7:6  | Manual Reset Time Configuration.<br>See the <i>nEN Manual Reset</i> section for more details. | 0x0: 4s<br>0x1: 8s<br>0x2: 12s<br>0x3: 16s                                                                                                                                                                                                         |
| PU_DIS              | 5    | Enable or disable an internal pullup resistor at the nEN pin.                                 | 0x0: Enable internal nEN pullup (200kΩ)<br>0x1: Internal pullup disabled                                                                                                                                                                           |
| BIAS_LPM            | 4    | Main Bias Low-Power Mode Software Request                                                     | 0x0: Main Bias forced to be in Normal-Power Mode by software.<br>0x1: Main Bias request to be in Low-Power Mode by software.<br>If at least one channel is serviced more than twice in 15μs, the regulator automatically enters normal-power mode. |
| SIMO_INT_C<br>H_DIS | 3    |                                                                                               | 0x0: Normal operation (SIMO internal channel supplies 1.8V in LPM mode)<br>0x1: Internal LDO always supplies 1.8V                                                                                                                                  |
| nEN_MODE            | 2:1  | nEN Mode                                                                                      | 0x0: Push-Button Mode<br>0x1: Slide-Switch Mode<br>0x2: Logic Mode<br>0x3: Reserved                                                                                                                                                                |
| DBEN_nEN            | 0    | Debounce Timer Enable for the nEN Pin                                                         | 0x0: 100μs Debounce<br>0x1: 30ms Debounce                                                                                                                                                                                                          |

**CNFG\_GLBL\_B (0x01)**

| BIT         | 7 | 6 | 5 | 4 | 3 | 2                | 1 | 0 |
|-------------|---|---|---|---|---|------------------|---|---|
| Field       | – | – | – | – | – | SFT_CTRL[2:0]    |   |   |
| Reset       | – | – | – | – | – | 0x0              |   |   |
| Access Type | – | – | – | – | – | Write, Read, Ext |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                             | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|----------|------|-------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SFT_CTRL | 2:0  | Software Control Functions. See the <i>On/Off Controller</i> section for more information about what each command does. | 0x0: No Action<br>0x1: Software Cold Reset (SFT_CRST). The device powers down, resets, and then powers up again.<br>0x2: Software Off (SFT_OFF). The device powers down, resets, and then remains off until a wake-up event.<br>0x3: Software Standby (SFT_STBY). The device powers down and goes to standby mode.<br>0x4: Software Exit Standby (SFT_EXIT_STBY). The device exits standby mode and powers up again.<br>0x5 - 0x7: Reserved |

**INT\_GLBL (0x02)**

| BIT         | 7                  | 6                  | 5                  | 4                  | 3                  | 2                  | 1                  | 0                  |
|-------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Field       | SBB3_F             | SBB2_F             | SBB1_F             | SBB0_F             | TJAL2_R            | TJAL1_R            | nEN_R              | nEN_F              |
| Reset       | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                |
| Access Type | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All |

| BITFIELD | BITS | DESCRIPTION                      | DECODE                                                                                                                                                                                       |
|----------|------|----------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SBB3_F   | 7    | SBB3 Channel Fault Interrupt     | 0x0: SBB3 was not overloaded since the last time this bit was read.<br>0x1: SBB3 was overloaded since the last time this bit was read.                                                       |
| SBB2_F   | 6    | SBB2 Channel Fault Interrupt     | 0x0: SBB2 was not overloaded since the last time this bit was read.<br>0x1: SBB2 was overloaded since the last time this bit was read.                                                       |
| SBB1_F   | 5    | SBB1 Channel Fault Interrupt     | 0x0: SBB1 was not overloaded since the last time this bit was read.<br>0x1: SBB1 was overloaded since the last time this bit was read.                                                       |
| SBB0_F   | 4    | SBB0 Channel Fault Interrupt     | 0x0: SBB0 was not overloaded since the last time this bit was read.<br>0x1: SBB0 was overloaded since the last time this bit was read.                                                       |
| TJAL2_R  | 3    | Thermal Alarm 2 Rising Interrupt | 0x0: The junction temperature has not risen above TJAL2 since the last time this bit was read.<br>0x1: The junction temperature has risen above TJAL2 since the last time this bit was read. |
| TJAL1_R  | 2    | Thermal Alarm 1 Rising Interrupt | 0x0: The junction temperature has not risen above TJAL1 since the last time this bit was read.<br>0x1: The junction temperature has risen above TJAL1 since the last time this bit was read. |
| nEN_R    | 1    | nEN Rising Interrupt             | 0x0: No nEN rising edges have occurred since the last time this bit was read.<br>0x1: An nEN rising edge has occurred since the last time this bit was read.                                 |
| nEN_F    | 0    | nEN Falling Interrupt            | 0x0: No nEN falling edges have occurred since the last time this bit was read.<br>0x1: An nEN falling edge has occurred since the last time this bit was read.                               |

**INTM\_GLBL (0x03)**

| BIT         | 7           | 6           | 5           | 4           | 3           | 2           | 1           | 0           |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field       | SBB3_FM     | SBB2_FM     | SBB1_FM     | SBB0_FM     | TJAL2_RM    | TJAL1_RM    | nEN_RM      | nEN_FM      |
| Reset       | 0b1         | 0b1         | 0b1         | 0b1         | 0b1         | 0b1         | 0b1         | 0b1         |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION                           |
|----------|------|---------------------------------------|
| SBB3_FM  | 7    | SBB3 Channel Fault Interrupt Mask     |
| SBB2_FM  | 6    | SBB2 Channel Fault Interrupt Mask     |
| SBB1_FM  | 5    | SBB1 Channel Fault Interrupt Mask     |
| SBB0_FM  | 4    | SBB0 Channel Fault Interrupt Mask     |
| TJAL2_RM | 3    | Thermal Alarm 2 Rising Interrupt Mask |
| TJAL1_RM | 2    | Thermal Alarm 1 Rising Interrupt Mask |
| nEN_RM   | 1    | nEN Rising Interrupt Mask             |
| nEN_FM   | 0    | nEN Falling Interrupt Mask            |

[STAT\\_GLBL \(0x04\)](#)

| BIT         | 7         | 6         | 5         | 4         | 3 | 2         | 1         | 0         |
|-------------|-----------|-----------|-----------|-----------|---|-----------|-----------|-----------|
| Field       | SBB3_S    | SBB2_S    | SBB1_S    | SBB0_S    | – | TJAL2_S   | TJAL1_S   | STAT_EN   |
| Reset       | 0x0       | 0x0       | 0x0       | 0x0       | – | 0x0       | 0x0       | 0x0       |
| Access Type | Read Only | Read Only | Read Only | Read Only | – | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION                         | DECODE                                                                                                  |
|----------|------|-------------------------------------|---------------------------------------------------------------------------------------------------------|
| SBB3_S   | 7    | SBB3 Channel Regulation Status      | 0x0: SBB3 is overloaded or disabled<br>0x1: SBB3 is not overloaded                                      |
| SBB2_S   | 6    | SBB2 Channel Regulation Status      | 0x0: SBB2 is overloaded or disabled<br>0x1: SBB2 is not overloaded                                      |
| SBB1_S   | 5    | SBB1 Channel Regulation Status      | 0x0: SBB1 is overloaded or disabled<br>0x1: SBB1 is not overloaded                                      |
| SBB0_S   | 4    | SBB0 Channel Regulation Status      | 0x0: SBB0 is overloaded or disabled<br>0x1: SBB0 is not overloaded                                      |
| TJAL2_S  | 2    | Thermal Alarm 2 Status              | 0x0: The junction temperature is less than TJAL2<br>0x1: The junction temperature is greater than TJAL2 |
| TJAL1_S  | 1    | Thermal Alarm 1 Status              | 0x0: The junction temperature is less than TJAL1<br>0x1: The junction temperature is greater than TJAL1 |
| STAT_EN  | 0    | Debounced Status for the nEN input. | 0x0: nEN is not asserted (logic HIGH)<br>0x1: nEN is asserted (logic LOW)                               |

[ERCFLAG \(0x05\)](#)

| BIT         | 7 | 6 | 5               | 4               | 3               | 2               | 1               | 0               |
|-------------|---|---|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| Field       | – | – | SFT_CRST_F      | SFT_OFF_F       | MRST            | UVLO            | OVLO            | TOVLD           |
| Reset       | – | – | 0x0             | 0x0             | 0x0             | 0x0             | 0x0             | 0x0             |
| Access Type | – | – | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All |

| BITFIELD   | BITS | DESCRIPTION              | DECODE                                                                                                                                                                                                                            |
|------------|------|--------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SFT_CRST_F | 5    | Software Cold Reset Flag | 0x0: The software cold reset has not occurred since the last read of this register.<br>0x1: The software cold reset has occurred since the last read of this register. This indicates that software has set SFT_CTRL[1:0] = 0b01. |
| SFT_OFF_F  | 4    | Software Off Flag        | 0x0: The SFT_OFF function has not occurred since the last read of this register.<br>0x1: The SFT_OFF function has occurred since the last read of this register. This indicates that software has set SFT_CTRL[1:0] = 0b10.       |
| MRST       | 3    | Manual Reset Timer       | 0x0: A manual reset has not occurred since this last read of this register.<br>0x1: A manual reset has occurred since this last read of this register.                                                                            |



| BITFIELD | BITS | DESCRIPTION          | DECODE                                                                                                                                                                                                                                            |
|----------|------|----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| UVLO     | 2    | Undervoltage Lockout | 0x0: The undervoltage lockout has not occurred since this last read of this register.<br>0x1: The undervoltage lockout has occurred since the last read of this register. This indicates that the V <sub>IN</sub> voltage fell below UVLO (~2.4V) |
| OVLO     | 1    | Overvoltage Lockout  | 0x0: The overvoltage lockout has not occurred since this last read of this register.<br>0x1: The overvoltage lockout has occurred since the last read of this register. This indicates that the V <sub>IN</sub> voltage rose above OVLO (~5.85V)  |
| TOVLD    | 0    | Thermal Overload     | 0x0: The thermal overload has not occurred since the last read of this register.<br>0x1: The thermal overload has occurred since the last read of this register. This indicates that the junction temperature exceeded +145°C.                    |

**CID (0x06)**

| BIT         | 7 | 6 | 5 | 4         | 3 | 2 | 1 | 0 |
|-------------|---|---|---|-----------|---|---|---|---|
| Field       | — | — | — | CID[4:0]  |   |   |   |   |
| Reset       | — | — | — | 0x0       |   |   |   |   |
| Access Type | — | — | — | Read Only |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                       |
|----------|------|-------------------------------------------------------------------|
| CID      | 4:0  | Chip Identification Code. These bits track the OTP configuration. |

**CNFG\_SBB\_TOP\_A (0x07)**

| BIT         | 7 | 6 | 5            | 4            | 3            | 2            | 1            | 0 |
|-------------|---|---|--------------|--------------|--------------|--------------|--------------|---|
| Field       | — | — | STEP_SZ_SBB3 | STEP_SZ_SBB2 | STEP_SZ_SBB1 | STEP_SZ_SBB0 | DRV_SBB[1:0] |   |
| Reset       | — | — | 0x0          | 0x0          | 0x0          | 0x0          | 0x0          |   |
| Access Type | — | — | Write, Read  | Write, Read  | Write, Read  | Write, Read  | Write, Read  |   |

| BITFIELD     | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                                     | DECODE                                                             |
|--------------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------|
| STEP_SZ_SBB3 | 5    | Selects the output voltage step size for SBB3. Changing step size also affects the maximum programmable output voltage. New step size setting takes effect only after TV_SBBx update.<br><br>If set to 0b0, the programmable range becomes 0.500V - 5.500V.<br>If set to 0b1, the programmable range becomes 0.5000V - 3.6875V. | SBB3 Output Voltage Step Size<br><br>0b0 = 25.0mV,<br>0b1 = 12.5mV |

| BITFIELD         | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                                             | DECODE                                                                                                                                                                         |
|------------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| STEP_SZ_S<br>BB2 | 4    | <p>Selects the output voltage step size for SBB2. Changing step size also affects the maximum programmable output voltage. New step size setting takes effect only after TV_SBBx update.</p> <p>If set to 0b0, the programmable range becomes 0.500V - 5.500V.<br/>If set to 0b1, the programmable range becomes 0.5000V - 3.6875V.</p> | <p>SBB2 Output Voltage Step Size</p> <p>0b0 = 25.0mV,<br/>0b1 = 12.5mV</p>                                                                                                     |
| STEP_SZ_S<br>BB1 | 3    | <p>Selects the output voltage step size for SBB1. Changing step size also affects the maximum programmable output voltage. New step size setting takes effect only after TV_SBBx update.</p> <p>If set to 0b0, the programmable range becomes 0.500V - 5.500V.<br/>If set to 0b1, the programmable range becomes 0.5000V - 3.6875V.</p> | <p>SBB1 Output Voltage Step Size</p> <p>0b0 = 25.0mV,<br/>0b1 = 12.5mV</p>                                                                                                     |
| STEP_SZ_S<br>BB0 | 2    | <p>Selects the output voltage step size for SBB0. Changing step size also affects the maximum programmable output voltage. New step size setting takes effect only after TV_SBBx update.</p> <p>If set to 0b0, the programmable range becomes 0.500V - 5.500V.<br/>If set to 0b1, the programmable range becomes 0.5000V - 3.6875V.</p> | <p>SBB0 Output Voltage Step Size</p> <p>0b0 = 25.0mV,<br/>0b1 = 12.5mV</p>                                                                                                     |
| DRV_SBB          | 1:0  | SIMO Buck-Boost (All Channels) Drive Strength Trim.<br>See the <i>Drive Strength</i> section for more details.                                                                                                                                                                                                                          | <p>0x0: Fastest transition time (~0.6ns)<br/>0x1: A little slower than 0b00 (~1.2ns)<br/>0x2: A little slower than 0b01 (~1.8ns)<br/>0x3: A little slower than 0b10 (~8ns)</p> |

**CNFG\_SBB0\_A (0x08)**

| BIT         | 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|---|---|---|---|---|---|---|
| Field       | TV_SBB0[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x0          |   |   |   |   |   |   |   |
| Access Type | Write, Read  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                               | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TV_SBB0  | 7:0  | <p>SIMO Buck-Boost Channel 0 Target Output Voltage.</p> <p>When STEP_SZ_SBB0 = 0b0, the programmable range is 0.5V to 5.5V in 25.0mV increments.<br/> <math>V_{SBB0} = 0.5V + 0.0250V \times TV\_SBB0[7:0]</math></p> <p>When STEP_SZ_SBB0 = 0b1, the programmable range is 0.5000V to 3.6875V in 12.5mV increments.<br/> <math>V_{SBB0} = 0.5V + 0.0125V \times TV\_SBB0[7:0]</math></p> | <p>SBB0 Target Output Voltage</p> <p>When CNFG_SBB0_C.STEP_SZ_SBB0 = 0b0,<br/>           0x0 = 0.500V,<br/>           0x1 = 0.525V,<br/>           0x2 = 0.550V,<br/>           0x3 - 0xC6 = 0.5 + (TV_SBB0 x 0.025)V,<br/>           0xC7 = 5.475V,<br/>           0xC8 = 5.500V,<br/>           0xC9 - 0xFF = Reserved</p> <p>When CNFG_SBB0_C.STEP_SZ_SBB0 = 0b1,<br/>           0x0 = 0.5000V,<br/>           0x1 = 0.5125V,<br/>           0x2 = 0.5250V,<br/>           0x3 - 0xFD = 0.5 + (TV_SBB0 x 0.0125)V,<br/>           0xFE = 3.6750V,<br/>           0xFF = 3.6875V</p> |

**CNFG\_SBB0\_B (0x09)**

| BIT         | 7 | 6 | 5 | 4 | 3           | 2            | 1 | 0 |
|-------------|---|---|---|---|-------------|--------------|---|---|
| Field       | — | — | — | — | ADE_SBB0    | EN_SBB0[2:0] |   |   |
| Reset       | — | — | — | — | 0x0         | 0x0          |   |   |
| Access Type | — | — | — | — | Write, Read | Write, Read  |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                              | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ADE_SBB0 | 3    | SIMO Buck-Boost Channel 0 Active-Discharge Enable                                                                                                                                                                                                                                                                        | <p>0x0: The active discharge function is disabled. When SBB0 is disabled, its discharge rate is a function of the output capacitance and the external load.</p> <p>0x1: The active discharge function is enabled. When SBB0 is disabled, an internal resistor (RAD_SBB0) is activated from SBB0 to PGND to help the output voltage discharge. The output voltage discharge rate is a function of the output capacitance, the external loading, and the internal RAD_SBB0 load.</p> |
| EN_SBB0  | 2:0  | <p>Enable Control for SIMO Buck-Boost Channel 0. Select an FPS slot that the channel powers up and powers down in or whether the channel is forced on or off.</p> <p>After the SIMO is enabled, the bias circuits may be programmed back to low-power mode (CNFG_GLBL_A.BIAS_LPM = 1) to decrease quiescent current.</p> | <p>0x0: FPS slot 0<br/>           0x1: FPS slot 1<br/>           0x2: FPS slot 2<br/>           0x3: FPS slot 3<br/>           0x4: Off<br/>           0x5: Same as 0x4<br/>           0x6: On<br/>           0x7: Same as 0x6</p>                                                                                                                                                                                                                                                 |

**CNFG\_SBB1\_A (0x0A)**

| BIT         | 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|---|---|---|---|---|---|---|
| Field       | TV_SBB1[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x0          |   |   |   |   |   |   |   |
| Access Type | Write, Read  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                               | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TV_SBB1  | 7:0  | <p>SIMO Buck-Boost Channel 1 Target Output Voltage.</p> <p>When STEP_SZ_SBB1 = 0b0, the programmable range is 0.5V to 5.5V in 25.0mV increments.<br/> <math>V_{SBB1} = 0.5V + 0.0250V \times TV\_SBB1[7:0]</math></p> <p>When STEP_SZ_SBB1 = 0b1, the programmable range is 0.5000V to 3.6875V in 12.5mV increments.<br/> <math>V_{SBB1} = 0.5V + 0.0125V \times TV\_SBB1[7:0]</math></p> | <p>SBB1 Target Output Voltage</p> <p>When CNFG_SBB1_C.STEP_SZ_SBB1 = 0b0,<br/>           0x0 = 0.500V,<br/>           0x1 = 0.525V,<br/>           0x2 = 0.550V,<br/>           0x3 - 0xC6 = 0.5 + (TV_SBB1 x 0.025)V,<br/>           0xC7 = 5.475V,<br/>           0xC8 = 5.500V,<br/>           0xC9 - 0xFF = Reserved</p> <p>When CNFG_SBB1_C.STEP_SZ_SBB1 = 0b1,<br/>           0x0 = 0.5000V,<br/>           0x1 = 0.5125V,<br/>           0x2 = 0.5250V,<br/>           0x3 - 0xFD = 0.5 + (TV_SBB1 x 0.0125)V,<br/>           0xFE = 3.6750V,<br/>           0xFF = 3.6875V</p> |

**CNFG\_SBB1\_B (0x0B)**

| BIT         | 7 | 6 | 5 | 4 | 3           | 2            | 1 | 0 |
|-------------|---|---|---|---|-------------|--------------|---|---|
| Field       | — | — | — | — | ADE_SBB1    | EN_SBB1[2:0] |   |   |
| Reset       | — | — | — | — | 0x0         | 0x0          |   |   |
| Access Type | — | — | — | — | Write, Read | Write, Read  |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                              | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ADE_SBB1 | 3    | SIMO Buck-Boost Channel 1 Active-Discharge Enable                                                                                                                                                                                                                                                                        | <p>0x0: The active discharge function is disabled. When SBB1 is disabled, its discharge rate is a function of the output capacitance and the external load.</p> <p>0x1: The active discharge function is enabled. When SBB1 is disabled, an internal resistor (RAD_SBB1) is activated from SBB1 to PGND to help the output voltage discharge. The output voltage discharge rate is a function of the output capacitance, the external loading, and the internal RAD_SBB1 load.</p> |
| EN_SBB1  | 2:0  | <p>Enable Control for SIMO Buck-Boost Channel 1. Select an FPS slot that the channel powers up and powers down in or whether the channel is forced on or off.</p> <p>After the SIMO is enabled, the bias circuits may be programmed back to low-power mode (CNFG_GLBL_A.BIAS_LPM = 1) to decrease quiescent current.</p> | <p>0x0: FPS slot 0<br/>           0x1: FPS slot 1<br/>           0x2: FPS slot 2<br/>           0x3: FPS slot 3<br/>           0x4: Off<br/>           0x5: Same as 0x4<br/>           0x6: On<br/>           0x7: Same as 0x6</p>                                                                                                                                                                                                                                                 |

**CNFG\_SBB2\_A (0x0C)**

| BIT         | 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|---|---|---|---|---|---|---|
| Field       | TV_SBB2[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x0          |   |   |   |   |   |   |   |
| Access Type | Write, Read  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                               | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TV_SBB2  | 7:0  | <p>SIMO Buck-Boost Channel 2 Target Output Voltage.</p> <p>When STEP_SZ_SBB2 = 0b0, the programmable range is 0.5V to 5.5V in 25.0mV increments.<br/> <math>V_{SBB2} = 0.5V + 0.0250V \times TV\_SBB2[7:0]</math></p> <p>When STEP_SZ_SBB2 = 0b1, the programmable range is 0.5000V to 3.6875V in 12.5mV increments.<br/> <math>V_{SBB2} = 0.5V + 0.0125V \times TV\_SBB2[7:0]</math></p> | <p>SBB2 Target Output Voltage</p> <p>When CNFG_SBB2_C.STEP_SZ_SBB2 = 0b0,<br/>           0x0 = 0.500V,<br/>           0x1 = 0.525V,<br/>           0x2 = 0.550V,<br/>           0x3 - 0xC6 = 0.5 + (TV_SBB2 x 0.025)V,<br/>           0xC7 = 5.475V,<br/>           0xC8 = 5.500V,<br/>           0xC9 - 0xFF = Reserved</p> <p>When CNFG_SBB2_C.STEP_SZ_SBB2 = 0b1,<br/>           0x0 = 0.5000V,<br/>           0x1 = 0.5125V,<br/>           0x2 = 0.5250V,<br/>           0x3 - 0xFD = 0.5 + (TV_SBB2 x 0.0125)V,<br/>           0xFE = 3.6750V,<br/>           0xFF = 3.6875V</p> |

**CNFG\_SBB2\_B (0x0D)**

| BIT         | 7 | 6 | 5 | 4 | 3           | 2            | 1 | 0 |
|-------------|---|---|---|---|-------------|--------------|---|---|
| Field       | — | — | — | — | ADE_SBB2    | EN_SBB2[2:0] |   |   |
| Reset       | — | — | — | — | 0x0         | 0x0          |   |   |
| Access Type | — | — | — | — | Write, Read | Write, Read  |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                              | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ADE_SBB2 | 3    | SIMO Buck-Boost Channel 2 Active-Discharge Enable                                                                                                                                                                                                                                                                        | <p>0x0: The active discharge function is disabled. When SBB2 is disabled, its discharge rate is a function of the output capacitance and the external load.</p> <p>0x1: The active discharge function is enabled. When SBB2 is disabled, an internal resistor (RAD_SBB2) is activated from SBB2 to PGND to help the output voltage discharge. The output voltage discharge rate is a function of the output capacitance, the external loading, and the internal RAD_SBB2 load.</p> |
| EN_SBB2  | 2:0  | <p>Enable Control for SIMO Buck-Boost Channel 2. Select an FPS slot that the channel powers up and powers down in or whether the channel is forced on or off.</p> <p>After the SIMO is enabled, the bias circuits may be programmed back to low-power mode (CNFG_GLBL_A.BIAS_LPM = 1) to decrease quiescent current.</p> | <p>0x0: FPS slot 0<br/>           0x1: FPS slot 1<br/>           0x2: FPS slot 2<br/>           0x3: FPS slot 3<br/>           0x4: Off<br/>           0x5: Same as 0x4<br/>           0x6: On<br/>           0x7: Same as 0x6</p>                                                                                                                                                                                                                                                 |

**CNFG\_SBB3\_A (0x0E)**

| BIT         | 7            | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|---|---|---|---|---|---|---|
| Field       | TV_SBB3[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x0          |   |   |   |   |   |   |   |
| Access Type | Write, Read  |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                               | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TV_SBB3  | 7:0  | <p>SIMO Buck-Boost Channel 3 Target Output Voltage.</p> <p>When STEP_SZ_SBB3 = 0b0, the programmable range is 0.5V to 5.5V in 25.0mV increments.<br/> <math>V_{SBB3} = 0.5V + 0.0250V \times TV\_SBB3[7:0]</math></p> <p>When STEP_SZ_SBB3 = 0b1, the programmable range is 0.5000V to 3.6875V in 12.5mV increments.<br/> <math>V_{SBB3} = 0.5V + 0.0125V \times TV\_SBB3[7:0]</math></p> | <p>SBB3 Target Output Voltage</p> <p>When CNFG_SBB3_C.STEP_SZ_SBB3 = 0b0,<br/>           0x0 = 0.500V,<br/>           0x1 = 0.525V,<br/>           0x2 = 0.550V,<br/>           0x3 - 0xC6 = 0.5 + (TV_SBB3 x 0.025)V,<br/>           0xC7 = 5.475V,<br/>           0xC8 = 5.500V,<br/>           0xC9 - 0xFF = Reserved</p> <p>When CNFG_SBB3_C.STEP_SZ_SBB3 = 0b1,<br/>           0x0 = 0.5000V,<br/>           0x1 = 0.5125V,<br/>           0x2 = 0.5250V,<br/>           0x3 - 0xFD = 0.5 + (TV_SBB3 x 0.0125)V,<br/>           0xFE = 3.6750V,<br/>           0xFF = 3.6875V</p> |

**CNFG\_SBB3\_B (0x0F)**

| BIT         | 7 | 6 | 5 | 4 | 3           | 2            | 1 | 0 |
|-------------|---|---|---|---|-------------|--------------|---|---|
| Field       | — | — | — | — | ADE_SBB3    | EN_SBB3[2:0] |   |   |
| Reset       | — | — | — | — | 0x0         | 0x0          |   |   |
| Access Type | — | — | — | — | Write, Read | Write, Read  |   |   |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                                                                                                                              | DECODE                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ADE_SBB3 | 3    | SIMO Buck-Boost Channel 3 Active-Discharge Enable                                                                                                                                                                                                                                                                        | <p>0x0: The active discharge function is disabled. When SBB3 is disabled, its discharge rate is a function of the output capacitance and the external load.</p> <p>0x1: The active discharge function is enabled. When SBB3 is disabled, an internal resistor (RAD_SBB3) is activated from SBB3 to PGND to help the output voltage discharge. The output voltage discharge rate is a function of the output capacitance, the external loading, and the internal RAD_SBB3 load.</p> |
| EN_SBB3  | 2:0  | <p>Enable Control for SIMO Buck-Boost Channel 3. Select an FPS slot that the channel powers up and powers down in or whether the channel is forced on or off.</p> <p>After the SIMO is enabled, the bias circuits may be programmed back to low-power mode (CNFG_GLBL_A.BIAS_LPM = 1) to decrease quiescent current.</p> | <p>0x0: FPS slot 0<br/>           0x1: FPS slot 1<br/>           0x2: FPS slot 2<br/>           0x3: FPS slot 3<br/>           0x4: Off<br/>           0x5: Same as 0x4<br/>           0x6: On<br/>           0x7: Same as 0x6</p>                                                                                                                                                                                                                                                 |

**CNFG\_SBB\_TOP\_B (0x10)**

| BIT         | 7 | 6 | 5           | 4           | 3           | 2           | 1           | 0           |
|-------------|---|---|-------------|-------------|-------------|-------------|-------------|-------------|
| Field       | — | — | DVS_SLEW    | LAT_MODE    | SR_SBB3     | SR_SBB2     | SR_SBB1     | SR_SBB0     |
| Reset       | — | — | 0x0         | 0x0         | 0x0         | 0x0         | 0x0         | 0x0         |
| Access Type | — | — | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION                                                                                                                                                                                                             | DECODE                                                                                                |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------|
| DVS_SLEW | 5    | Select DVS slew rate                                                                                                                                                                                                    | 0x0: 5mV/μs<br>0x1: 10mV/μs                                                                           |
| LAT_MODE | 4    | If set, reduces the latency between changing output voltage (CNFG_SBBx_A.TV_SBBx[7:0]) and the start of SBBx voltage ramp. Low-power mode not supported while this bit is set to 1. This bit is ignored if SR_SBBx = 0. | 0x0: Low quiescent current, high latency (~100μs)<br>0x1: High quiescent current, low latency (~10μs) |
| SR_SBB3  | 3    | Controls the rising slew rate when SBB3 ramps from one voltage setting to a higher setting.                                                                                                                             | 0x0: 2mV/μs<br>0x1: See DVS_SLEW                                                                      |
| SR_SBB2  | 2    | Controls the rising slew rate when SBB2 ramps from one voltage setting to a higher setting.                                                                                                                             | 0x0: 2mV/μs<br>0x1: See DVS_SLEW                                                                      |
| SR_SBB1  | 1    | Controls the rising slew rate when SBB1 ramps from one voltage setting to a higher setting.                                                                                                                             | 0x0: 2mV/μs<br>0x1: See DVS_SLEW                                                                      |
| SR_SBB0  | 0    | Controls the rising slew rate when SBB0 ramps from one voltage setting to a higher setting.                                                                                                                             | 0x0: 2mV/μs<br>0x1: See DVS_SLEW                                                                      |

## Applications Information

### Configuring Power Modes

The MAX77675's power mode is configurable through CNFG\_GLBL\_A.BIAS\_LPM and CNFG\_GLBL\_A.SIMO\_INT\_CH\_DIS to meet requirements depending on whether quiescent current or performance is more important.

After configuring these bits, avoid changing them in real time while the system is operating and drawing load current.

If the system enters a state with low current draw (e.g., <5mA per channel) and low quiescent current is needed, configure the MAX77675 to be in low-power mode as described in [Table 7](#). If there is >5mA per channel, use normal-power mode and set SIMO\_INT\_CH\_DIS = 1 if low-quiescent current is still required.

**Table 7. Power Mode Configuration**

| BIAS_LPM | SIMO_INT_CH_DIS | DESCRIPTION                                         | BENEFITS                                                                                          | TRADE-OFFS                                                                                                                                                                                                               |
|----------|-----------------|-----------------------------------------------------|---------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0        | Don't Care      | Normal-Power Mode                                   | <ul style="list-style-type: none"> <li>Lower ripple</li> <li>Faster transient response</li> </ul> | <ul style="list-style-type: none"> <li>Highest quiescent current state</li> </ul>                                                                                                                                        |
| 1        | 0               | Low-Power Mode                                      | <ul style="list-style-type: none"> <li>Lowest quiescent current state</li> </ul>                  | <ul style="list-style-type: none"> <li>Higher ripple</li> <li>Slower transient response</li> </ul>                                                                                                                       |
| 1        | 1               | Everything except for the bias is in low-power mode | <ul style="list-style-type: none"> <li>Lower ripple compared to low-power mode</li> </ul>         | <ul style="list-style-type: none"> <li>Slower transient response</li> <li>Quiescent current increased by about 10μA (typical) compared to low-power mode</li> <li>Higher ripple compared to normal-power mode</li> </ul> |

## Applications Information—SIMO Buck-Boost

### SIMO-Supported Output Current

The maximum supported output current is limited by inductor valley current (see the [Inductor Valley Current](#) section). When the valley current is at its maximum value, channels enter overload condition, triggering their respective fault interrupt flags. While the absolute maximum valley current is 1.2A (eight valley steps), stay below 900mA (six valley steps) to avoid valley current occasionally reaching the absolute maximum.

In addition, if the average inductor current is above 700mA, ripple on the output channels can increase out of specifications.

To predict if a given set of conditions is supported, estimate the average inductor current and maximum valley current the regulator experiences. A calculator tool is provided (see the [Support Materials](#) section) for convenience. [Table 8](#) shows some example results using the calculator.

**Table 8. SIMO-Supported Output Current for Common Applications**

| PARAMETERS                     | EXAMPLE 1     | EXAMPLE 2     | EXAMPLE 3     | EXAMPLE 4      | EXAMPLE 5      |
|--------------------------------|---------------|---------------|---------------|----------------|----------------|
| V <sub>IN</sub>                | 2.7V          | 4.0V          | 3.7V          | 3.7V           | 5.0V           |
| SBB0                           | 1.8V at 100mA | 1.8V at 30mA  | 1.8V at 100mA | 1.8V at 300mA  | 1.8V at 150mA  |
| SBB1                           | 3.3V at 200mA | 3.3V at 200mA | 1.1V at 120mA | 1.2V at 100mA  | 1.2V at 70mA   |
| SBB2                           | 0.5V at 250mA | 5.0V at 100mA | 0.7V at 200mA | 3.2V at 20mA   | 0.85V at 100mA |
| SBB3                           | 5.0V at 50mA  | 5.0V at 100mA | 3.3V at 80mA  | 2.85V at 100mA | 2.0V at 80mA   |
| Maximum I <sub>L,average</sub> | 864mA         | 696mA         | 550mA         | 597mA          | 400mA          |
| Maximum I <sub>L,valley</sub>  | 750mA         | 600mA         | 450mA         | 450mA          | 300mA          |



MAX77675

Low  $I_Q$  SIMO PMIC with 0.5V to 5.5V Outputs  
Delivering Up to 700mA Total Output Current

**Table 8. SIMO-Supported Output Current for Common Applications (continued)**

| PARAMETERS    | EXAMPLE 1 | EXAMPLE 2 | EXAMPLE 3 | EXAMPLE 4 | EXAMPLE 5 |
|---------------|-----------|-----------|-----------|-----------|-----------|
| Overloaded    | No        | No        | No        | No        | No        |
| Higher ripple | Yes       | No        | No        | No        | No        |

To manually estimate average inductor current, first estimate the average inductor current for each channel using the following equations:

$$I_{L\_avg} = \begin{cases} I_{out} & , \frac{V_{SBBx}}{V_{IN}} < 0.6 \quad (\text{Buck Mode}) \\ \frac{3}{2} \times I_{out} & , 0.6 \leq \frac{V_{SBBx}}{V_{IN}} \leq 1.25 \quad (\text{Buck-Boost Mode}) \\ I_{out} \times \frac{V_{SBBx}}{V_{IN} \times \eta} & , \frac{V_{SBBx}}{V_{IN}} > 1.25 \quad (\text{Boost Mode}) \end{cases} \quad (\text{Equation 3})$$

where  $\eta$  is efficiency (see the [Typical Operating Characteristics](#) section for efficiency values). The sum of the average currents is the expected maximum, average inductor current. Then, using the total average inductor current, estimate the number of valley current steps with the following equation:

$$I_{L\_valley\_steps} = \frac{I_{L\_avg}}{I_{valley\_step}} \quad (\text{Equation 4})$$

where  $I_{valley\_step}$  is 150mA. If the number of steps is above the previously mentioned maximum value (8), the regulator is overloaded. If the average inductor current is above 700mA, expect higher output voltage ripple.

### Overload

While in overload condition, the output voltage can drop for any channel. A host controller can detect which channels are "overloaded" by reading either the status bits (STAT\_GLBL.SBBx\_S) or the interrupt bits (INT\_GLBL.SBBx\_F), where x is the channel number. Status bits convey the current state of the channel while interrupt bits indicate if a channel had entered overload in the past. If the status bit indicates that a channel is overloaded, its output voltage is most likely out of regulation.

### Inductor Selection

Choose an inductance from 1.0μH to 2.2μH; 1.5μH inductors work best for most designs. Larger inductances transfer more energy to the output for each cycle and typically result in larger output voltage ripple and better efficiency. See the [Output Capacitor Selection](#) section for more information on how to size the output capacitor to control ripple.

Choose an inductor whose saturation current is above the worst case peak inductor current. For example, if the worst case occurs while drawing 700mA, the worst case peak inductor current is around 1.2A. For systems where the expected load currents are not well known, use an inductor with saturation current  $\geq 2A$ .

Consider the DC resistance (DCR), AC resistance (ACR), and package size of the inductor. Typically, smaller-sized inductors have larger DC and AC resistance, reducing efficiency. Note that many inductor manufacturers have inductor families containing different versions of core material to balance trade-offs between DCR, ACR (i.e., core losses), and component cost.

### Input Capacitor Selection

Choose the input bypass capacitance ( $C_{IN}$ ) to be at least 10μF. A value of 22μF nominal is recommended to account for voltage derating. Larger values of  $C_{IN}$  improve the decoupling for the SIMO regulator.

The  $C_{IN}$  reduces the current peaks drawn from the battery or input power source during SIMO regulator operation and reduces switching noise in the system. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

To fully utilize the available input voltage range of the device (5.5V max), use a capacitor with a voltage rating of 6.3V at minimum.

### Bootstrap Capacitor Selection

Choose the bootstrap capacitance ( $C_{BST}$ ) to be 10nF. Smaller values of  $C_{BST}$  result in insufficient gate drive for the output high-side power FETs. Larger values of  $C_{BST}$  (>100nF) have the potential to degrade the startup performance.

Ceramic capacitors with 0201 or 0402 case size are recommended.

### Output Capacitor Selection

Choose each output bypass capacitance ( $C_{SBBx}$ ) based on the target output voltage ripple ( $\Delta V_{SBBx}$ ): typical value is 22 $\mu$ F. In addition, consider using at least 44 $\mu$ F for an individual channel if either the channel's output voltage is less than 1.5V or the channel is lightly loaded while another channel is heavily loaded.

Larger values of  $C_{SBBx}$  improve the output voltage ripple but increase the input surge currents during soft-start and output voltage changes. The output voltage ripple is a function of the inductance (L), the output voltage ( $V_{SBBx}$ ), and the inductor current ripple ( $\Delta I_L$ ), which is typically 300mA to 500mA. See Equation 5 to estimate the minimum effective capacitance for a given ripple. However, always have the minimum capacitance at 10 $\mu$ F.

$$C_{SBBx} = \frac{\Delta I_L^2 \times L}{2 \times V_{SBBx} \times \Delta V_{SBBx}} \quad (\text{Equation 5})$$

Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

A capacitor's effective capacitance decreases with DC bias voltage. This effect is more pronounced with physically smaller capacitors. Due to this, it is possible for 0603 capacitors to perform well while 0402 capacitors of the same nominal capacitance perform poorly. Consider the effective output capacitance value after initial tolerance, bias voltage, aging, and temperature derating.

### PVDD and V<sub>DD</sub> Capacitors

Always have a minimum of 10 $\mu$ F capacitance near the PVDD pin. If possible, place an additional 1 $\mu$ F to 10 $\mu$ F near the V<sub>DD</sub> pin. If there is not enough room on the PCB, V<sub>DD</sub> can share PVDD's capacitor. The tradeoff is an occasional 5mV (approximate) droop on the output channels while in low-power mode.

If V<sub>DD</sub> and PVDD are not connected, place at minimum a 1 $\mu$ F capacitor near the V<sub>DD</sub> pin.

### Unused Outputs

Do not leave unused outputs unconnected. If an output left unconnected is accidentally enabled, the charged inductor experiences an open circuit, and the output voltage soars above the absolute maximum rating, damaging the device. If an output is not used, do one of the following:

1. Disable the output (CNFG\_SBBx\_B.EN\_SBBx[2:0] = 0x4 or 0x5) and connect the output to ground. If an unused output is enabled by default or can be accidentally enabled, do one of the other recommendations instead.
2. Bypass the unused output with a 1 $\mu$ F capacitor to ground.
3. Connect the unused output to IN or a different output channel if the unused output is programmed to a lower voltage. Since the output voltage is higher than the unused output, the regulator does not service the unused output even if it is unintentionally enabled.
  - Note that some OTP options have the active-discharge resistors enabled by default. Connecting an unused output to IN is **not recommended** if the active discharge is enabled by default. If connecting the unused output to a different channel, disable the active discharge resistor (CNFG\_SBBx\_B.ADE\_SBBx = 0) of the unused channel.

### Output Voltage Ripple

Ripple is highest when there is heavy load on at least one channel while other channels have less load.

While the regulator is operating in CCM (inductor valley current is greater than 0A), the output voltage ripple for one channel is affected by other channels. For example, channels may droop lower in voltage while waiting for another channel to be serviced. In addition, while one or more channels are loaded with more than 300mA, other channels may occasionally have larger spikes in voltage ripple. Ripple also increases with output voltage.

Assuming at least 300mA total load current and 22 $\mu$ F of output capacitance, for channels whose output voltage is 2.5V or less, the occasional spike in voltage ripple can be up to 200mV while the average ripple is < 100mV. For channels whose output voltage is greater than 2.5V, the occasional spike in voltage ripple can be up to 300mV while the average

ripple is < 120mV.

See the [Output Capacitor Selection](#) section for recommendations on how much output capacitance to use.

## PCB Layout Guide

### Capacitors

Place decoupling capacitors as close as possible to the IC such that connections from capacitor pads to pin and from capacitor pads to ground pins are short. Keeping the connections short lowers parasitic inductance and resistance, improving performance and shrinking the physical size of hot loops.

If connections to the capacitors are through vias, use multiple vias to minimize parasitics. Also, connect loads to the capacitor pads rather than the device pins.

### Input Capacitor at IN

Minimize the parasitic inductance from PGND to input capacitor to IN to reduce ringing on the LXA voltage.

### Output Capacitors at SBBx

The output capacitors experience large changes in current as the regulator charges and discharges the inductor. Minimize parasitic inductance from SBBx to output capacitor to PGND.

### Inductor

Keep the inductor close to the IC to reduce trace resistance. However, prioritize any regulator input/output capacitors over the inductor. Use the appropriate trace width from LXA to inductor to LXB to support the worst case, peak inductor current (see the [Inductor Selection](#) section). Likewise, if there are vias in the path, use an appropriate number of vias to support the current.

### Ground Connections

As the switching regulator charges and discharges the inductor, current flows from PGND to the input capacitor ground, from output capacitor ground to PGND, or from output capacitor ground to input capacitor ground. Therefore, use a wide, continuous copper plane to connect PGND to the capacitor grounds.

When connecting the GND and PGND pins together, ensure noise from the power ground does not enter the analog ground (where GND is connected). For example, assuming the ground pins are connected through a solid ground plane on an internal layer, one via connecting GND to the internal ground plane may be sufficient to protect GND from most of the noise in the power-ground plane. Likewise, if there are other higher current or noisy circuitry near this device, avoid connecting the GND pin directly to their grounds.

For more guidelines on grounding, refer to the *Technical Articles* section at <https://www.analog.com/en/design-center/packaging-quality-symbols-footprints/package-resources.html>.

### Example PCB Layout

[Figure 21](#) shows an example layout.

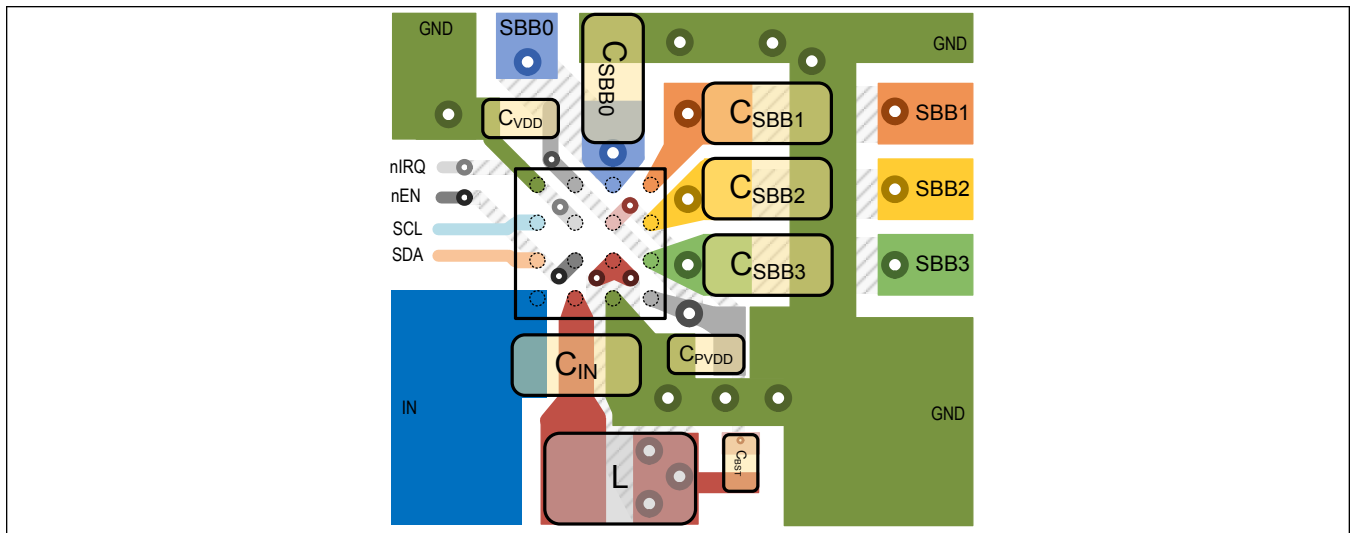
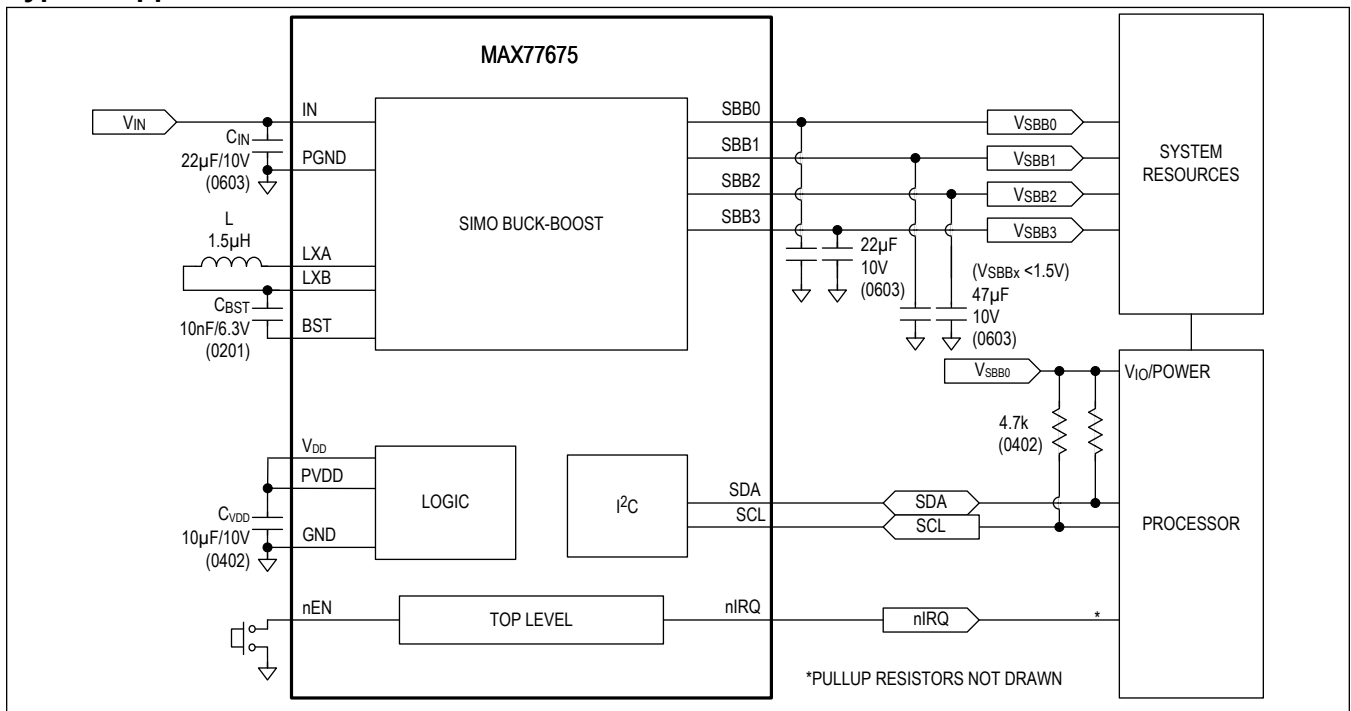


Figure 21. PCB Top Layer and Component Placement Example

## Typical Application Circuits

### Typical Applications Circuit



MAX77675

Low  $I_Q$  SIMO PMIC with 0.5V to 5.5V Outputs  
Delivering Up to 700mA Total Output Current

### Ordering Information

| PART           | TEMP RANGE     | PIN-PACKAGE | OPTIONS                     |
|----------------|----------------|-------------|-----------------------------|
| MAX77675EWE+T* | -40°C to +85°C | 16 WLP      | —                           |
| MAX77675AEWE+T | -40°C to +85°C | 16 WLP      | See <a href="#">Table 1</a> |
| MAX77675CEWE+T | -40°C to +85°C | 16 WLP      | See <a href="#">Table 1</a> |

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

\*Custom samples only. Not for production or stock. Contact factory for more information.

MAX77675

Low  $I_Q$  SIMO PMIC with 0.5V to 5.5V Outputs  
Delivering Up to 700mA Total Output Current

## Revision History

| REVISION<br>NUMBER | REVISION<br>DATE | DESCRIPTION                                           | PAGES<br>CHANGED |
|--------------------|------------------|-------------------------------------------------------|------------------|
| 0                  | 3/23             | Release for Market Intro                              | —                |
| 1                  | 10/23            | Updated Table 1 and <i>Ordering Information</i> table | 24, 63           |